

Microscopy of Nanomaterials: SEM Lecture



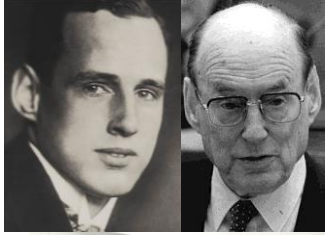
Ramzy Abdelaziz

*Nanomicroscopy Center
ramzy.abdelaziz@aalto.fi*

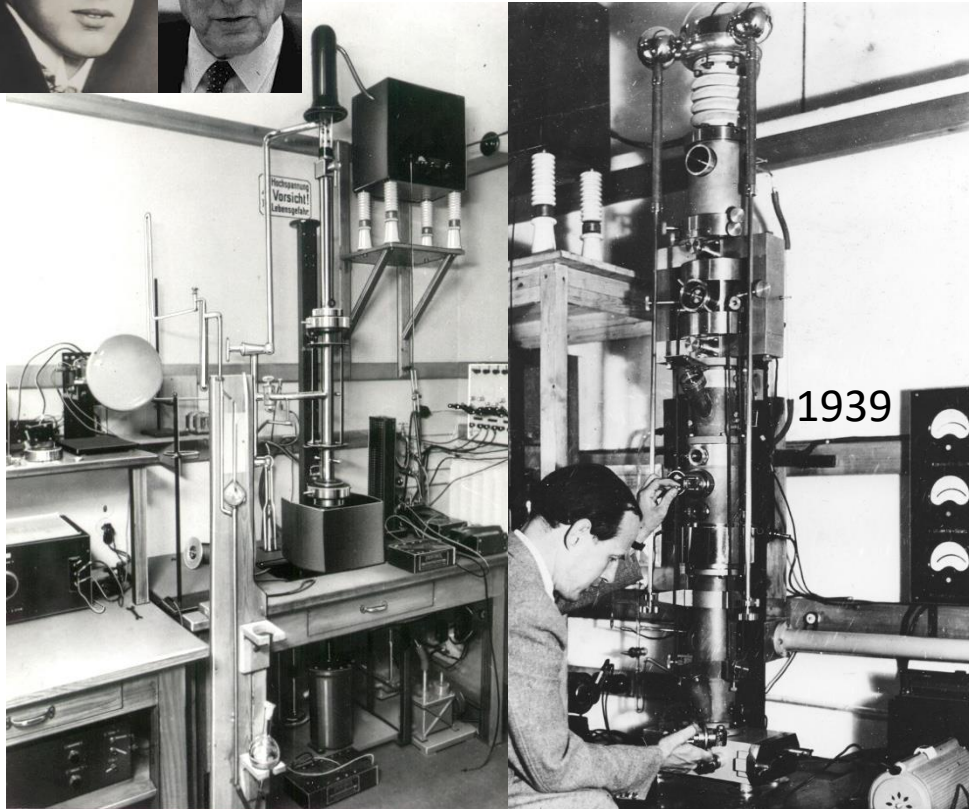
Learning Outcomes

- Basic knowledge about the main SEM component and what happens to the electrons in the SEM; how they are generated, interact with specimens and are then detected
- Learning about SEM beam alignment (astigmatism and wobble), magnification, focus, brightness, contrast, parameters affecting the quality (resolution) of the image
- Understanding SEM observations, sample preparation methods, and EDS

The First SEM

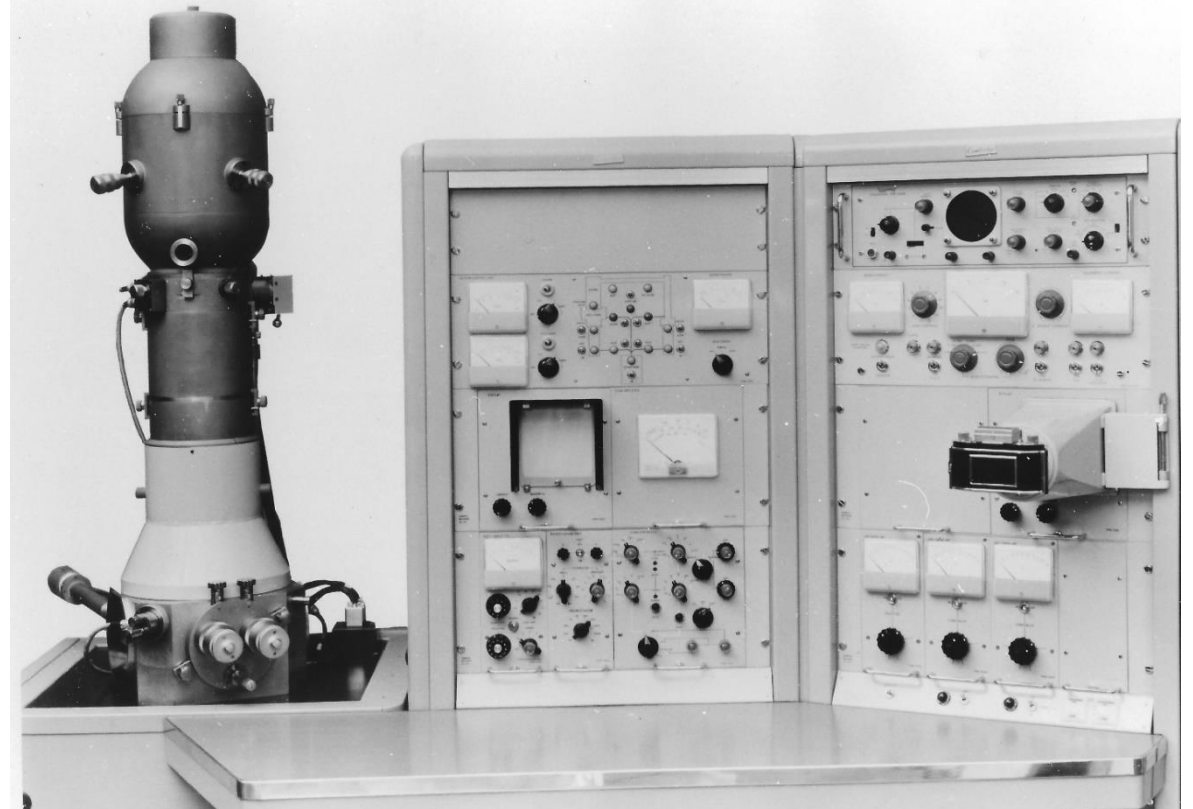


Prof. Manfred von Ardenne
(1907 - 1997)



The first SEM was invented and built by
Manfred von Ardenne in Germany 1937

<https://www.vonardenne.biz/ja/company/manfred-von-ardenne/>



Stereoscan MK1, the first commercial SEM
Cambridge Scientific Instrument Company in 1965

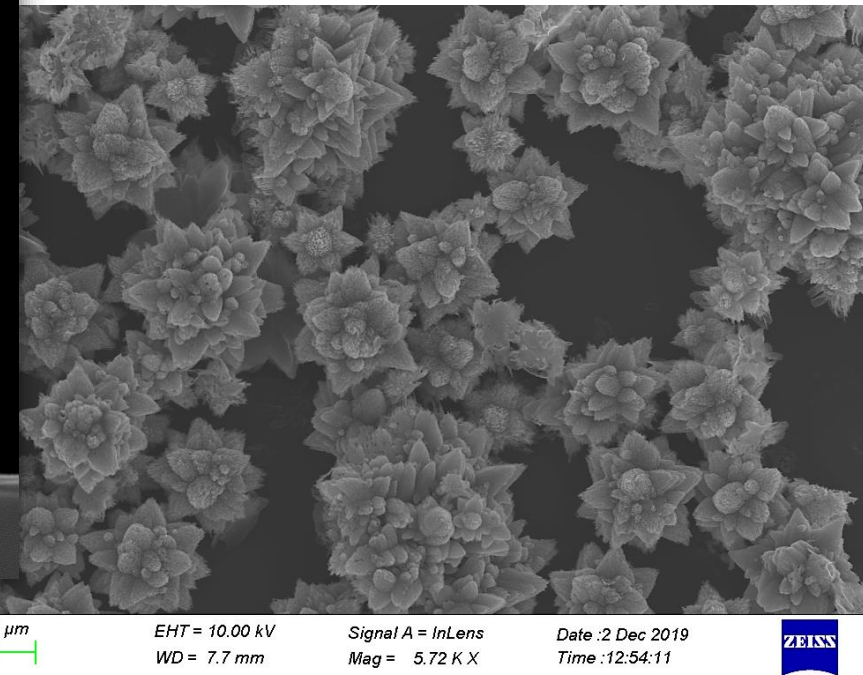
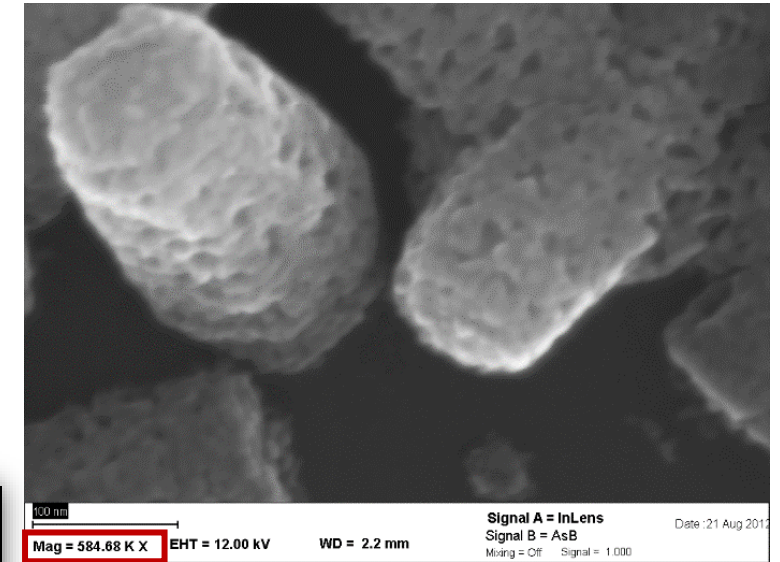
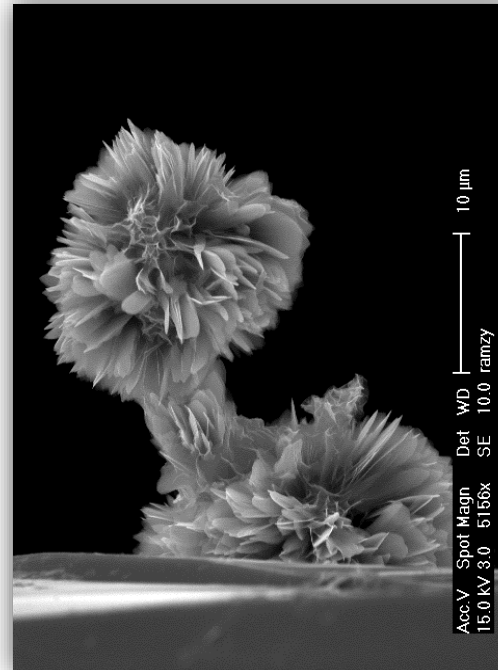
What is SEM?

Scanning electron microscope (SEM)

- A type of electron microscope that produces images of a sample by scanning the surface with a focused beam of electrons
- The electrons interact with atoms in the sample, producing various signals that contain information about the surface topography and composition of the sample

Why SEM?

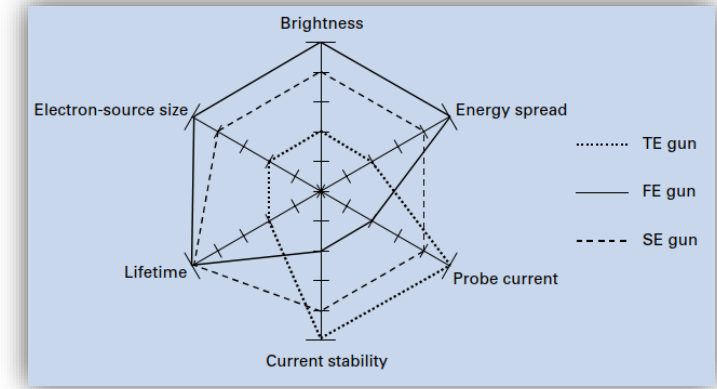
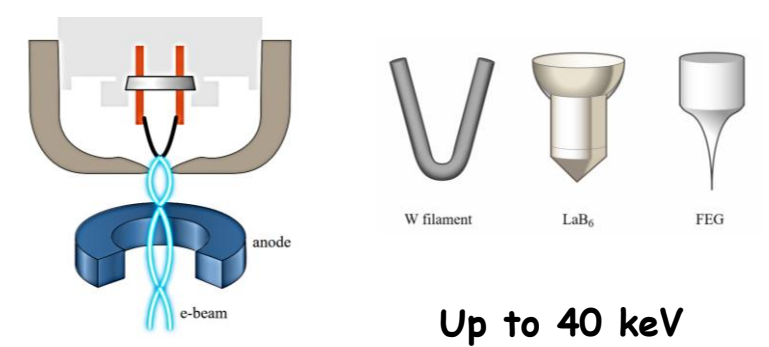
- Magnification range 10 to 1 million times
- Resolution of ~ 0.5 nm
- Excellent depth of field (3D appearance)
- Relatively easy sample prep.



SEM Components

✓ **Electron Gun**

- Thermionic gun
- Field-Emission Gun (FE)
- Schottky-Emission Gun



✓ **Condenser Lenses**

Electromagnetic lenses focusing the beam
→ fine electron probe

✓ **Objective aperture**

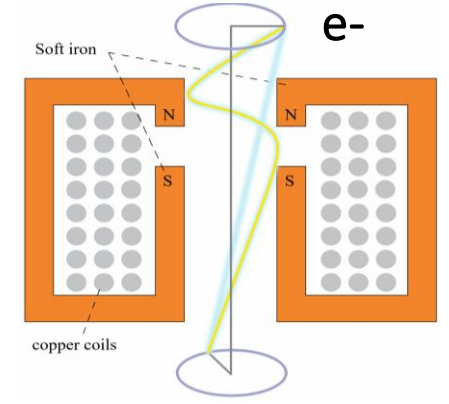
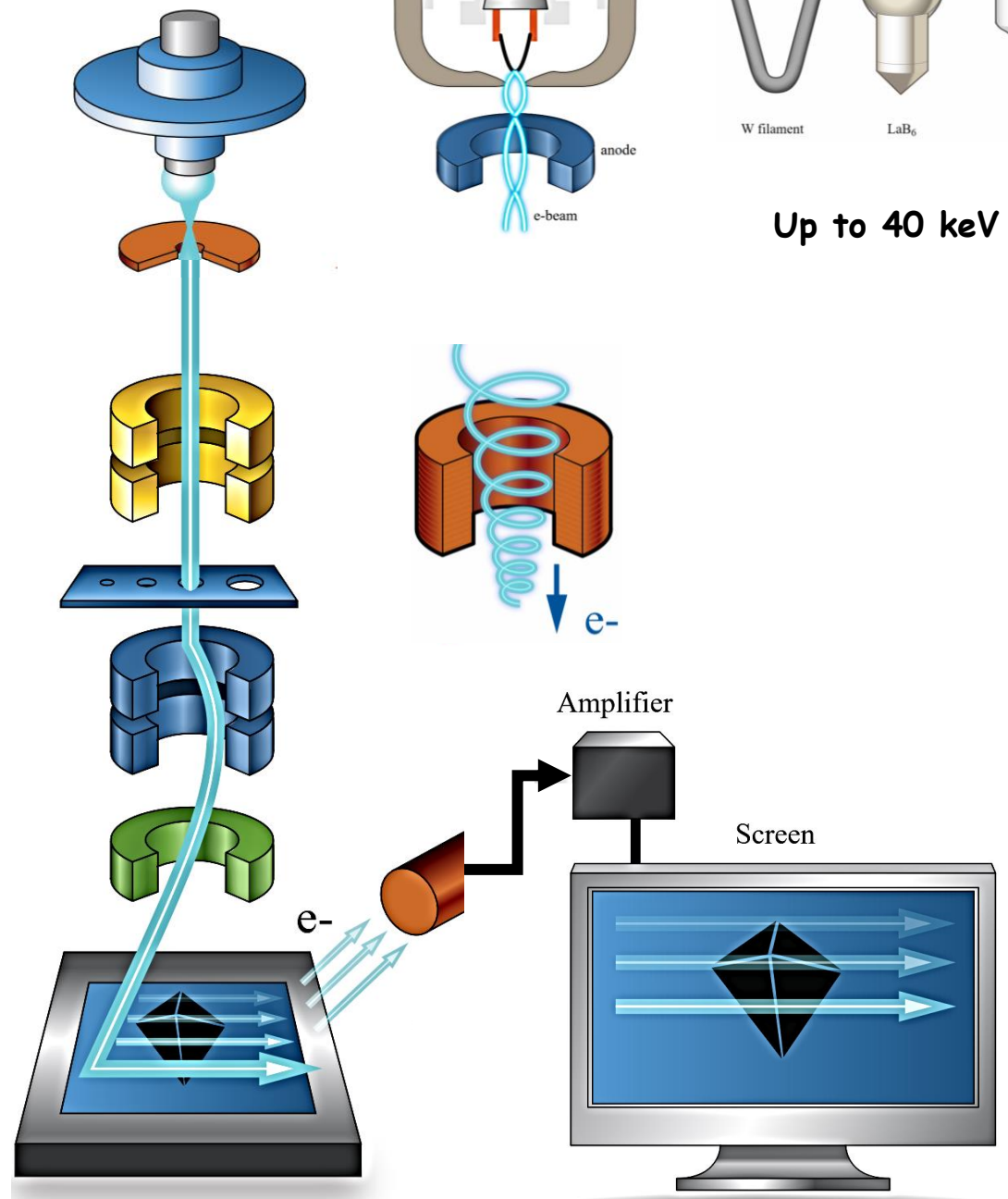
To control the amount of probe current

✓ **Scan coils**

Two pairs of electromagnetic deflection coils to construct the image point-by-point and line-by-line

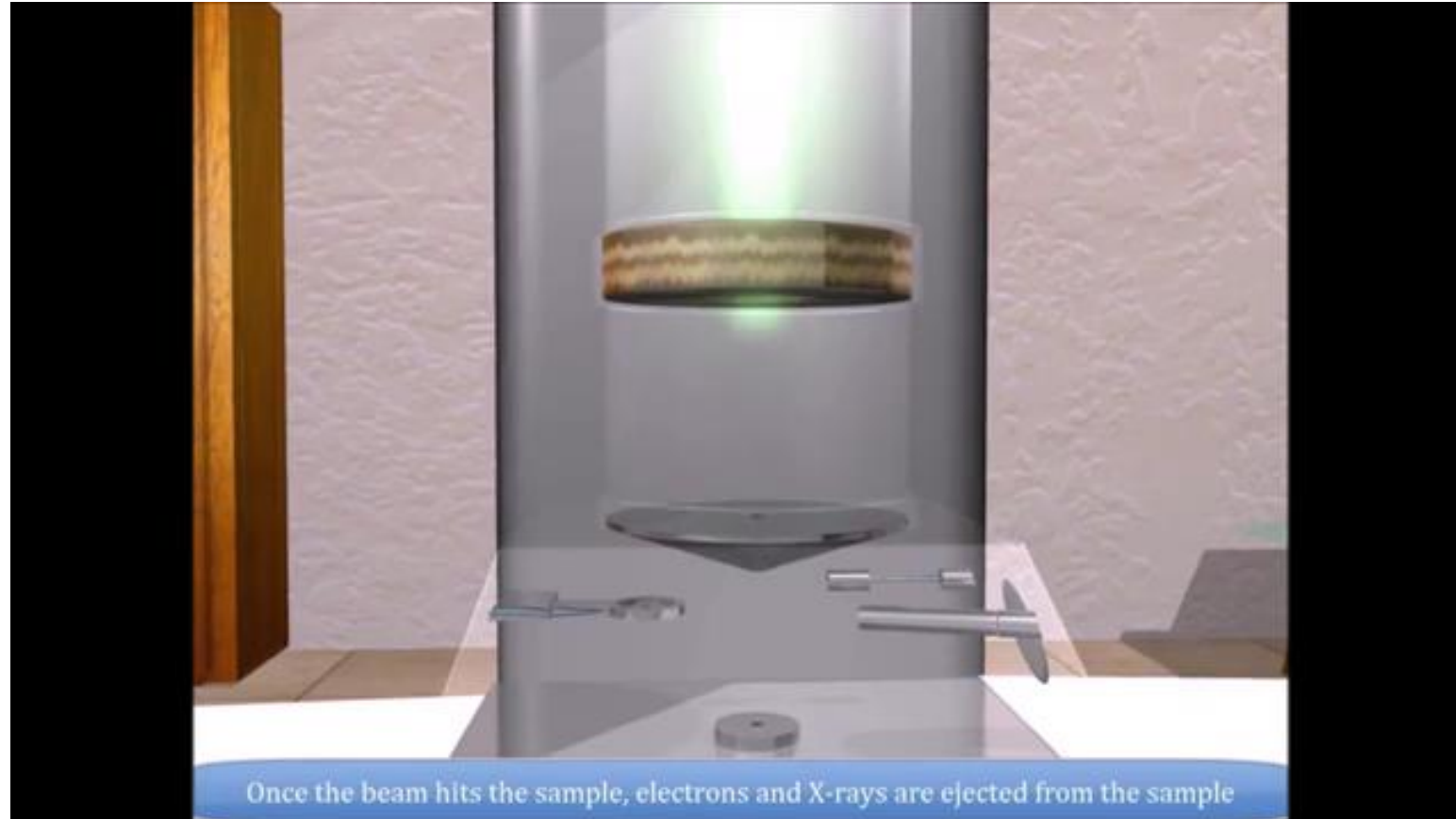
✓ **Objective Lens**

- Focus the beam onto the sample
- Influence over the diameter of the spot size of the electron beam



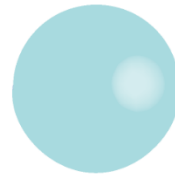
- ✓ Astigmatism correction coil
- ✓ Vacuum system
- ✓ Water chilling system
- ✓ Column
- ✓ Specimen chamber
- ✓ Detectors
- ✓ Imaging system

SEM Operation



<https://www.youtube.com/watch?v=Vs360UarP1U>

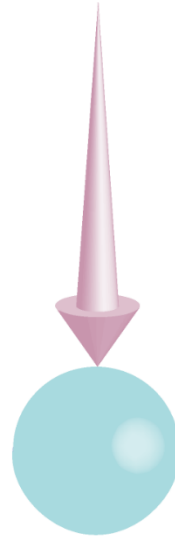
Electron Matter Interaction in SEM



Specimen

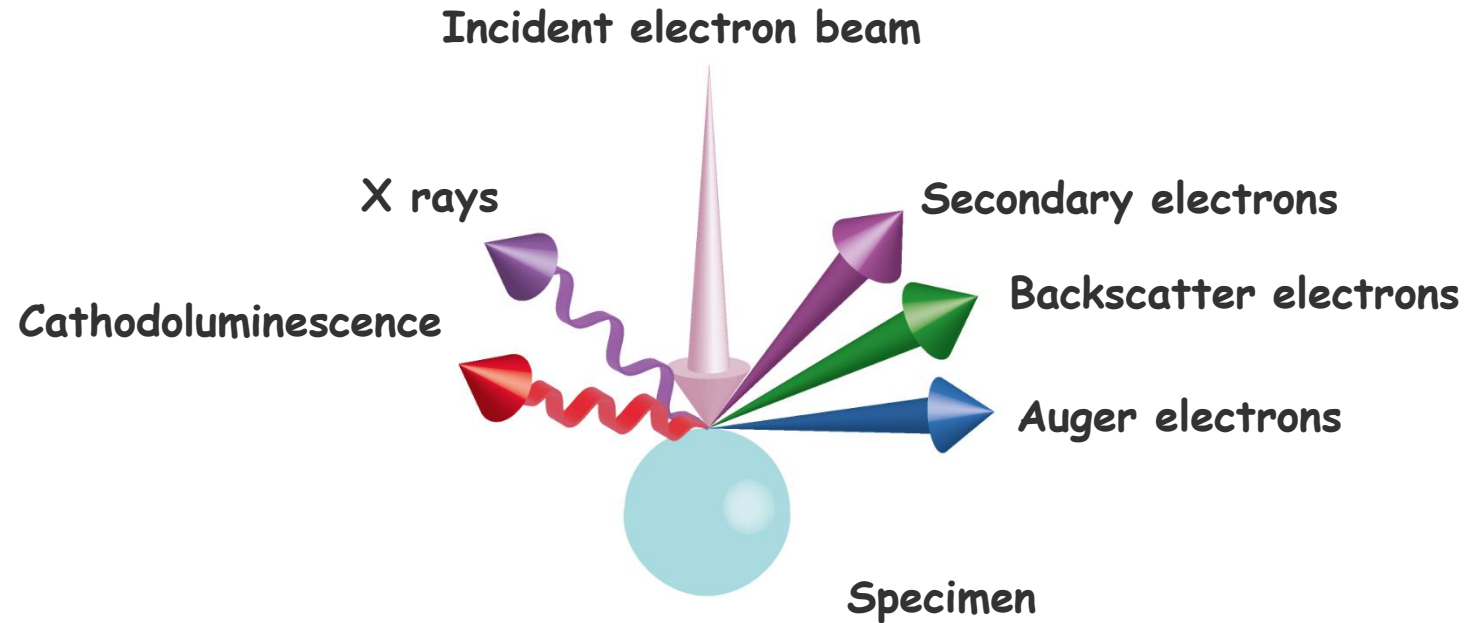
Electron Matter Interaction in SEM

Incident electron beam



Specimen

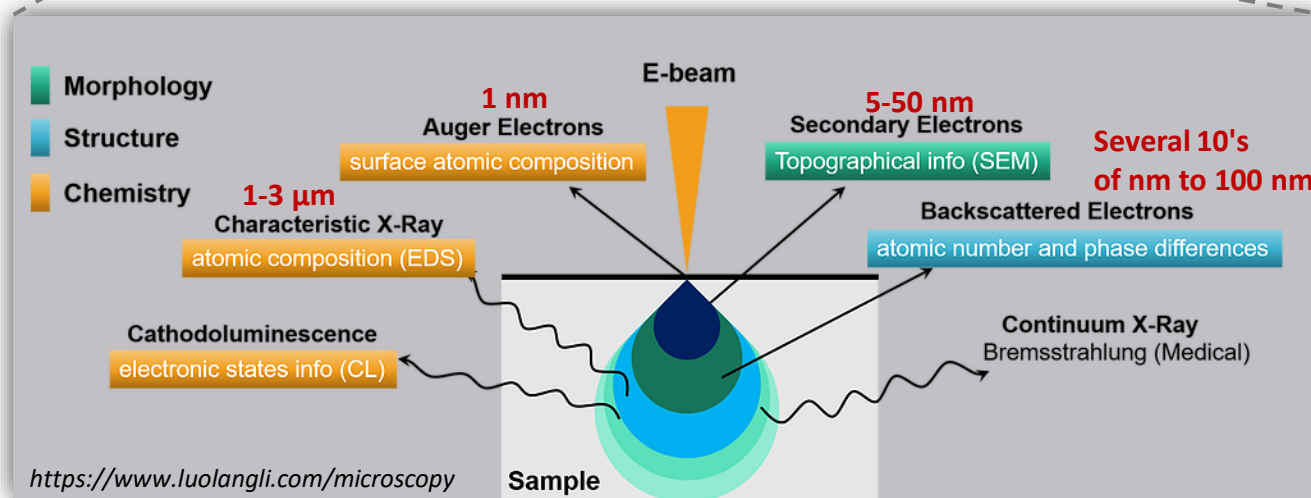
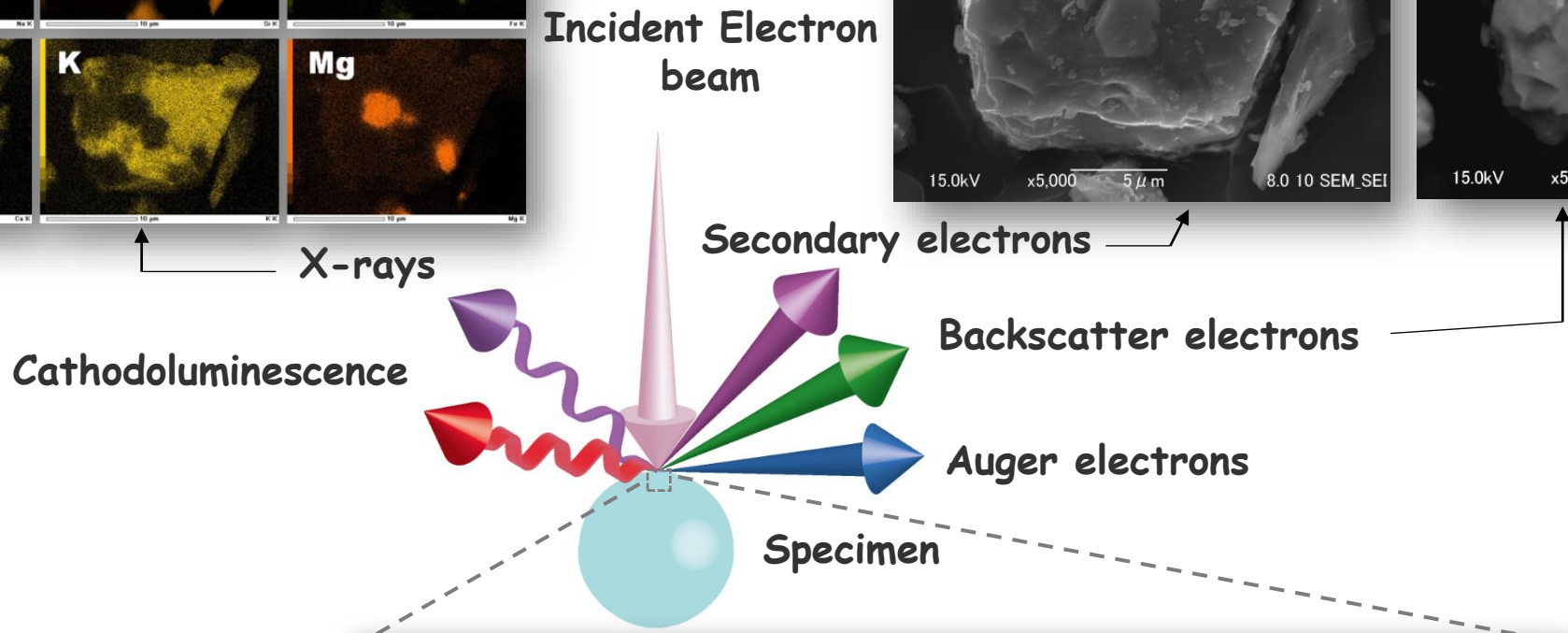
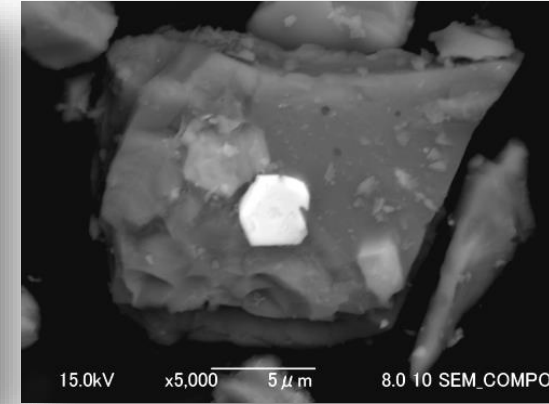
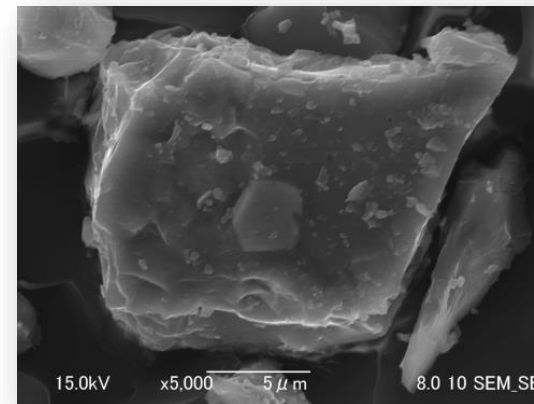
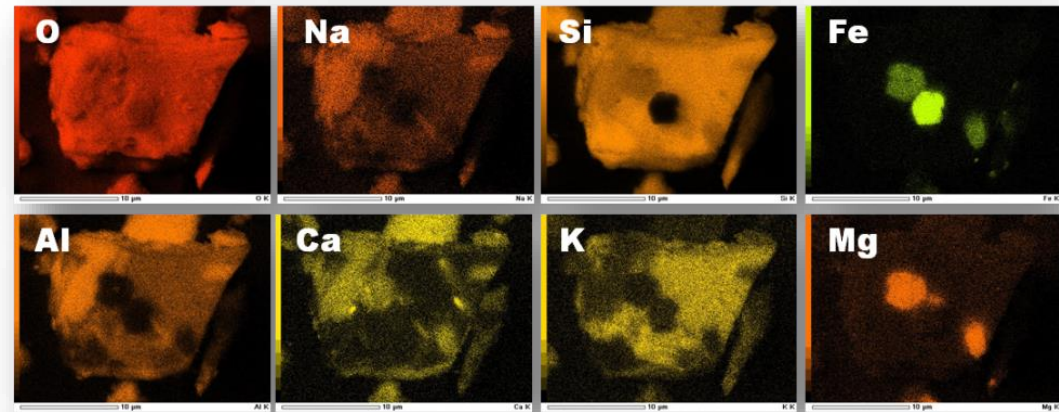
Electron Matter Interaction in SEM



- When irradiating the material with electron beam in vacuum, various signals are emitted
- Electron microscopes can obtain various information of substances by using these signals

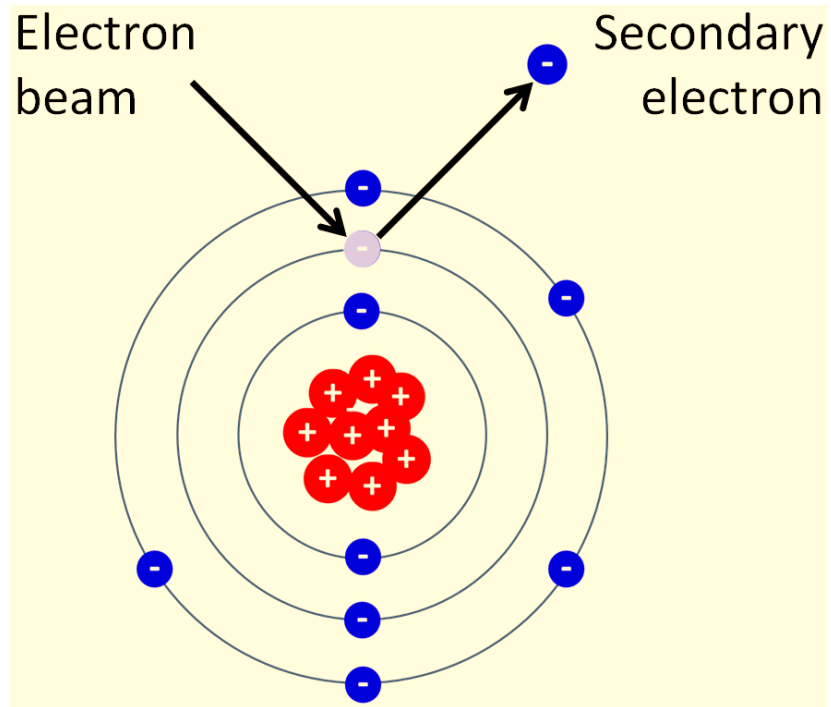
Volcanic Ash

Volcanic Ash



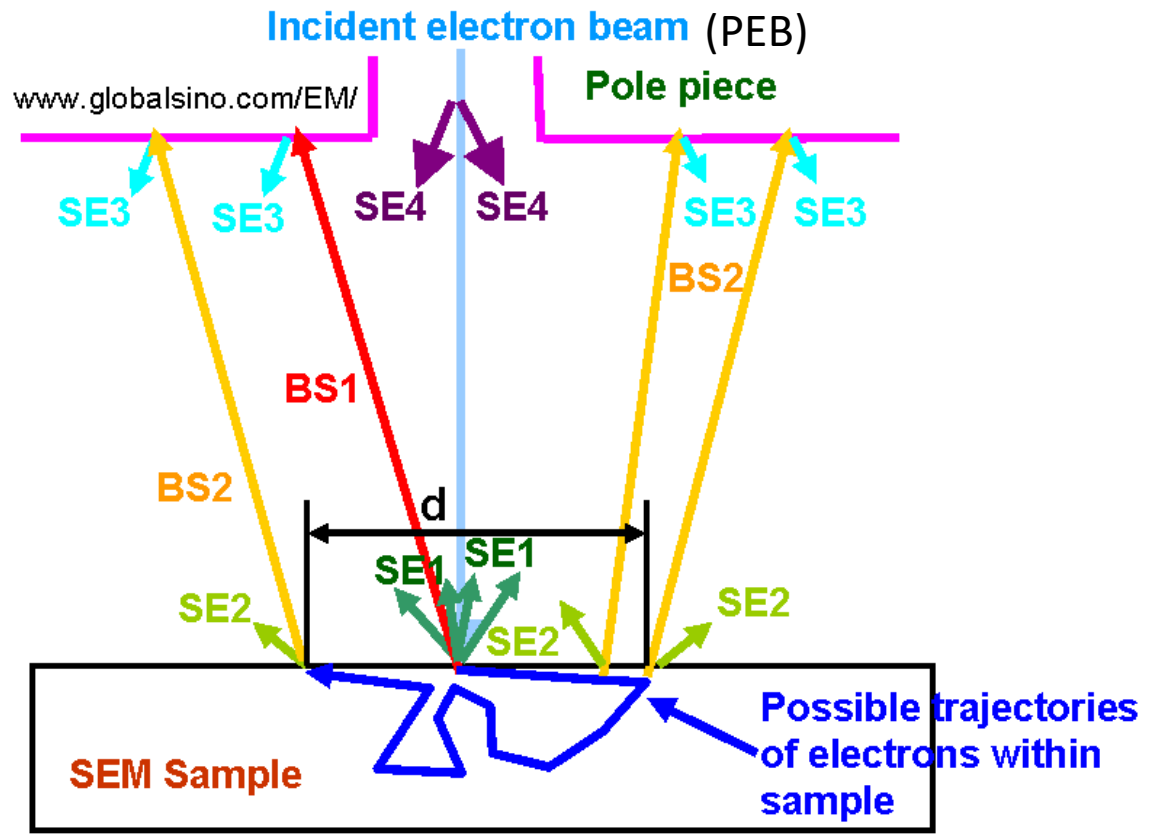
From Jeol

Secondary Electrons (SE)



- Inelastic collision between the primary electrons (PE) and the valence electrons of the constituent atoms in the specimen → ejection of secondary electrons (SE)
- Very low energy electrons ~ 2-50 eV
- Generated close to surface (5-50 nm)
- Topography contrast, provide particularly good edge detail

Types of SE

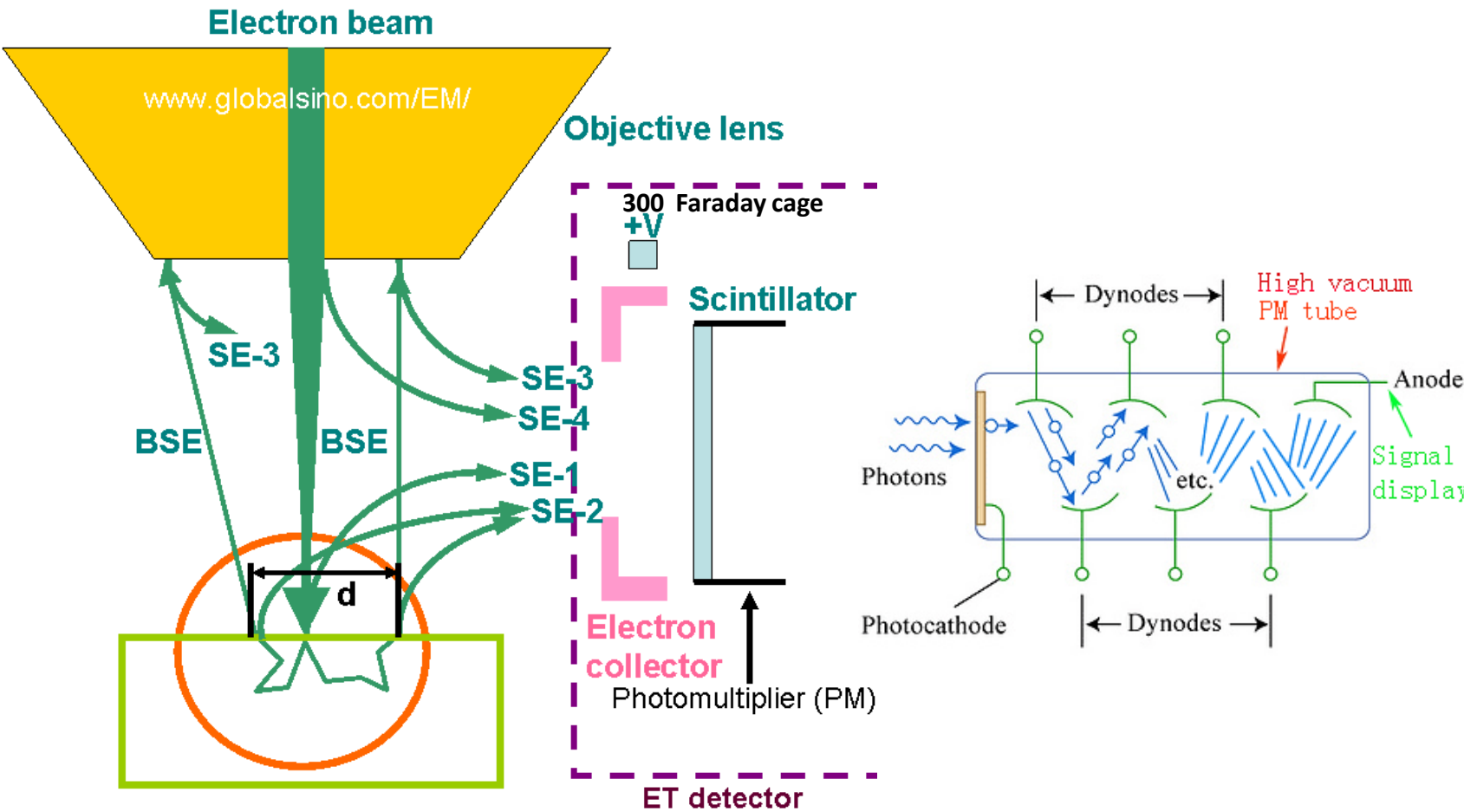


- Primary incident beam → SE1 Some Z contrast
- BSE as they leave the specimen → SE2
- BSE colliding with chamber or lens system → SE3
- PIB strikes an aperture within the electron column → SE4

Everhardt-Thornley Detector (ETSE)

- Main components: a collector grid, a scintillator, and a photomultiplier

- Mainly SEs (< 50 eV) are pulled toward the scintillator by a high potential (300 V) on the collector grid (Faraday cage)



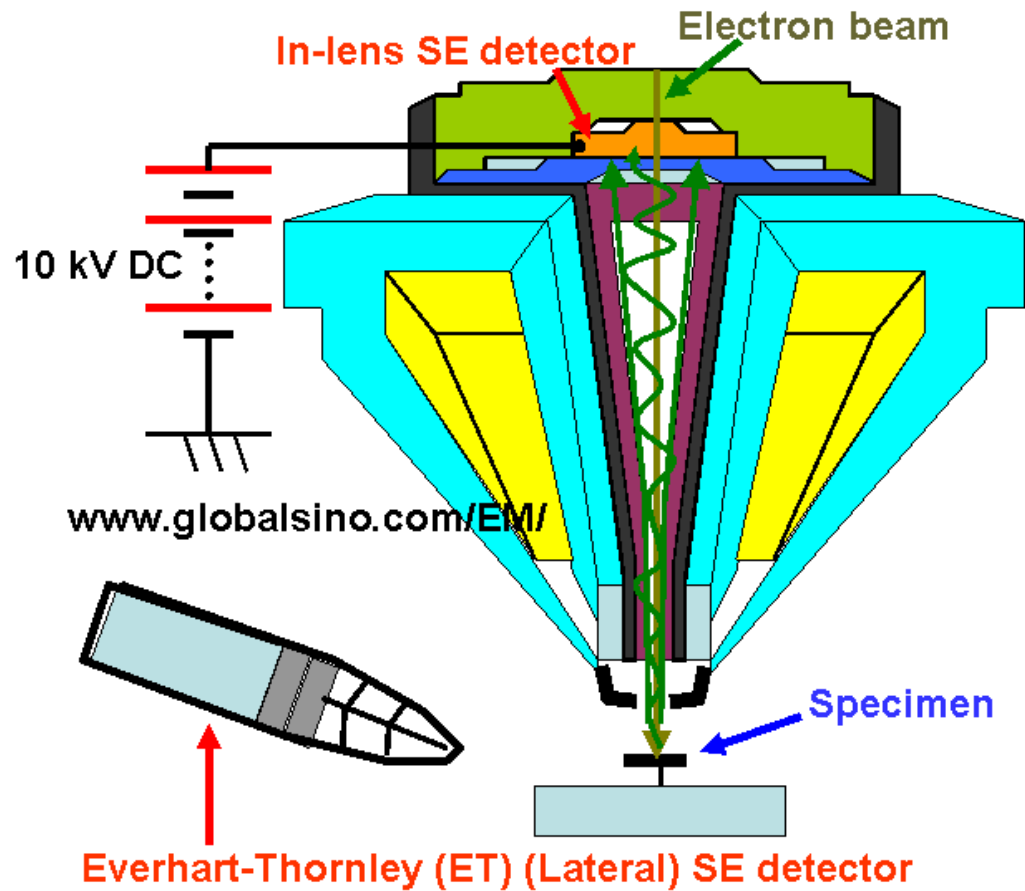
- A **scintillator** (fluorescent substance) is used to convert electrons to visible light that is amplified by a **photomultiplier (PM)**

- A high positive bias (10 kV) on the scintillator attracts and accelerates SEs enough to be converted to light photons

- The light is conducted through a guiding tube (LG) to a photomultiplier

- The photons converted back to electrons at the **photocathode**, the electrons are accelerated and multiplied by the dynodes

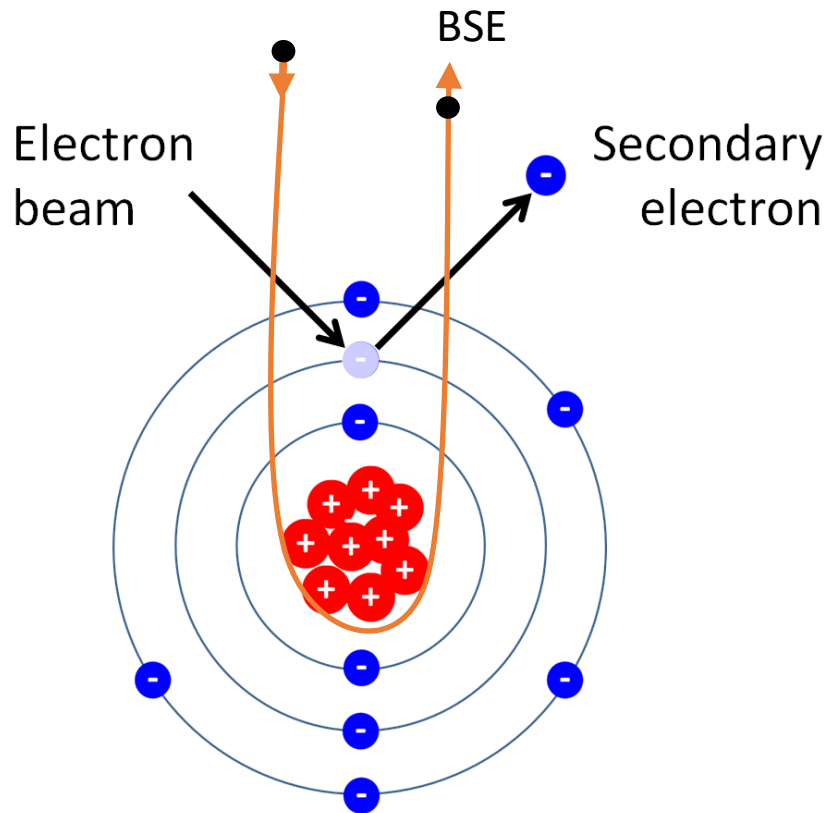
In-lens SE Detector



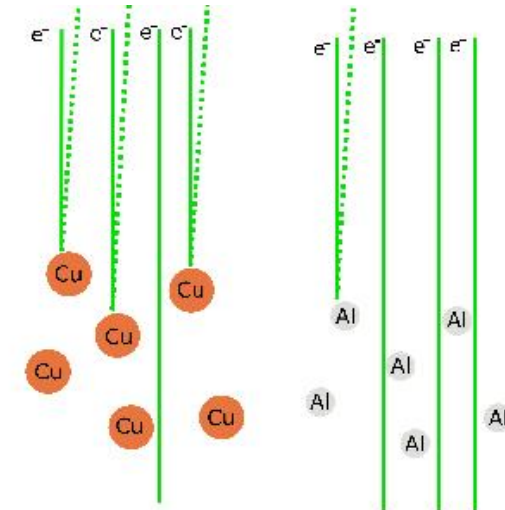
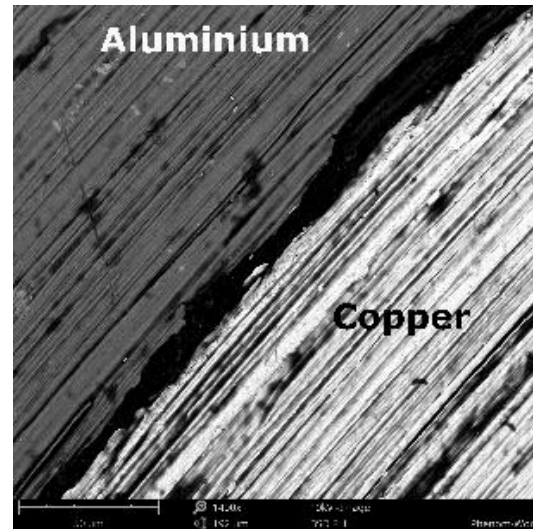
- Mostly collect SE1
- SE1 carry the highest spatial resolution information
- Ideal for very fine structures with short WD

Backscattered electrons (BSE)

- Tiny particles (electrons) collide with larger particles (atoms)
- Larger atoms are a lot stronger scatterers of electrons compared to light atoms
- High energy electrons same as the incident electrons
- Generated from deeper layers (several 10's of nm to 100 nm)
- Material contrast, depend on atomic number (Z)



- Elastic scattering of the primary electrons (PE) by atom nucleus
- PE is deflected by the electrostatic field of the positive nucleus

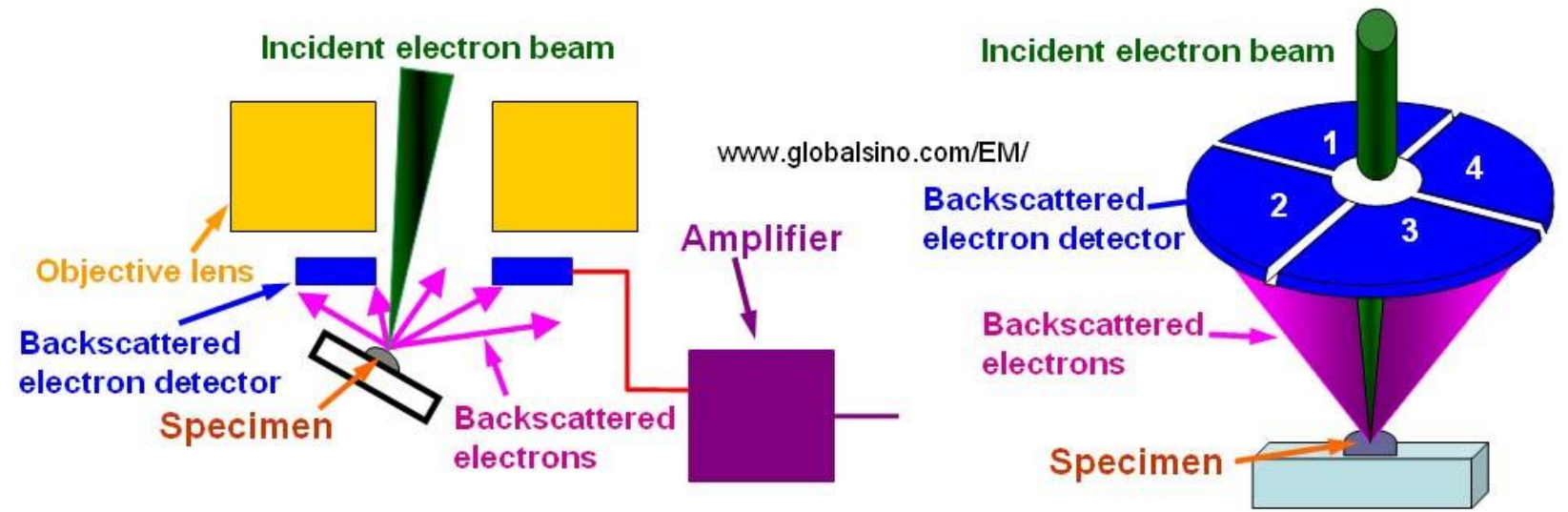


<https://www.azom.com/article.aspx?ArticleID=14309>

Copper atoms (higher Z) scatter more electrons back towards the detector than the lighter aluminum atoms and therefore appear brighter in the SEM image

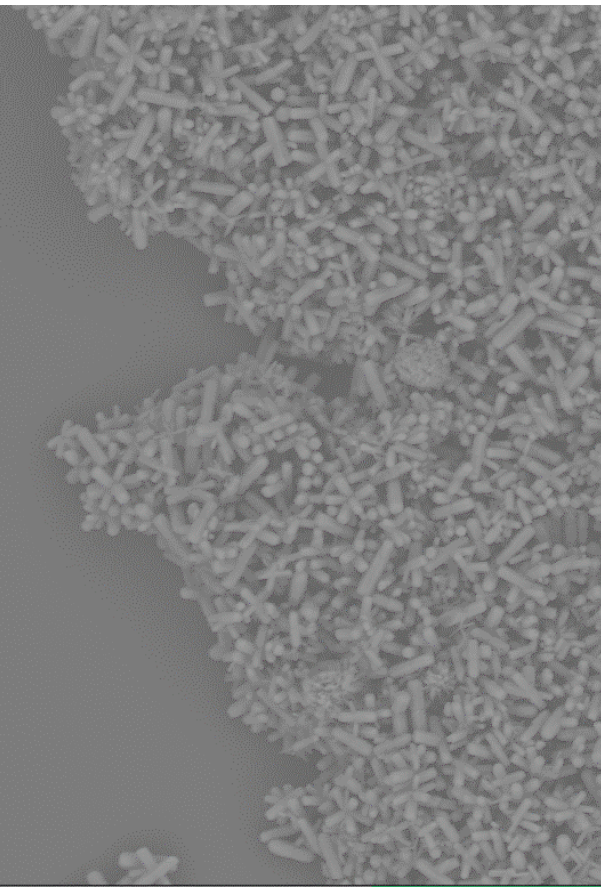
Solid-state BSE detector

BSE Detector



- BSEs detector is usually a four quadrant solid state detector (p-n junction) that is placed directly above the specimen
- BSEs that hit the detectors excite the silicon electrons, generating an electron-hole pair
- The p-n junction is linked to two electrodes, one of which attracts the electrons and the other the holes, thus producing an electrical current, which can be amplified

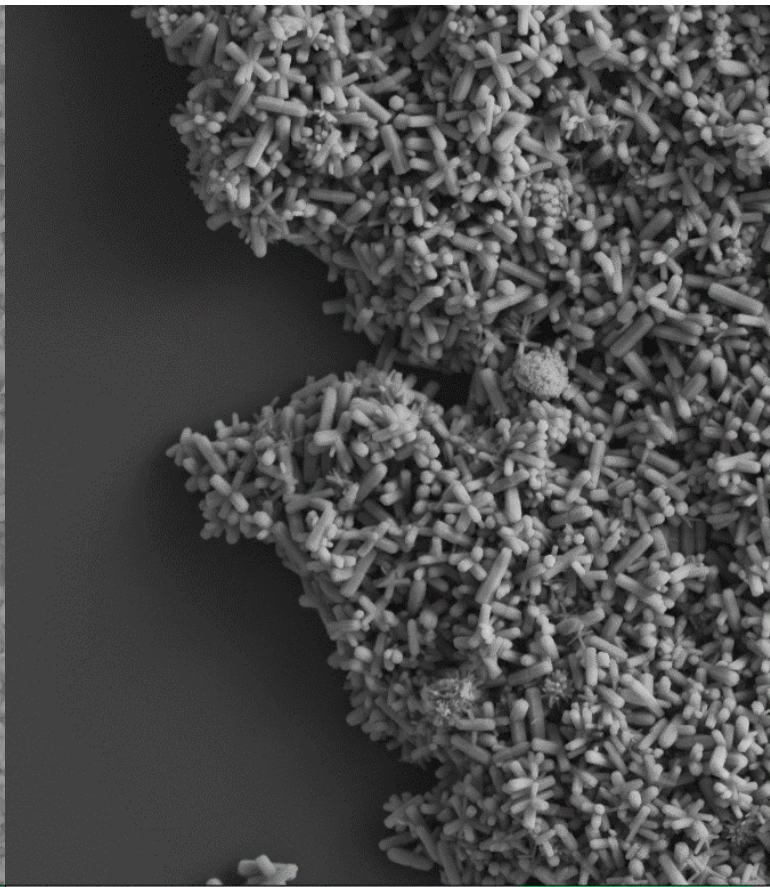
BSD



EHT = 8.00 kV
WD = 6.2 mm

Signal A = NTS BSD
Mag = 3.80 K X

SED

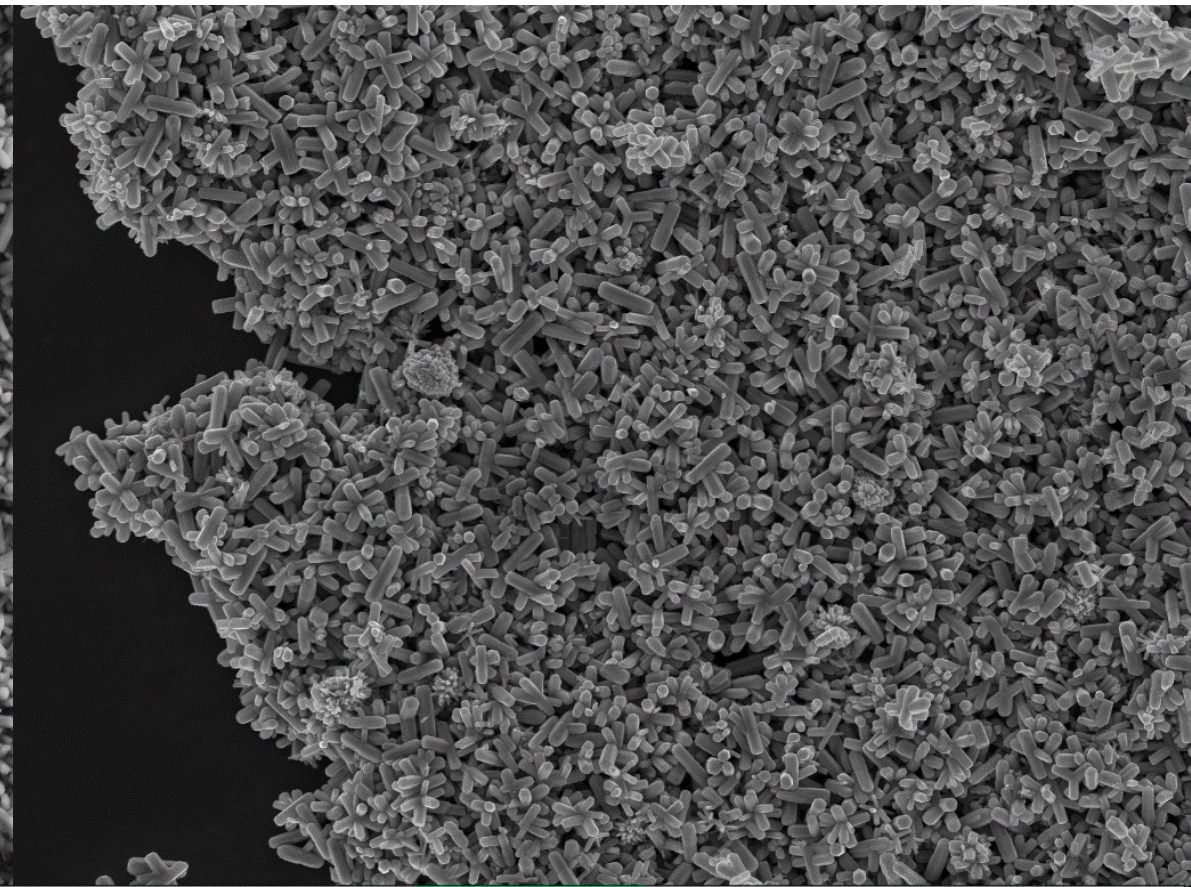


EHT = 8.00 kV
WD = 6.2 mm

Signal A = SE2
Mag = 3.80 K X

1 μ m


In-lens SED



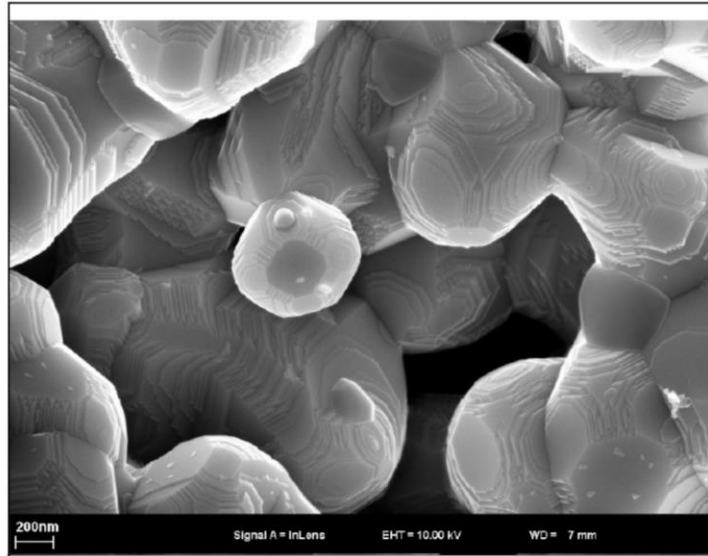
EHT = 8.00 kV
WD = 6.2 mm

Signal A = InLens
Mag = 3.80 K X

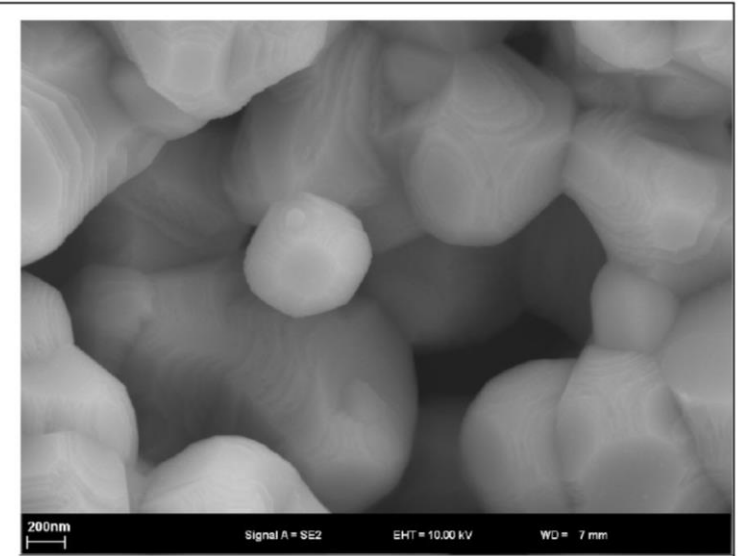
Date : 2 Dec 2019
Time : 16:20:15



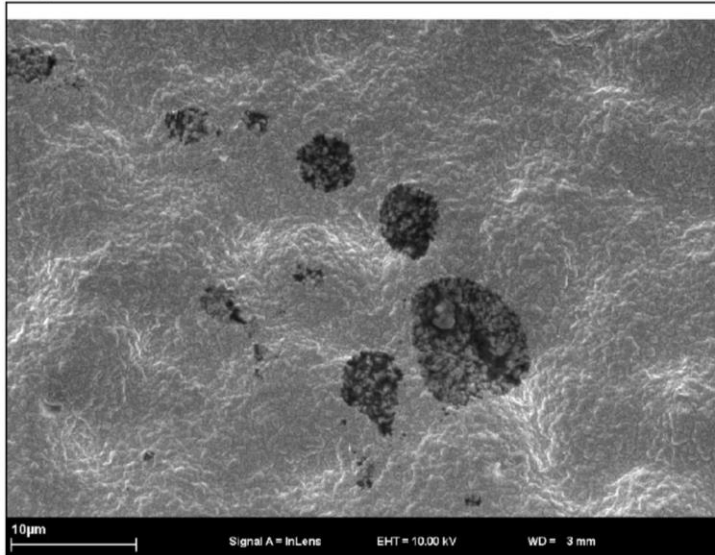
In-lens vs SE2



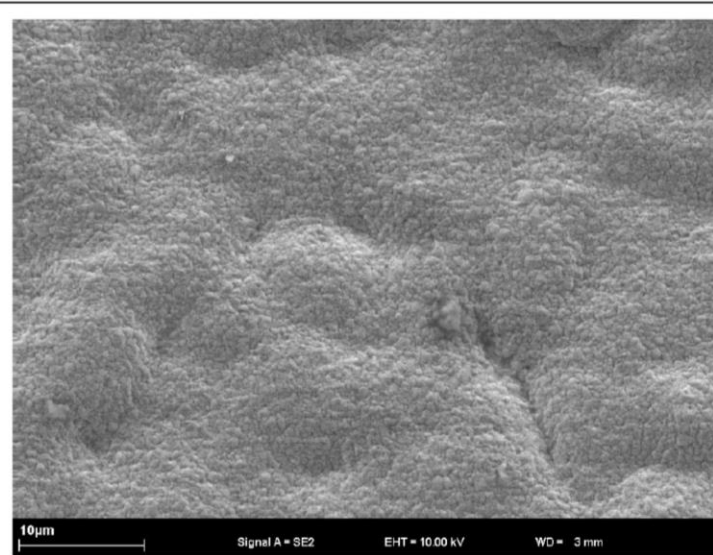
In-lens detector
Clear edge effect with good imaging
of the surface structures



ET-SE detector
Little surface information

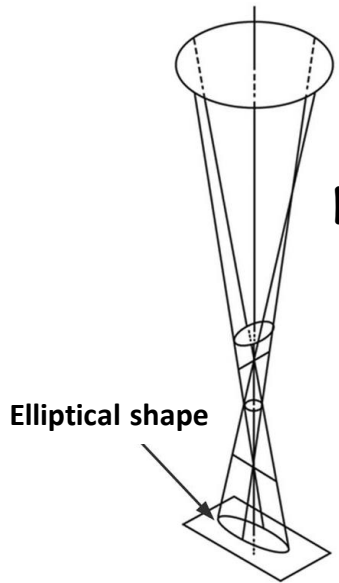


In-lens detector
Imaging of thin layers
on the specimen's surface



ET-SE detector
Layers are not imaged

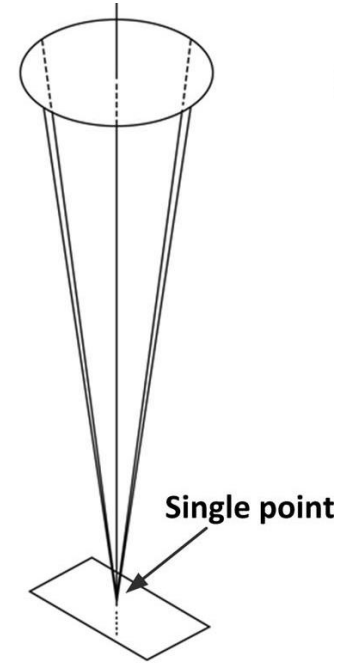
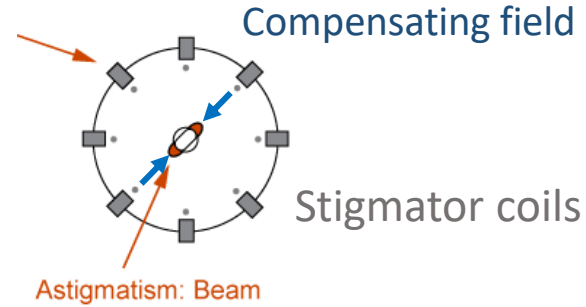
Astigmatism



Non-spherical electron beam

How to correct?

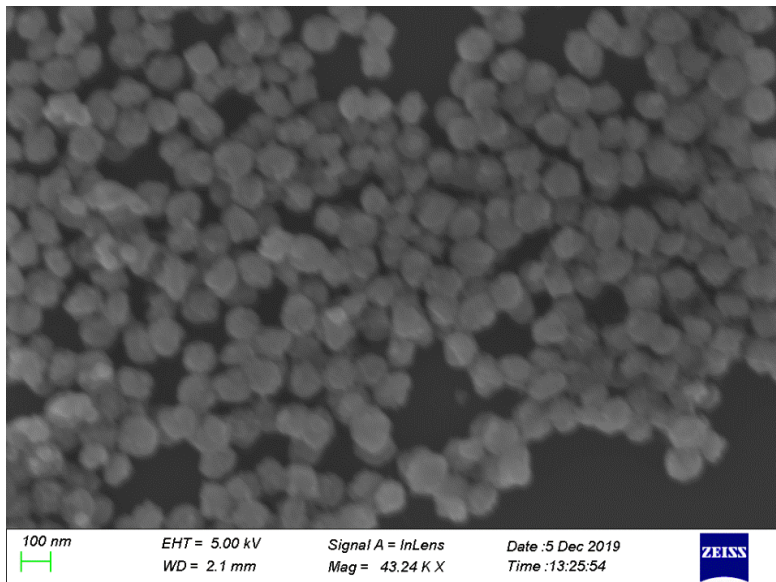
- Go to high mag.
- Focus (between elongations)
- Stigmator



3

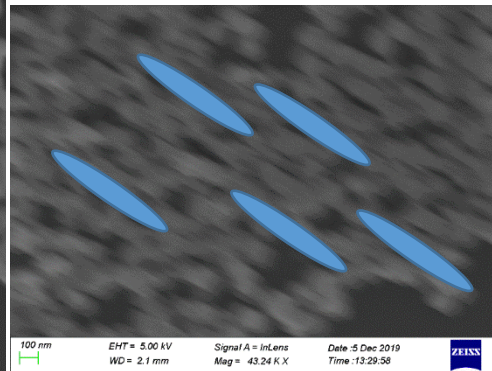
Astigmatism

4



Blurred image

1 Underfocus



2 Overfocus

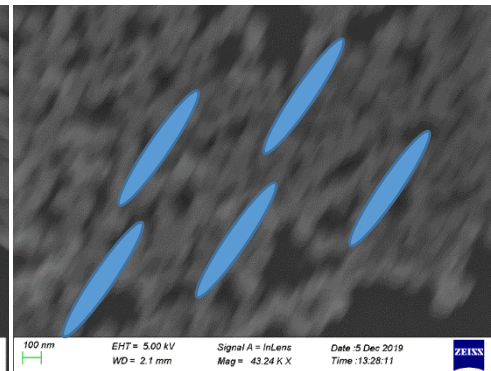


Image of defocus

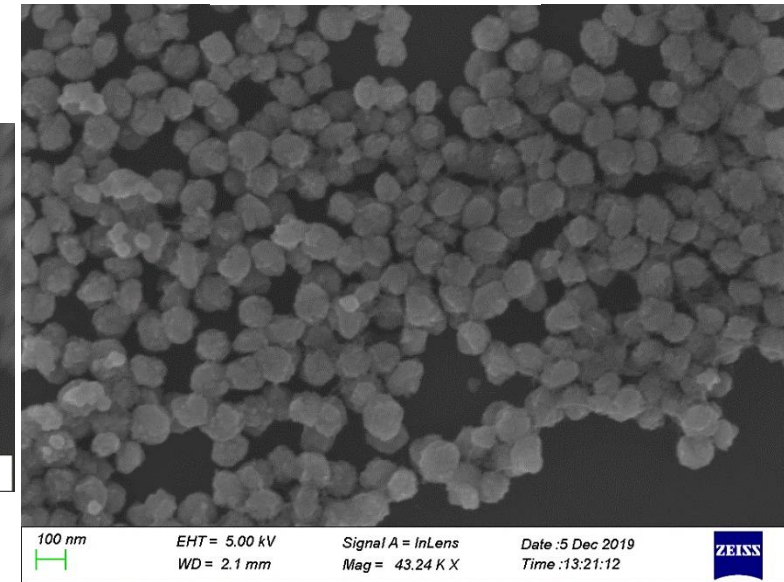
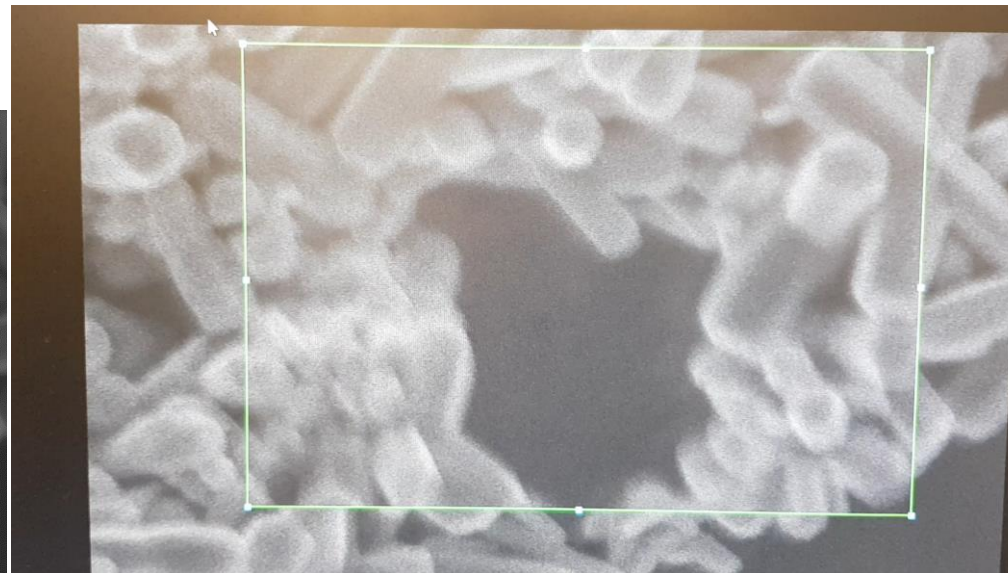
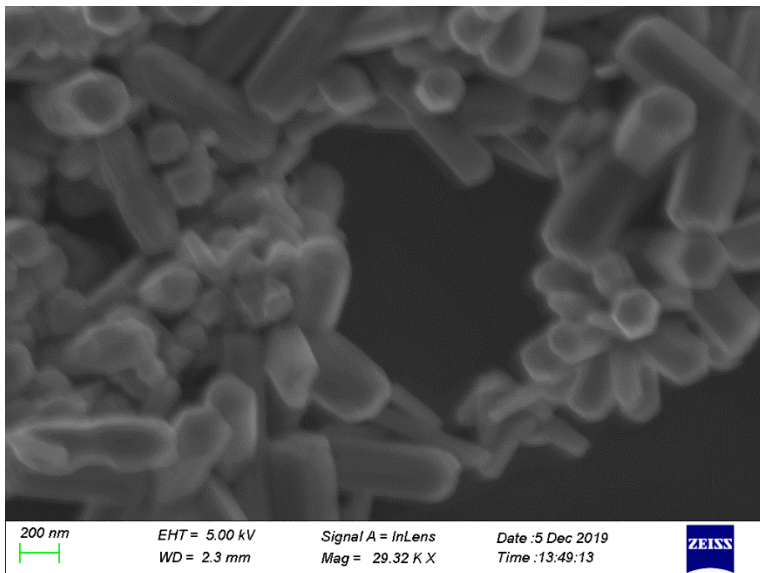


Image of In-focus
After astigmatism correction

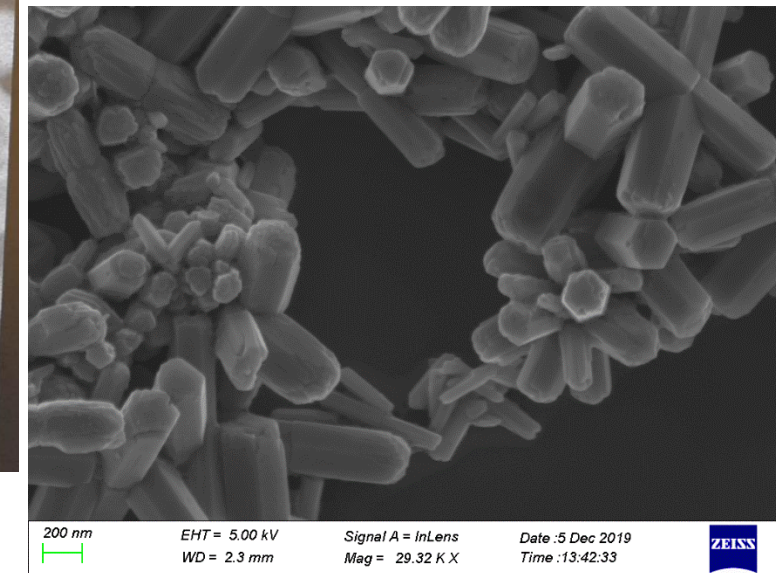
Wobble Aperture Alignment

- Ensuring that the apertures are centered with respect to the beam and thus the optical axis of the microscope (perfectly perpendicular to lenses)
- **HT wobbling:** is done by changing the acceleration voltage of the microscope
- If an objective aperture is not centered the image will move when you try to focus it. The way to correct this is to wobble the current to the objective lens and align the aperture to minimize movement in both the X and Y plane.
- This correction is done at successively higher magnifications—course to fine adjustment.
- The screen will “breath”, pumping in and out of the screen.

Before wobbling adjustment
Unfocused image (blurred)

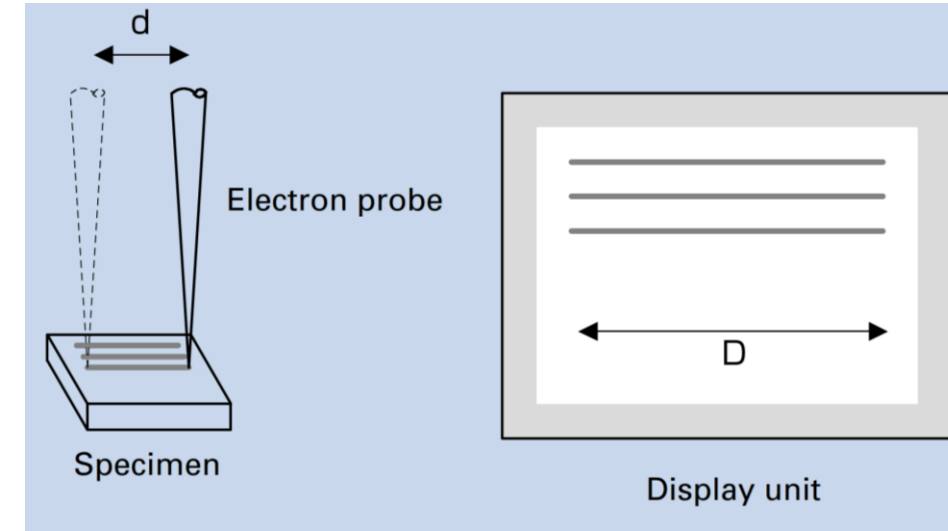
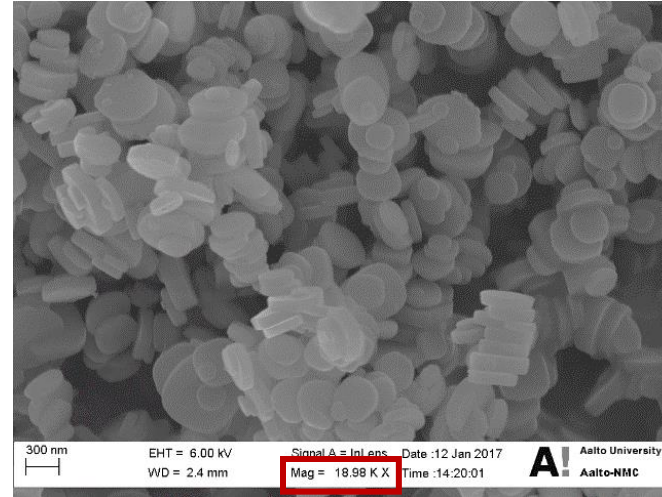


After wobbling adjustment
Focused image (sharp)



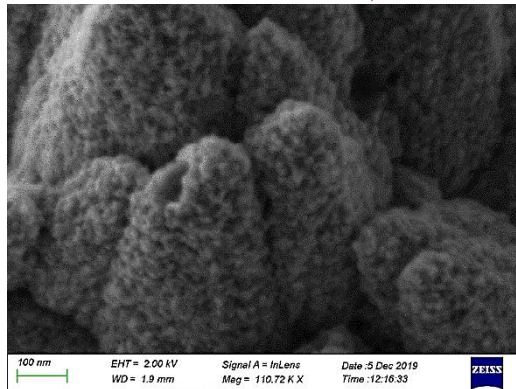
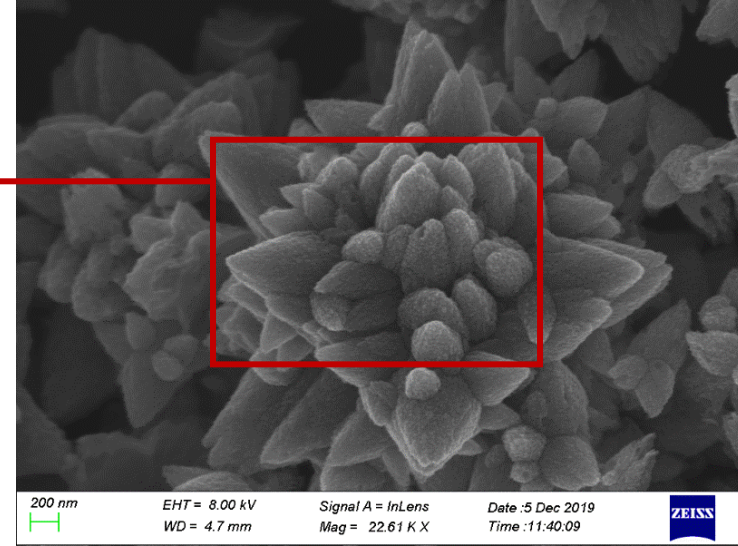
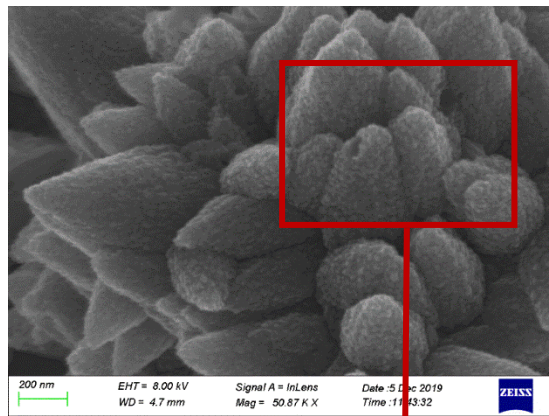
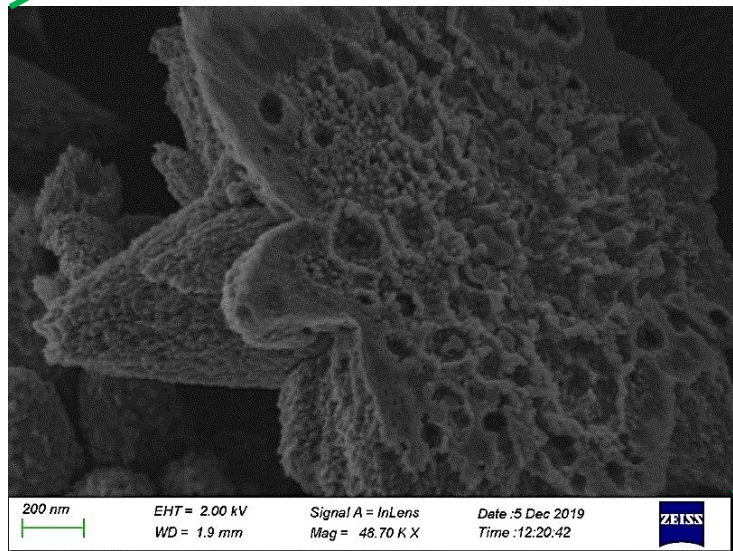
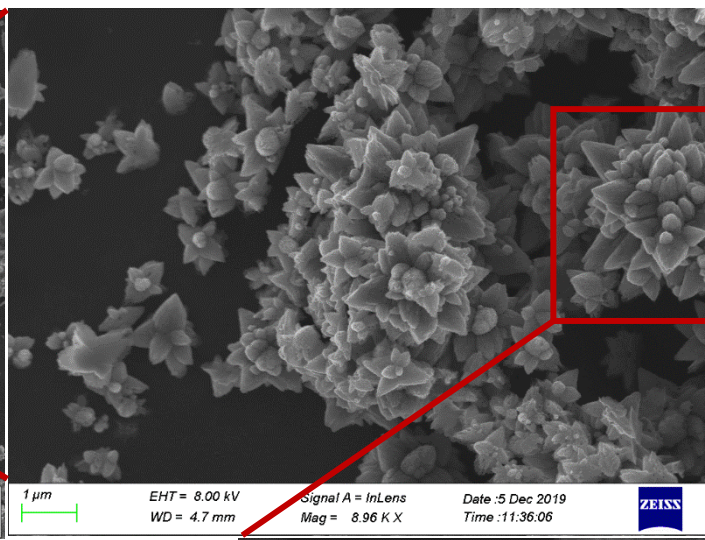
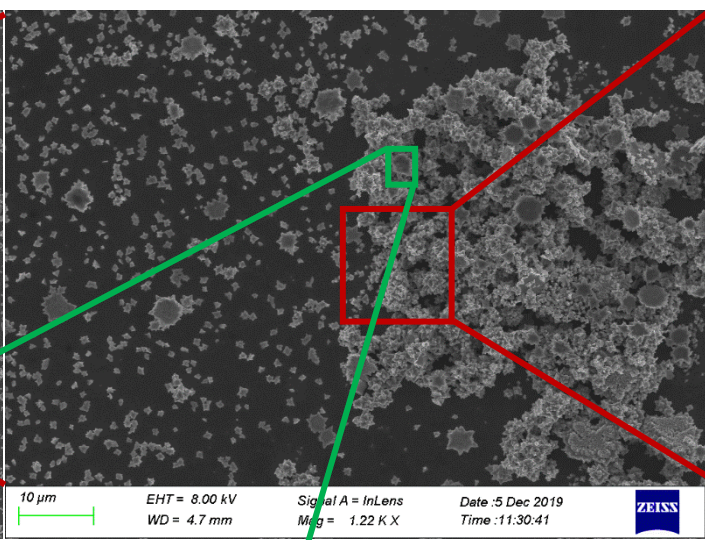
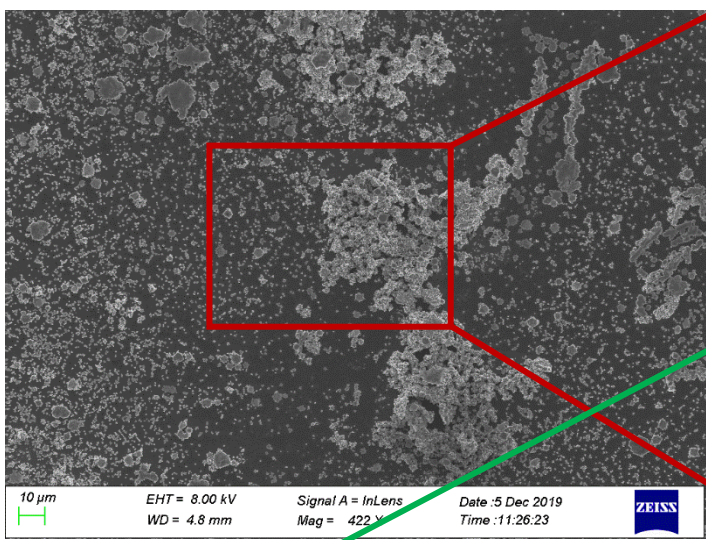
Magnification

- The specimen surface is two-dimensionally scanned by the electron probe
- SEM image appears on the monitor screen of the display unit



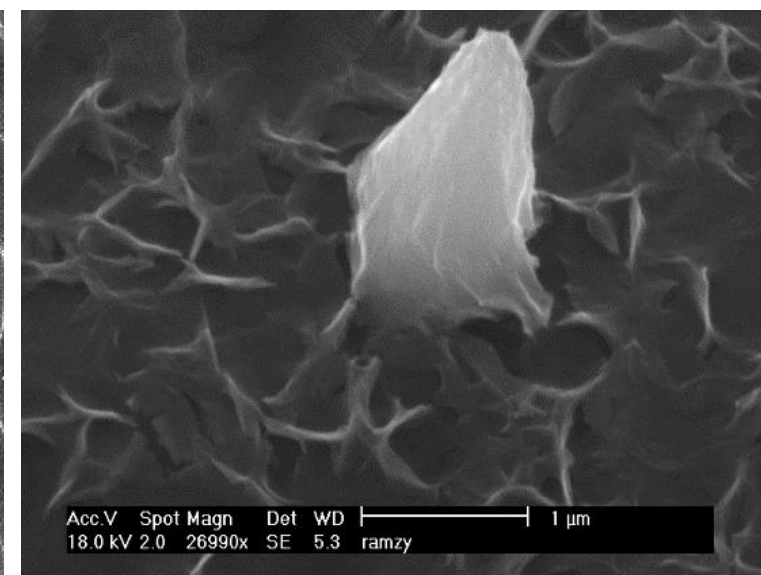
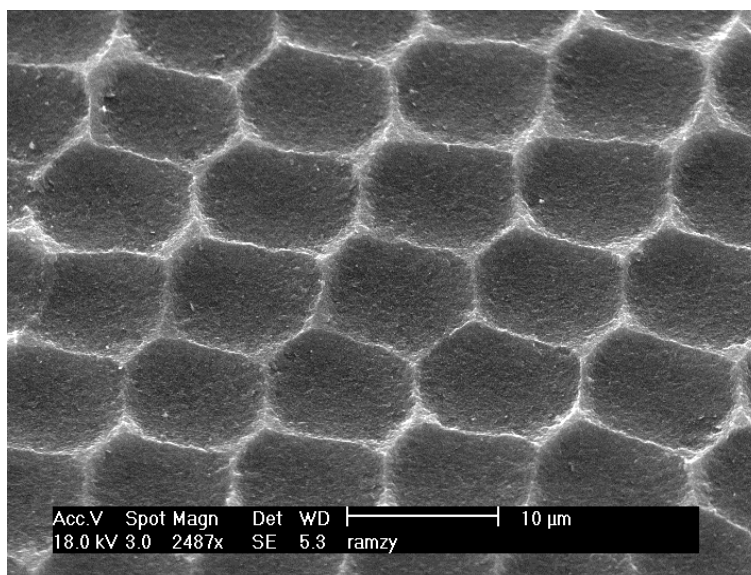
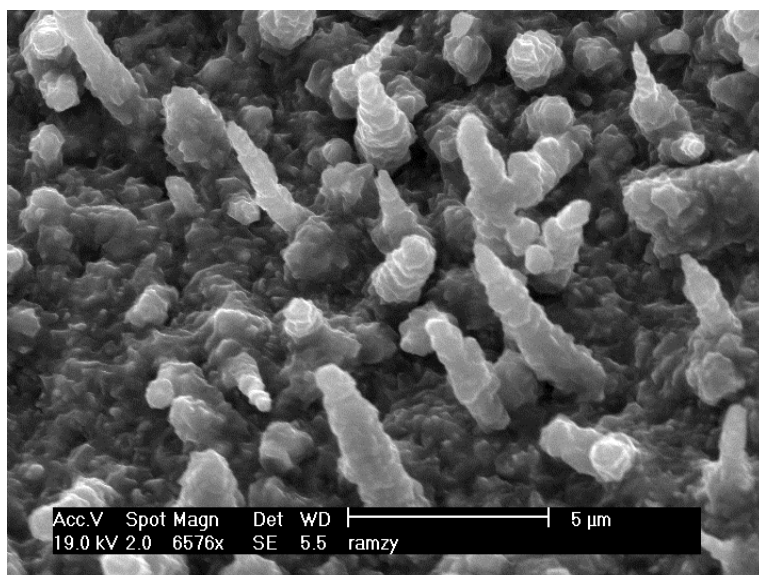
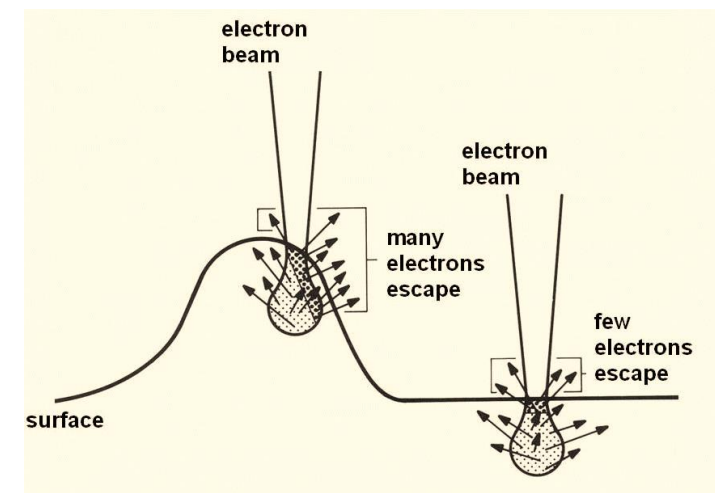
- SEM magnification = $\frac{\text{a length measured from the SEM monitor (D)}}{\text{length measured on the sample (d)}}$

Magnification (M)	Example 1 – HFOV	
	Image width D	Scan length d
10	24 cm	24.00 mm
100	24 cm	2.40 mm
1,000	24 cm	0.24 mm
10,000	24 cm	24.00 μm
100,000	24 cm	2.40 μm
1,000,000	24 cm	0.24 μm



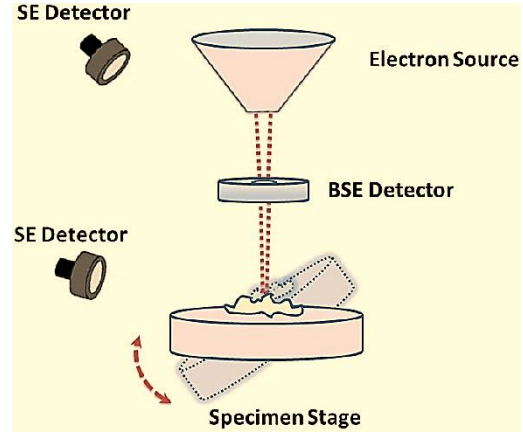
Edge Effect & Topography Contrast with SEs

- SEs → morphology & surface topography
- Contrast is dominated by the so-called edge effect
- SEs ↑ can leave the sample @ edges than in flat areas → brightness ↑

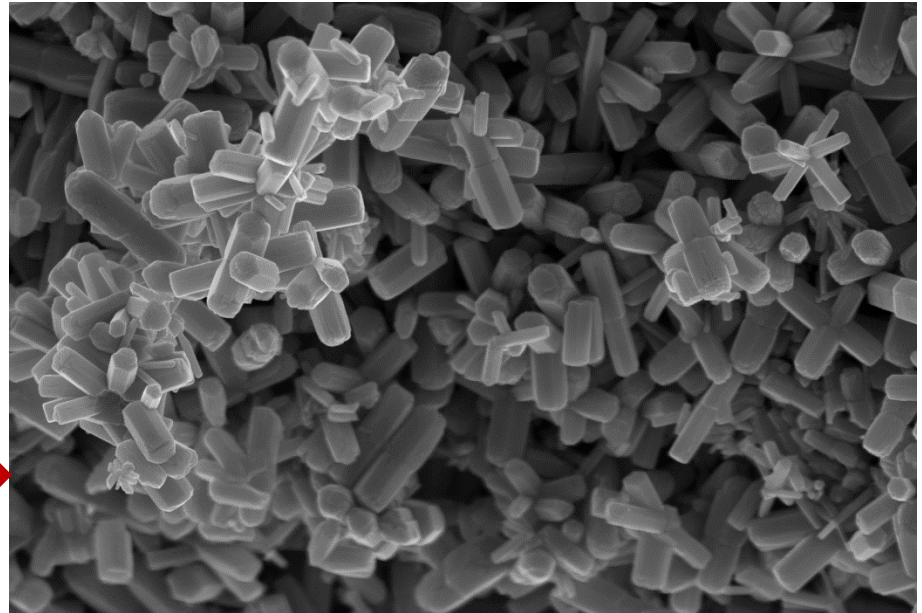


Tilting & 3D Effect

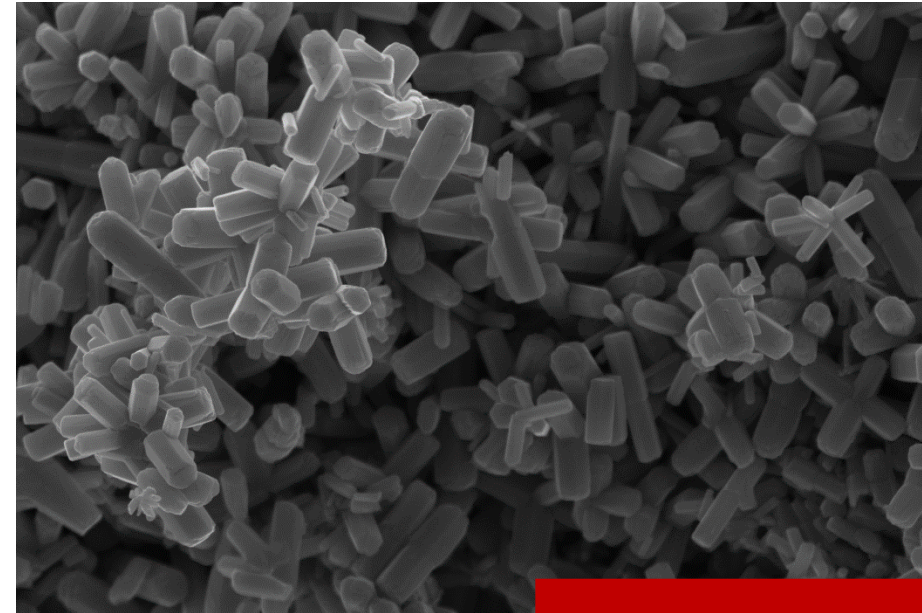
InLens detector:
sample tilted with 10°



SE2 detector:
sample tilted with 30°

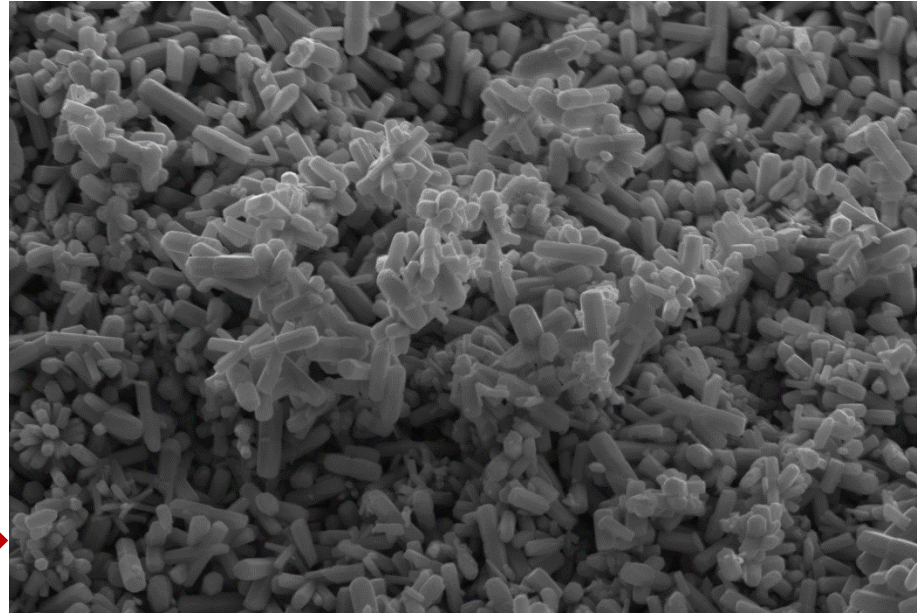


1 µm EHT = 8.00 kV Signal A = InLens Date :2 Dec 2019
WD = 4.2 mm Mag = 15.45 K X Time :16:37:54 ZEISS

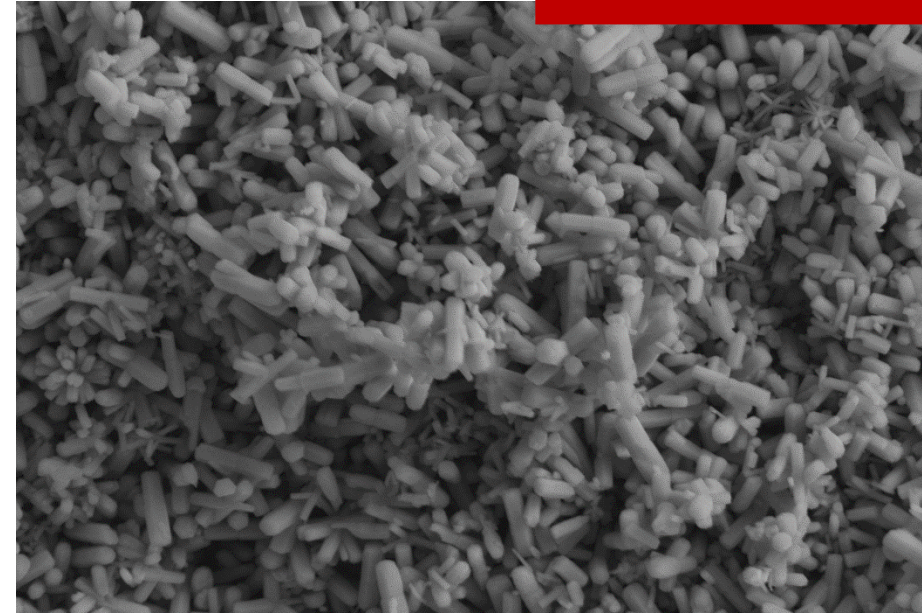


1 µm EHT = 8.00 kV Signal A = InLens Date :2 Dec 2019
WD = 4.2 mm Mag = 15.45 K X Time :16:37:54 ZEISS

Without tilting



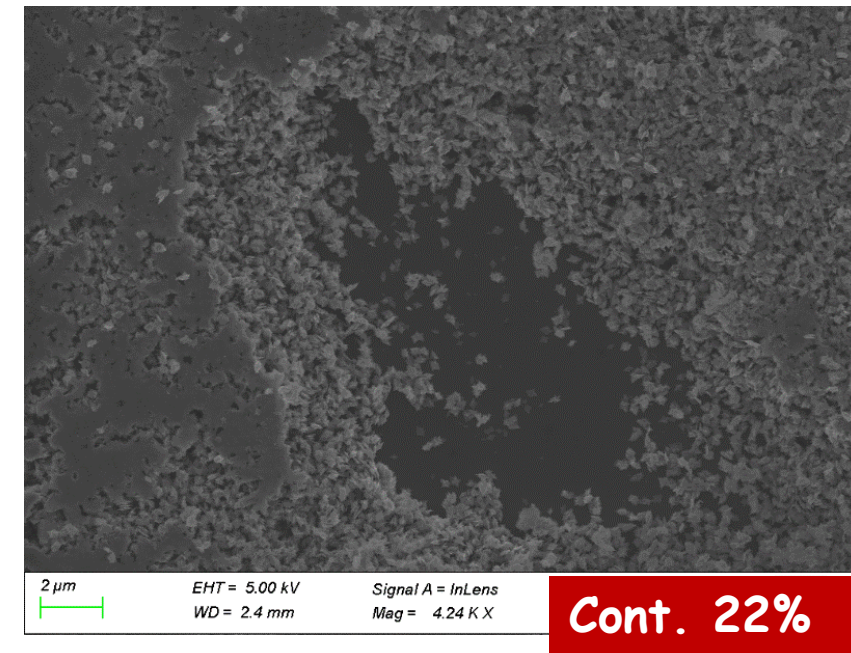
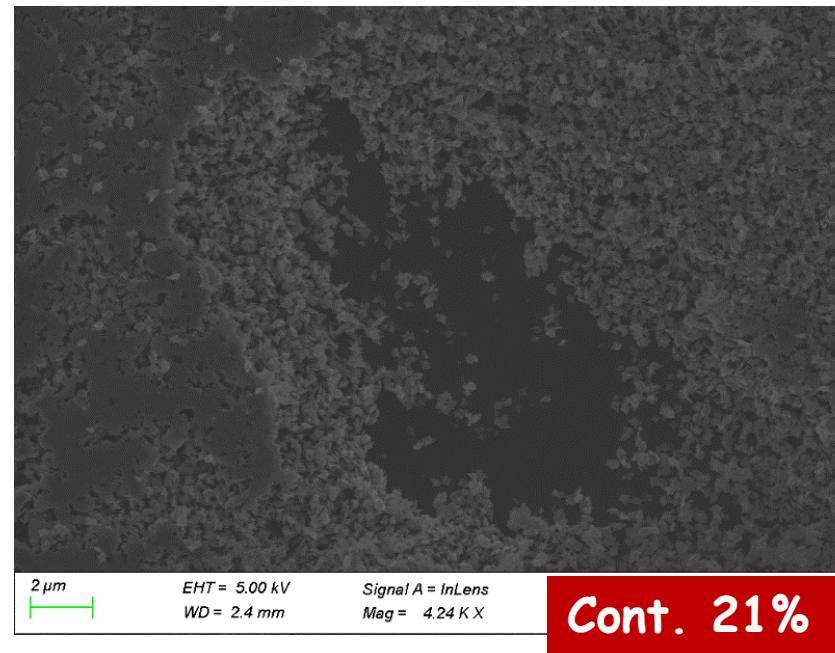
2 µm EHT = 8.00 kV Signal A = SE2 Date :2 Dec 2019
WD = 12.8 mm Mag = 8.44 K X Time :16:53:55 ZEISS



1 µm EHT = 8.00 kV Signal A = SE2 Date :2 Dec 2019
WD = 7.4 mm Mag = 8.44 K X Time :17:12:12 ZEISS

Contrast

- Measure of the difference between the highest and lowest density regions of the image



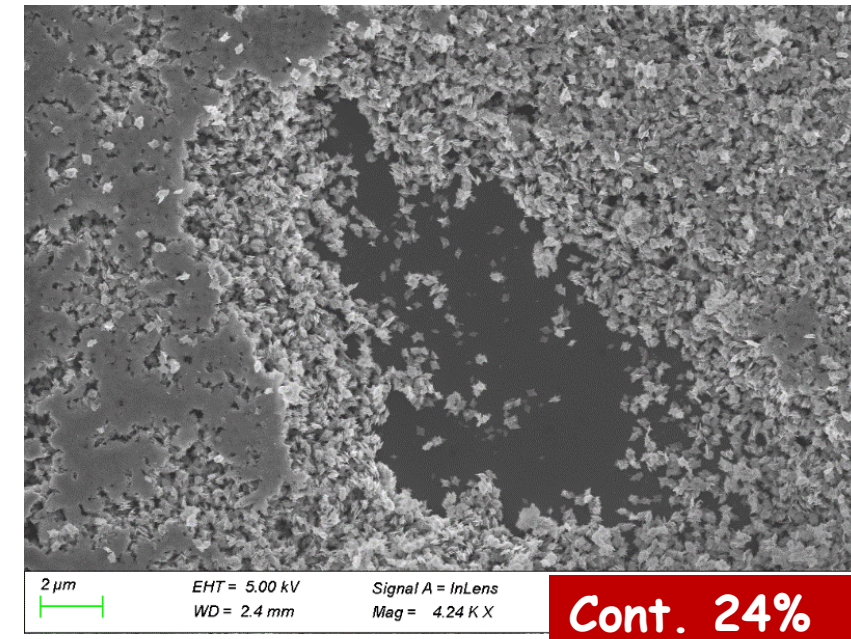
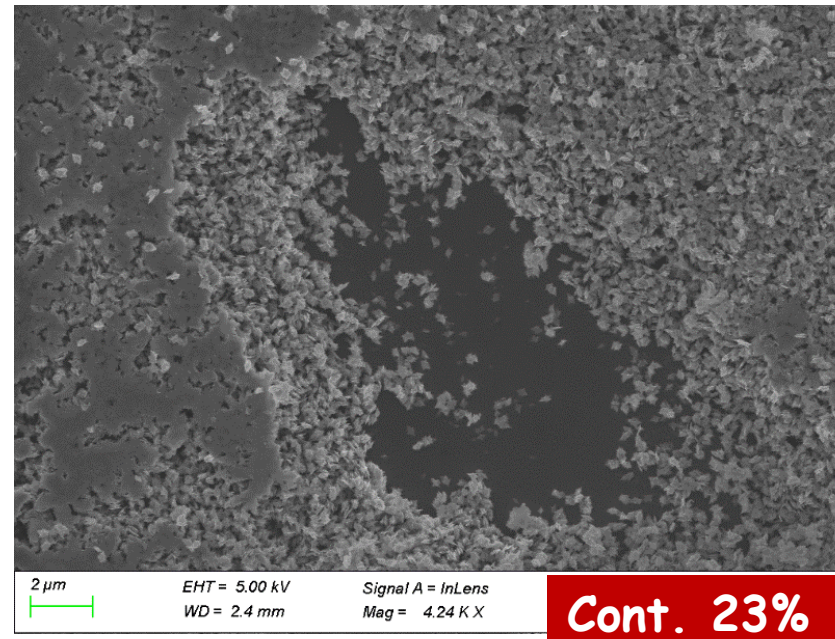
- **Contrast** = $(S_2 - S_1)/S_2$

Where...

S_2 : signal from the **feature of interest**

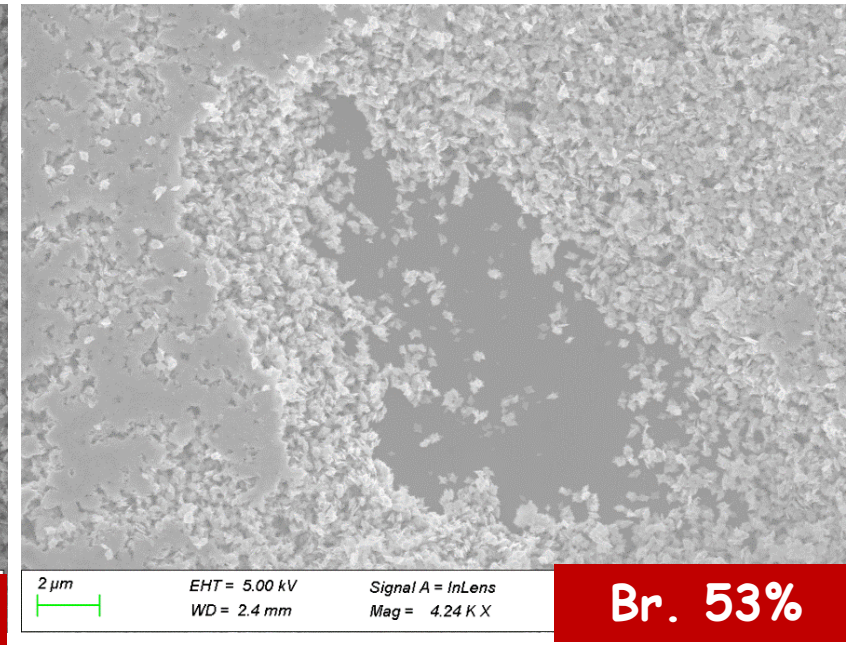
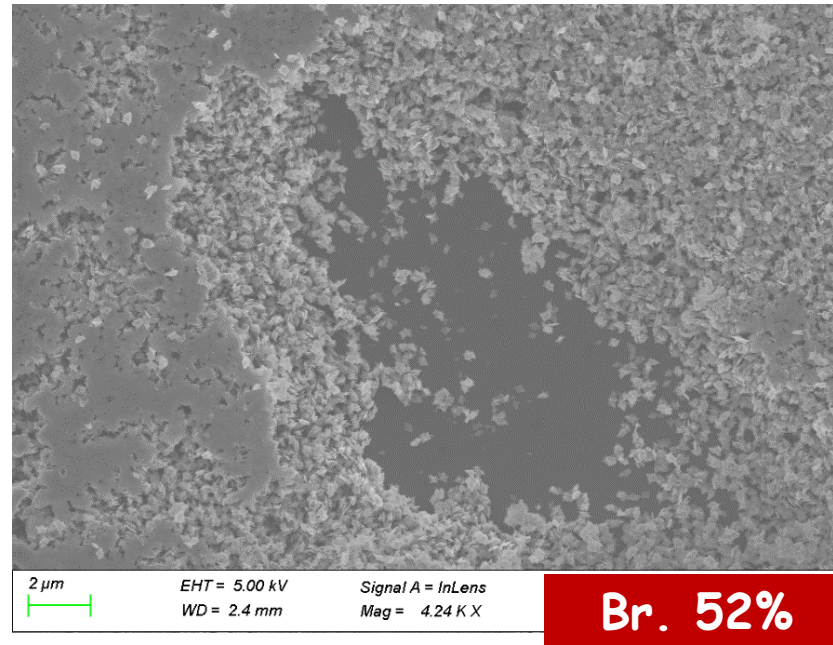
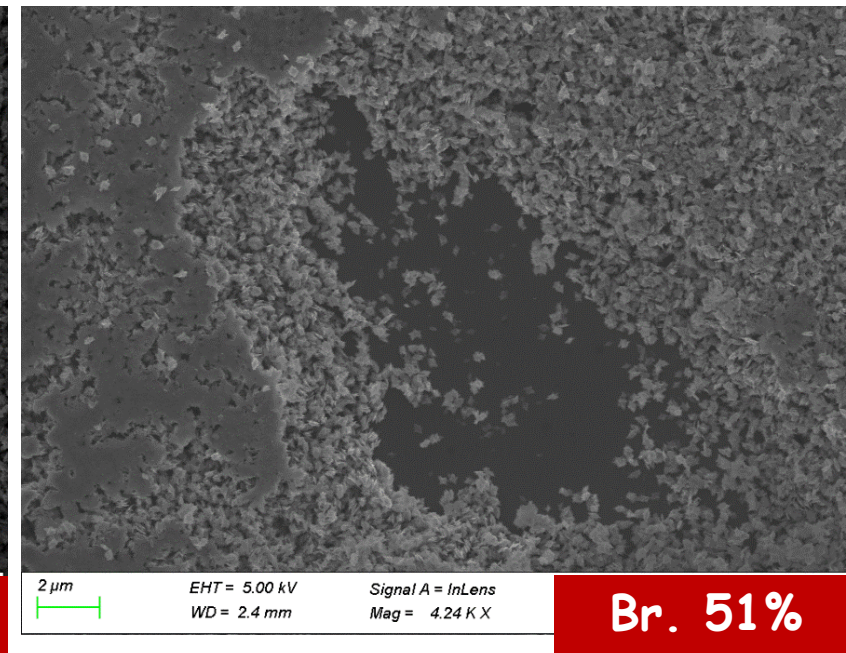
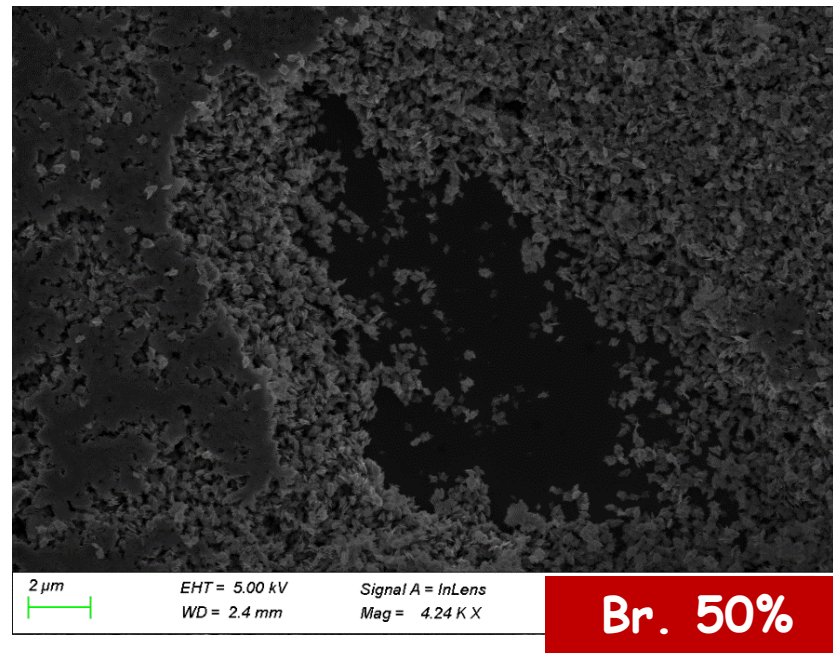
S_1 : is the **background signal**

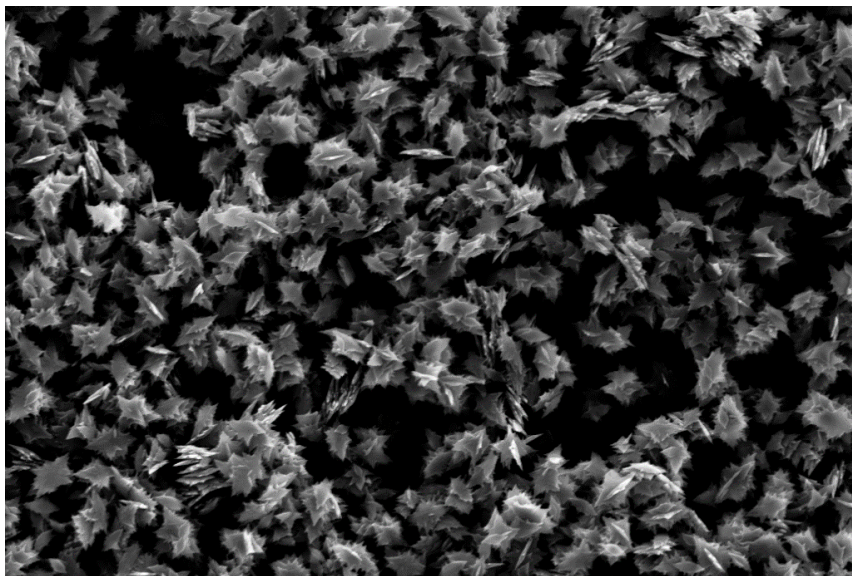
$S_2 > S_1$



Brightness

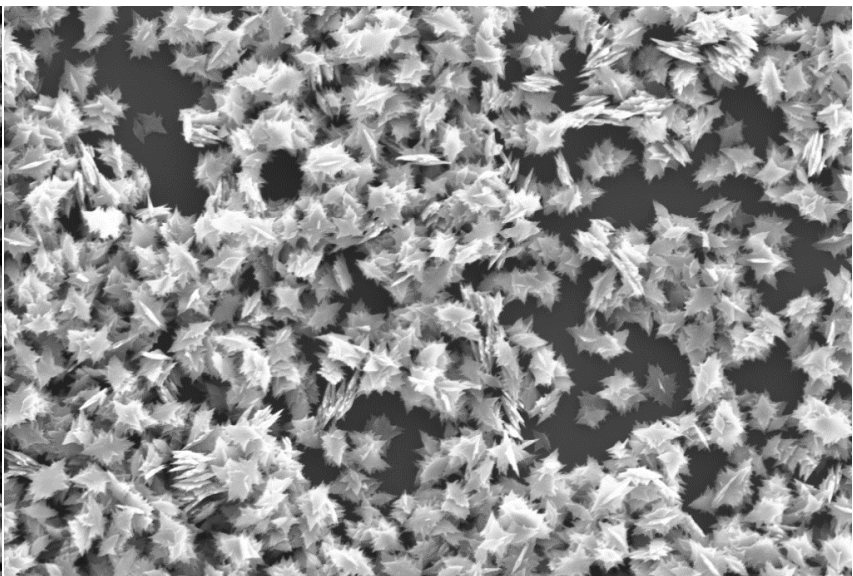
- Measure of the overall density of an image. Brighter images have less density than darker images





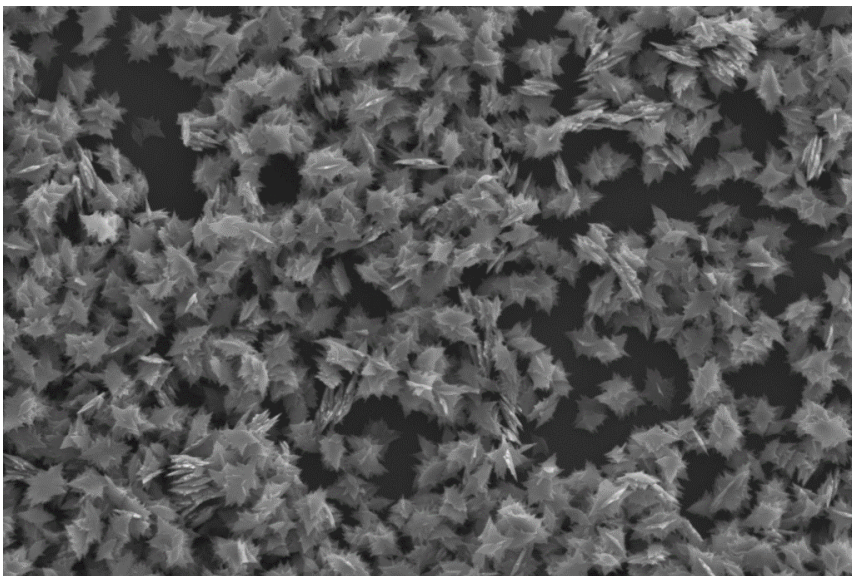
1 μ m EHT = 5.00 kV
WD = 2.5 mm

Br. 48% Cont. 25%



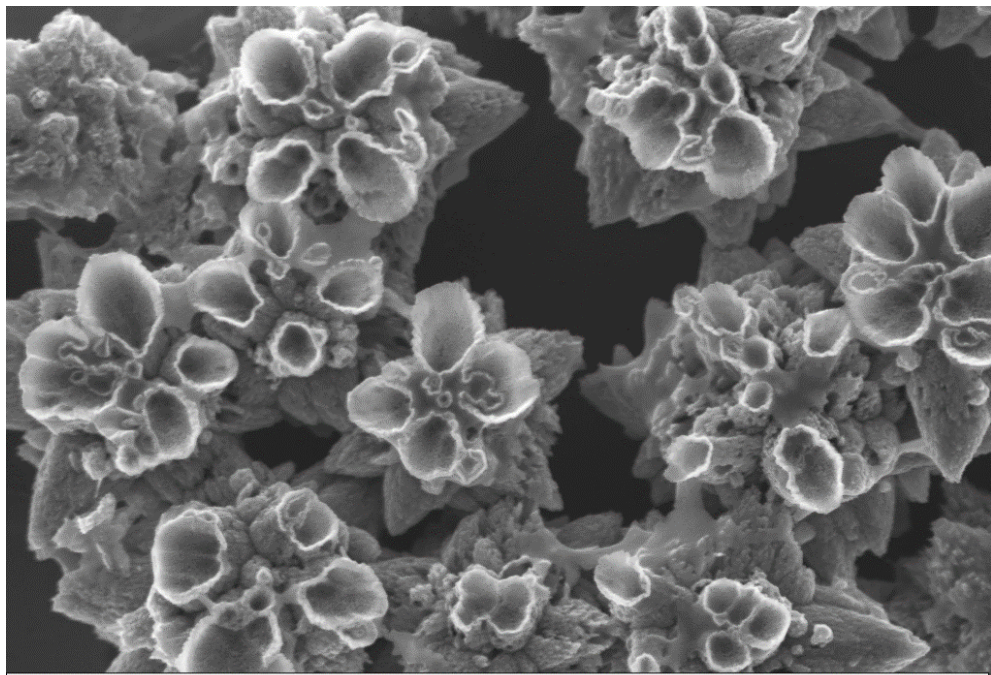
1 μ m EHT = 5.00 kV
WD = 2.5 mm

Br. 50.5% Cont. 25%



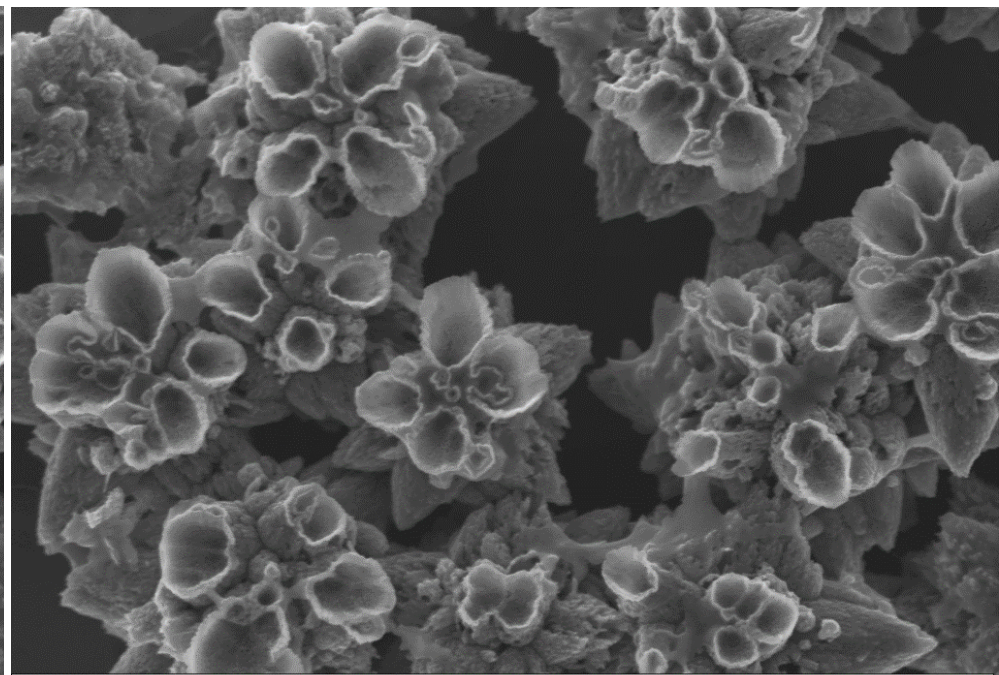
1 μ m EHT = 5.00 kV
WD = 2.5 mm

Br. 50.5% Cont. 23.5%



1 μ m EHT = 5.00 kV
WD = 2.5 mm

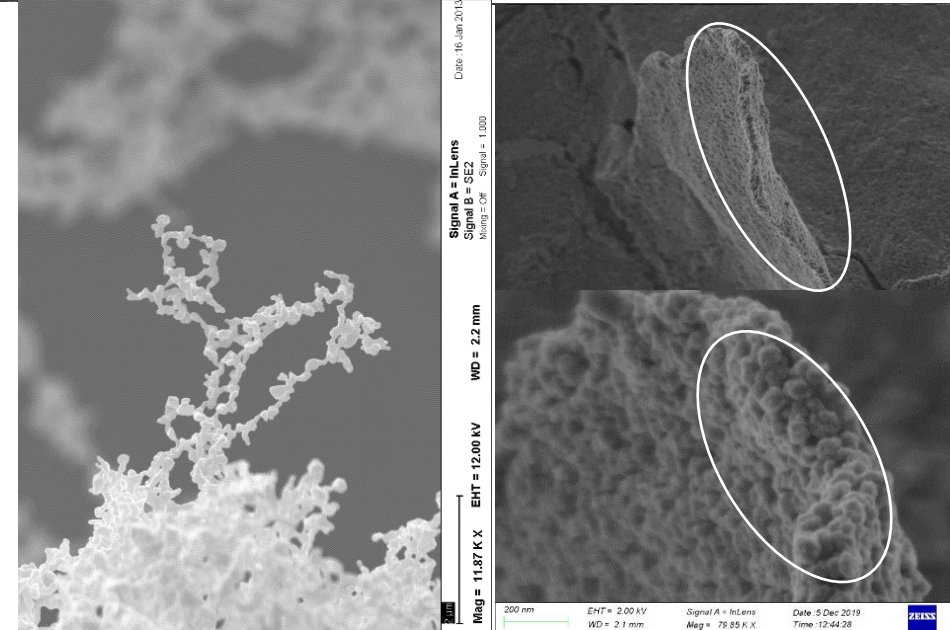
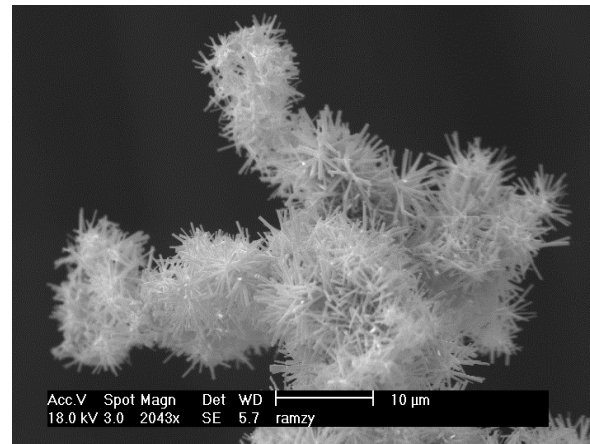
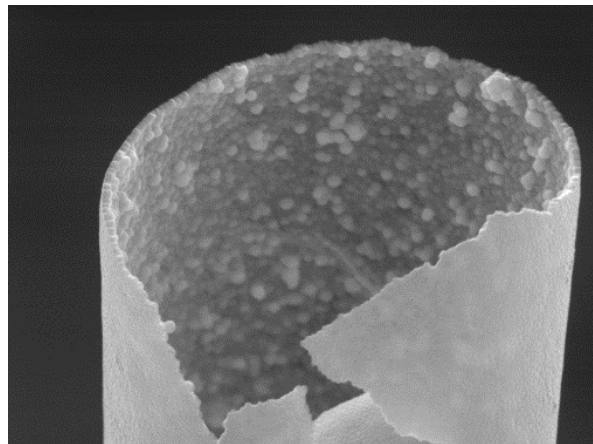
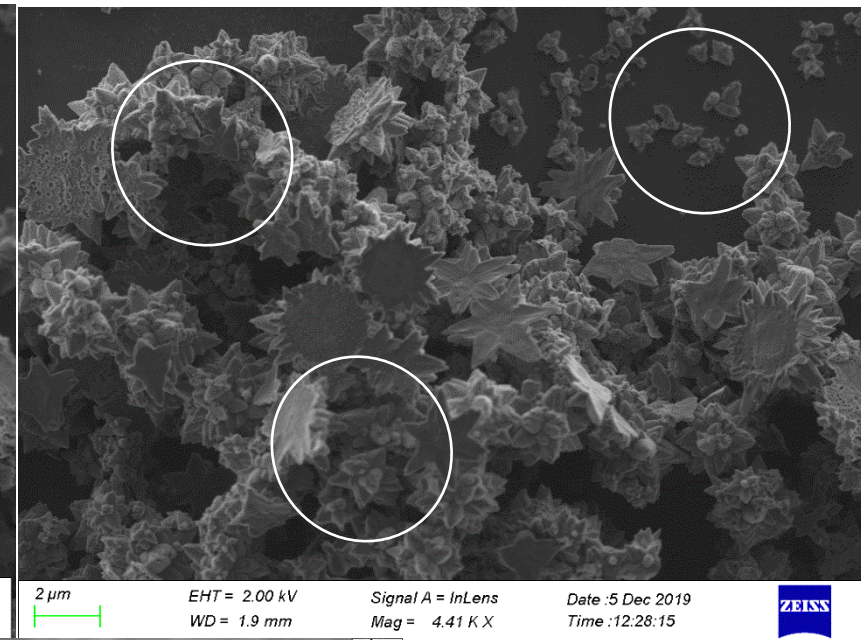
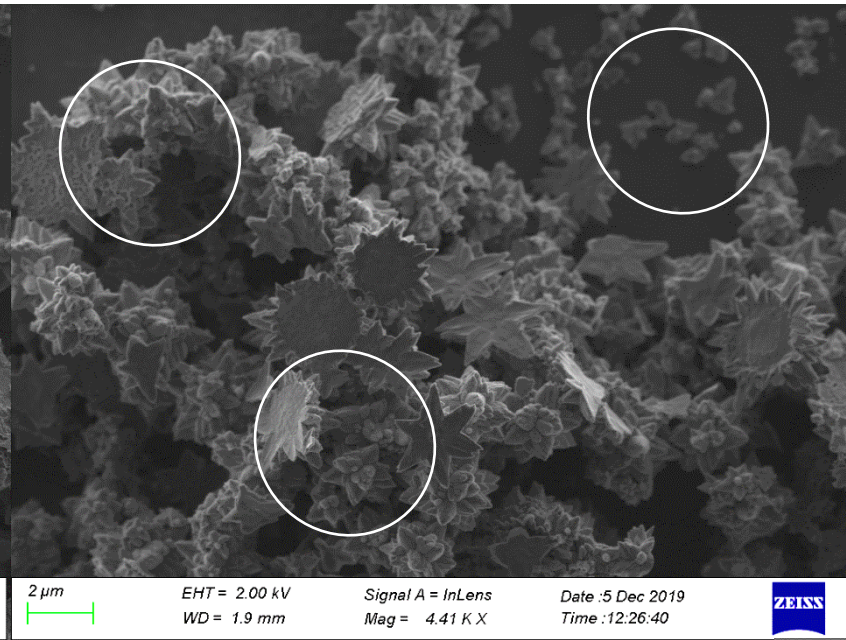
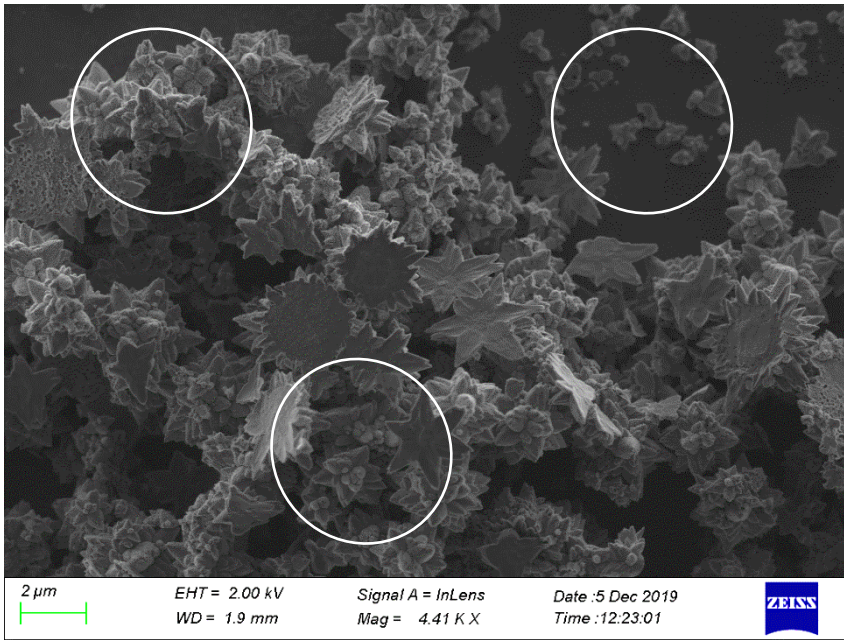
Br. 50.7% Cont. 23%



1 μ m EHT = 5.00 kV
WD = 2.5 mm

Br. 50.7% Cont. 22.3%

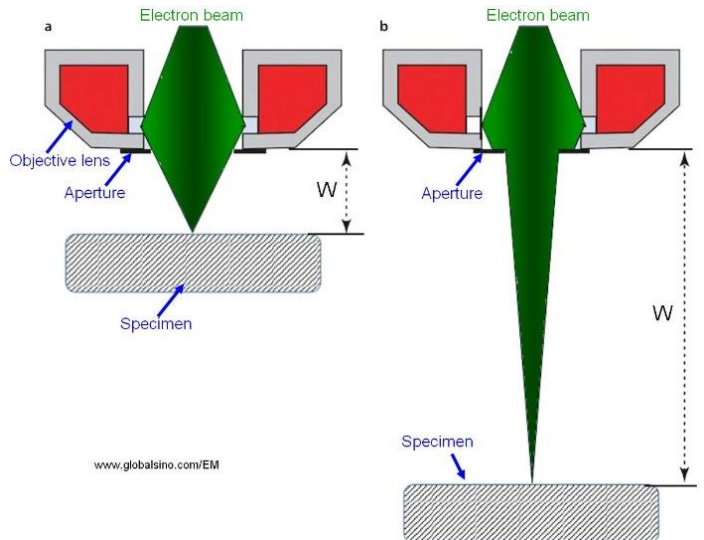
Focus



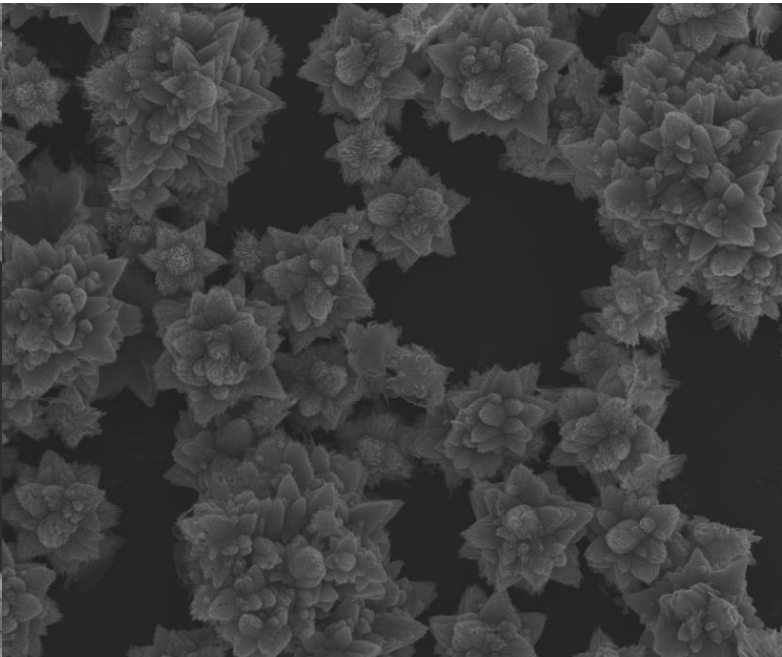
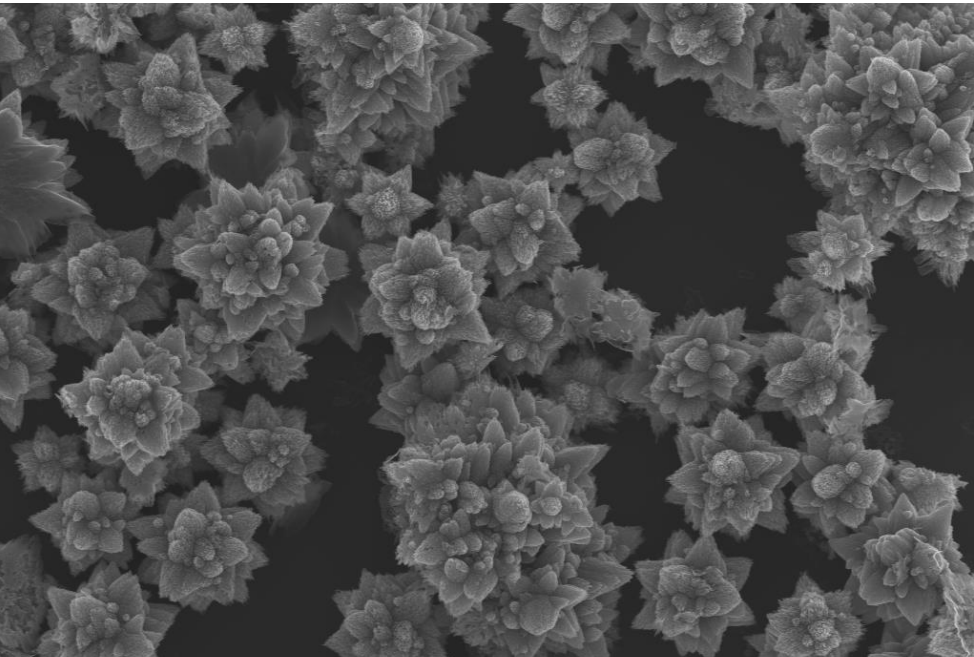
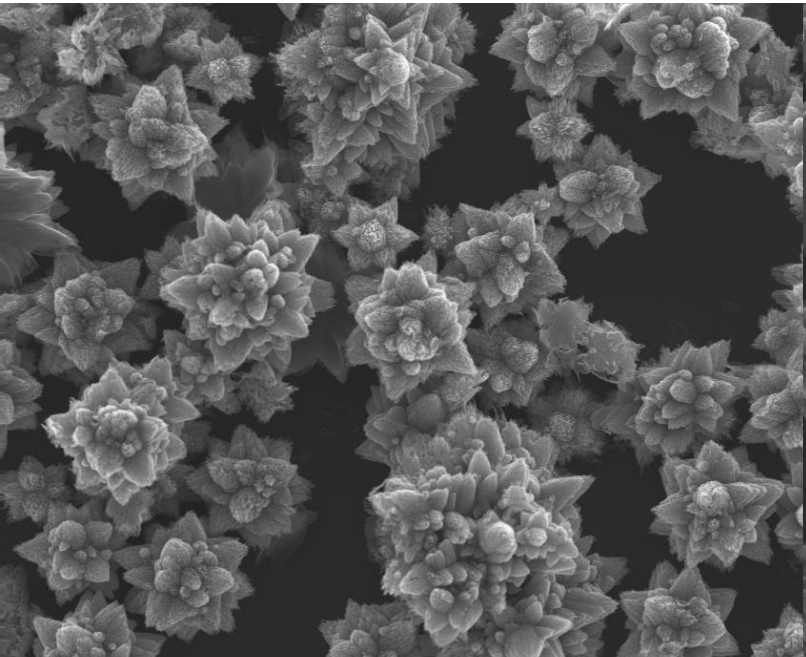
Working Distance (WD) effect

WD: a distance between the specimen and the lower pole piece in SEM system

- Short WD
- Small depth of field
- High resolution
- More edge effect
- More charge-up

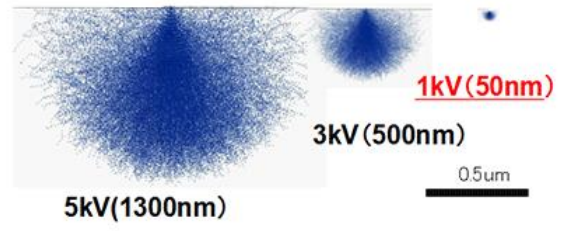


- Long WD
- Large depth of field
- Low resolution
- Less edge effect
- Less charge-up



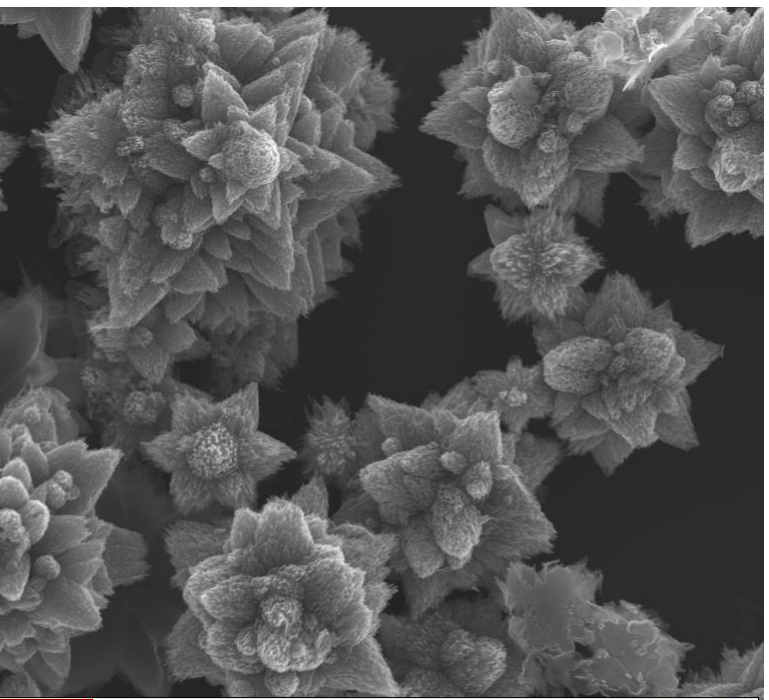
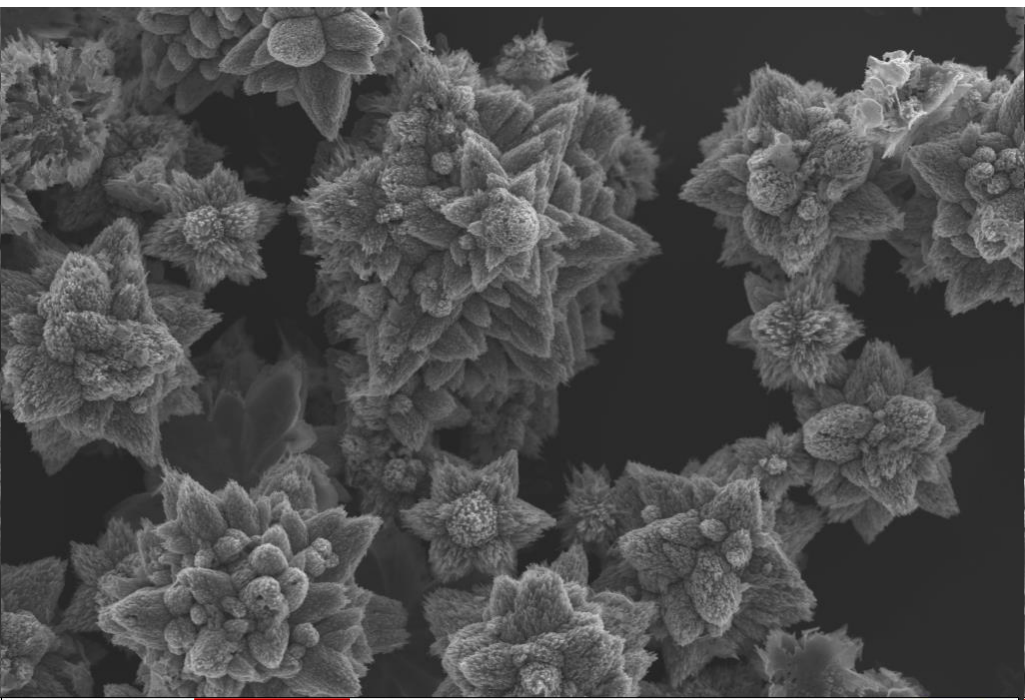
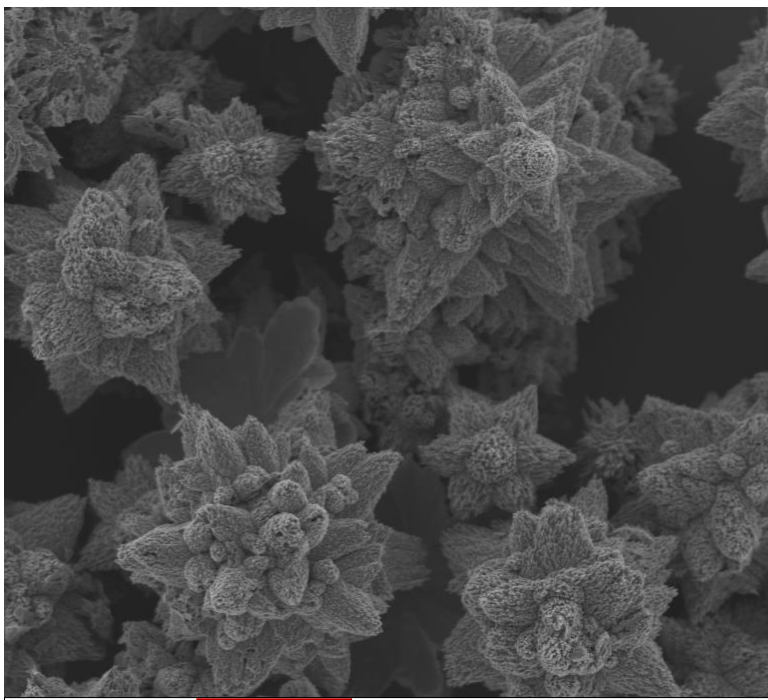
Accelerating Voltage effect

- Low AV
- Clear surface structures
- Low resolution
- Less edge effect
- Less charge-up
- Less damage



$$R = \frac{0.0276 A E^{1.67}}{(Z^{0.89} \rho)} \mu m$$

- High AV
- Unclear surface structures
- High resolution
- More edge effect
- More charge-up
- More damage

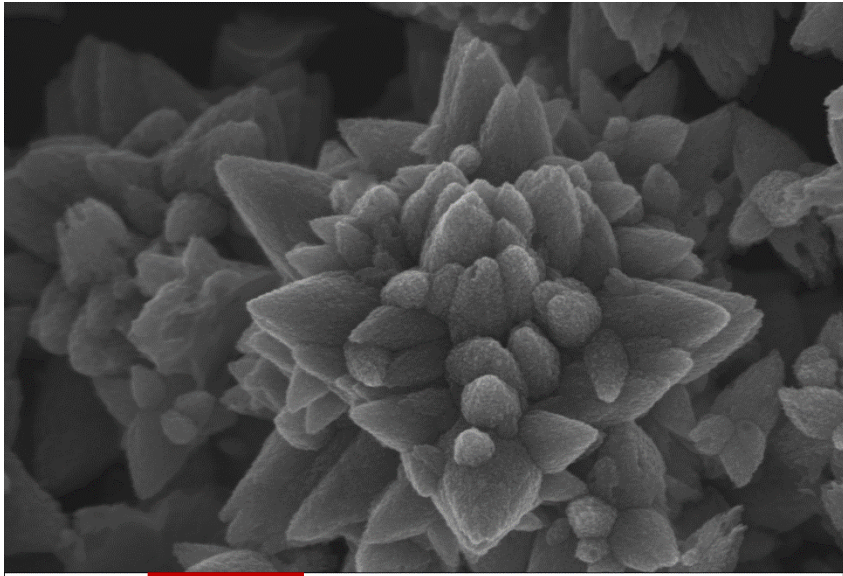


1 μm | **EHT = 1.00 kV** | Signal A = InLens | Date :2 Dec | Time :13:16
WD = 3.0 mm | Mag = 9.62 K X

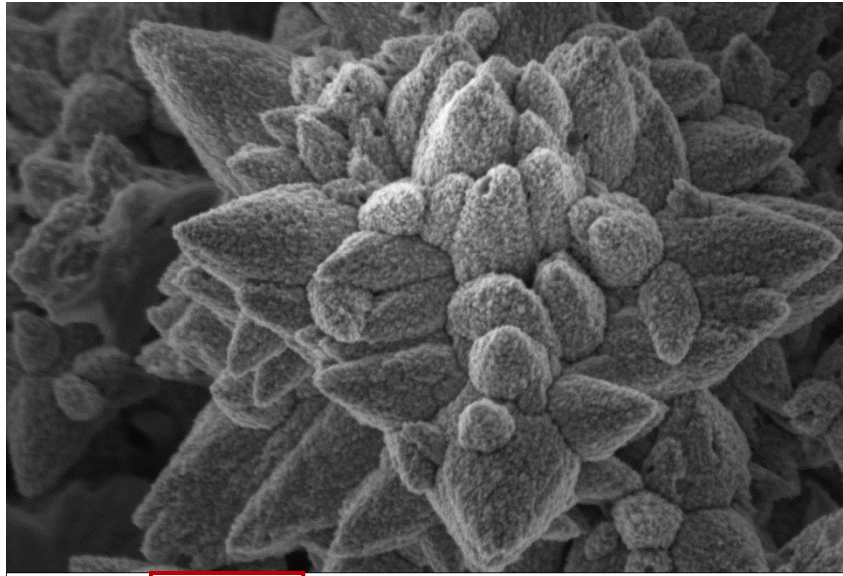
1 μm | **EHT = 5.00 kV** | Signal A = InLens | Date :2 Dec 2019 | Time :13:10:27
WD = 3.0 mm | Mag = 9.62 K X

10.00 kV | Signal A = InLens | Date :2 Dec 2019 | Time :13:05:08
3.0 mm | Mag = 9.62 K X





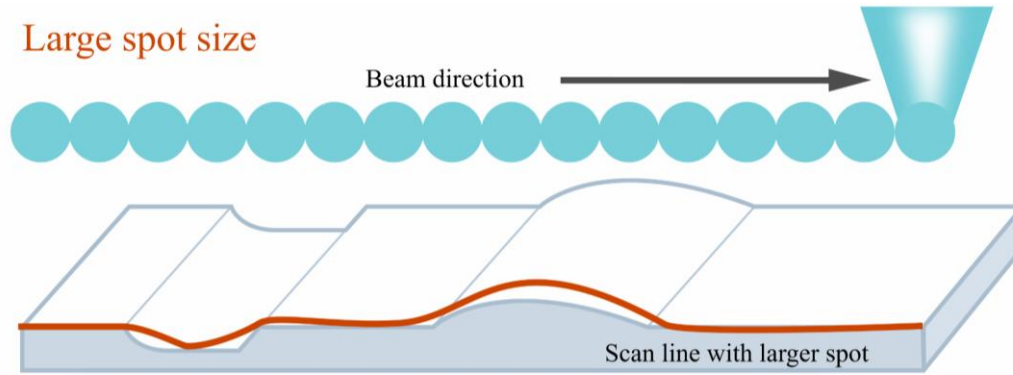
200 nm
EHT = 8.00 kV
WD = 4.7 mm
Signal A = InLens
Mag = 22.61 K X
Date :5 Dec 2019
Time :11:40:09
ZEISS



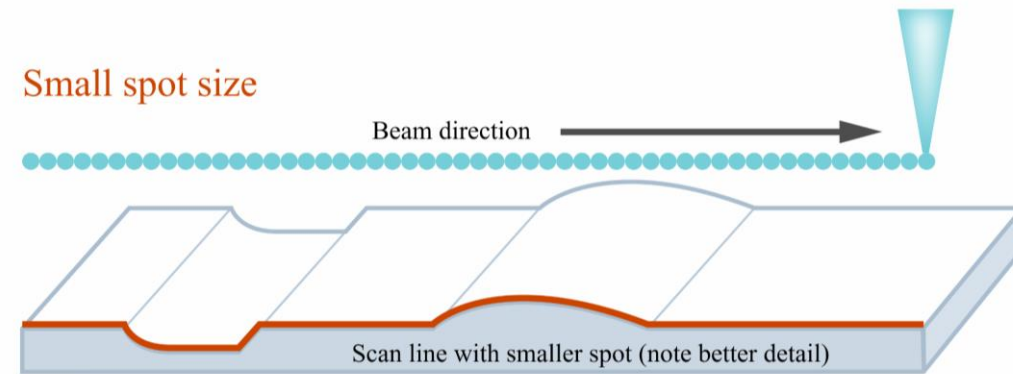
200 nm
EHT = 2.00 kV
WD = 3.3 mm
Signal A = InLens
Mag = 31.14 K X
Date :5 Dec 2019
Time :11:54:36
ZEISS

Spot Size Effect

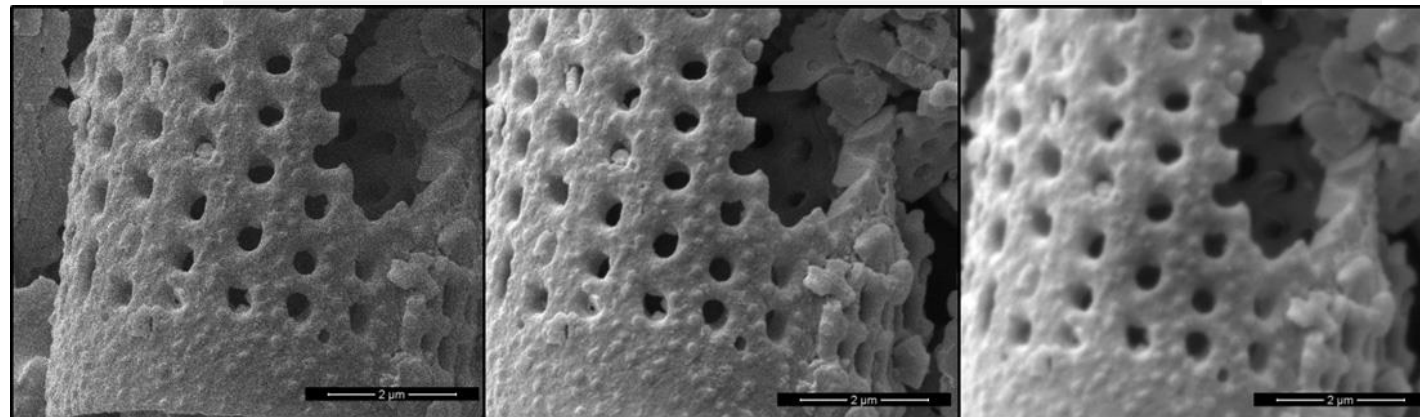
The diameter of the final beam spot onto the sample



- Large current
- Low resolution
- Small depth of field



- Less current
- High resolution
- Greater depth of field
- Clear surface structure

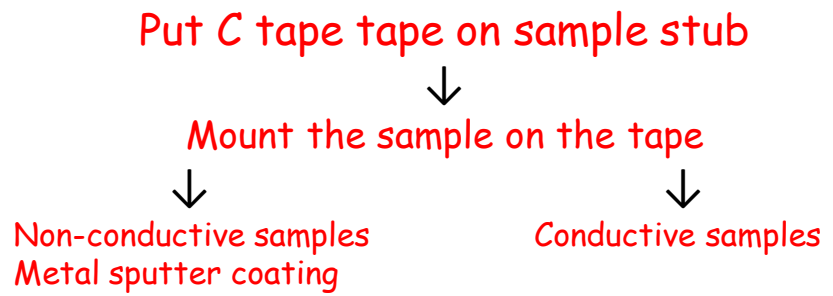


Small spot size

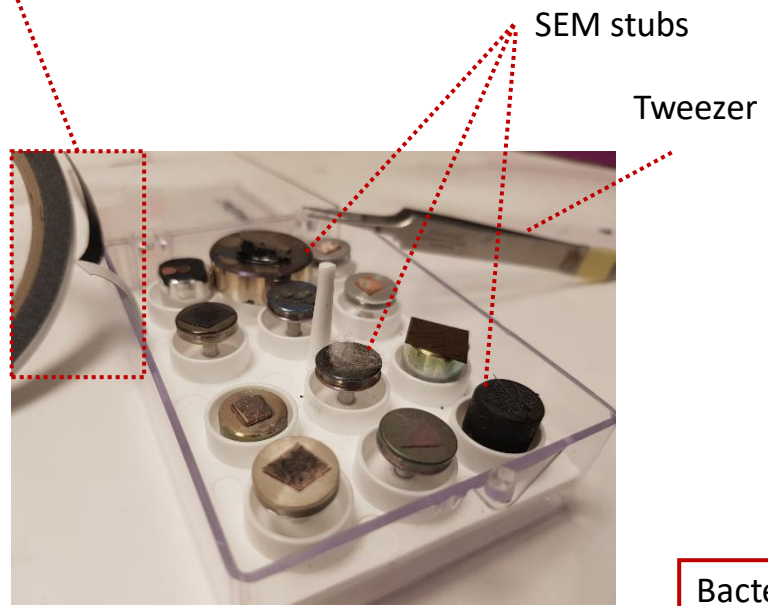
Large spot size

Sample preparation

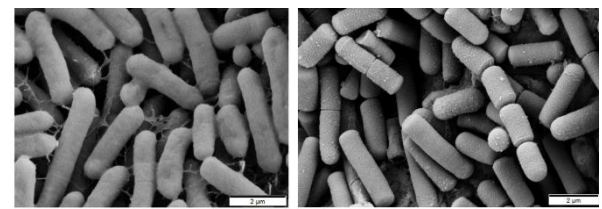
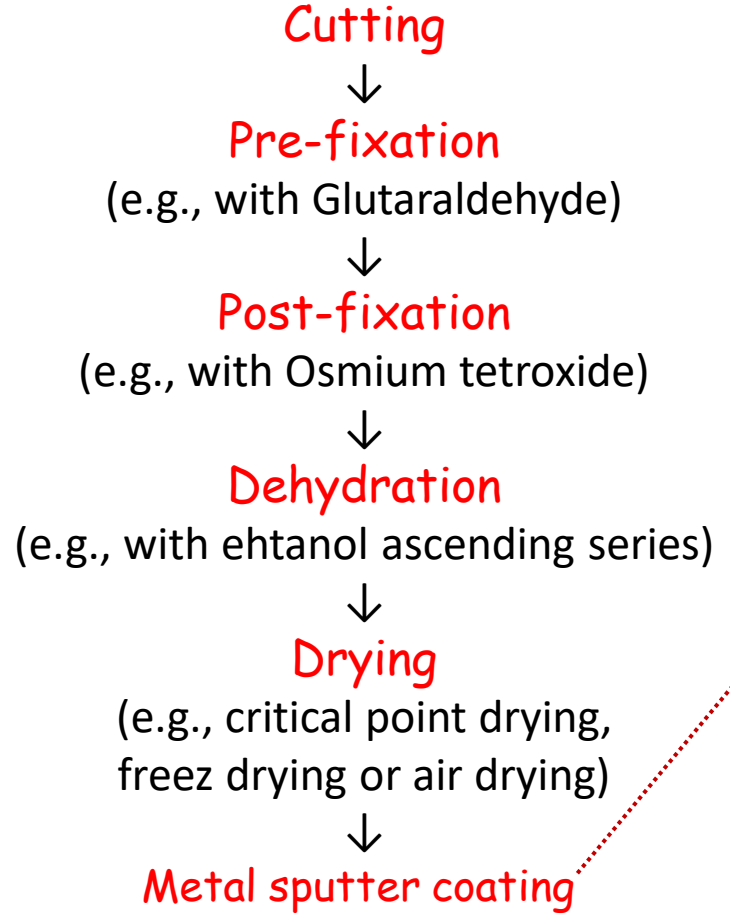
➤ Solid or powder samples (perfect dry)



Double-sided carbon or Cu adhesive tape



➤ Biological or food samples (wet)



Bacterial cells, Flattened, shrunken
 Unclear surface structures

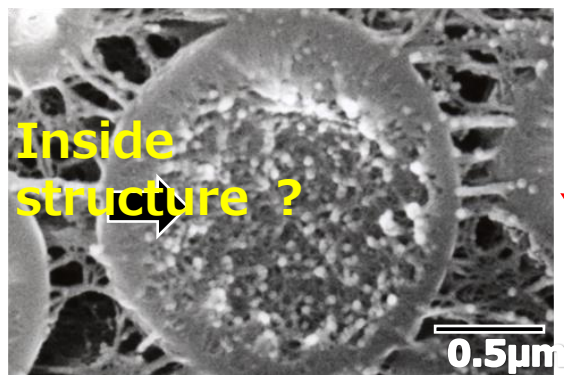
Well rounded and fulsome while
 the dividing cells are well exposed



Murtey, M. D., & Ramasamy, P. (2016). Sample preparations for scanning electron microscopy—life sciences. In *Modern electron microscopy in physical and life sciences*. IntechOpen.

➤ Making a cross section sample

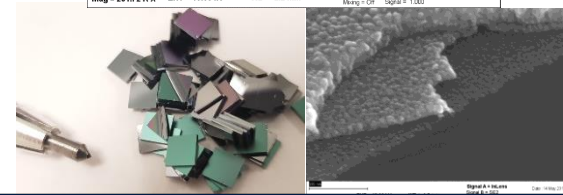
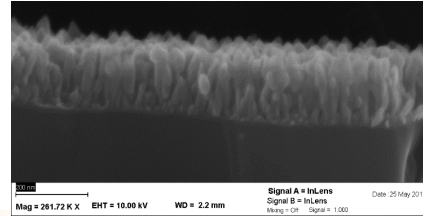
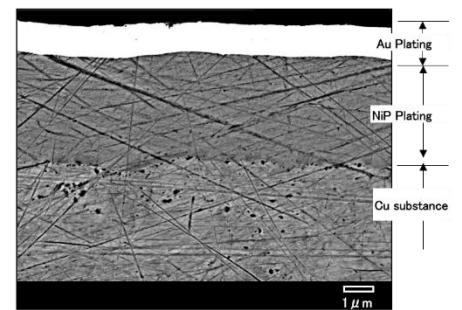
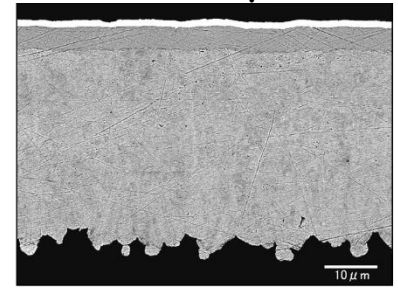
Cryo-SEM (freeze fracturing) method



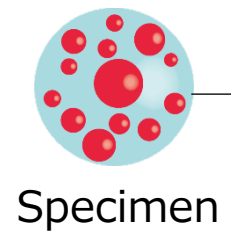
Specimen : Polyvinyl acetate



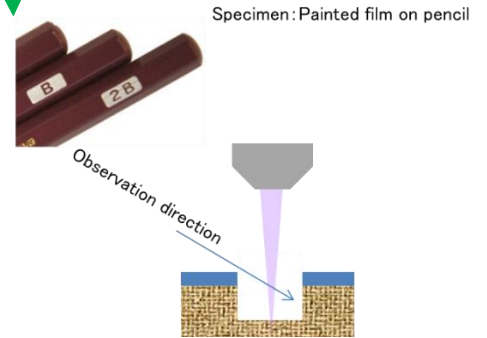
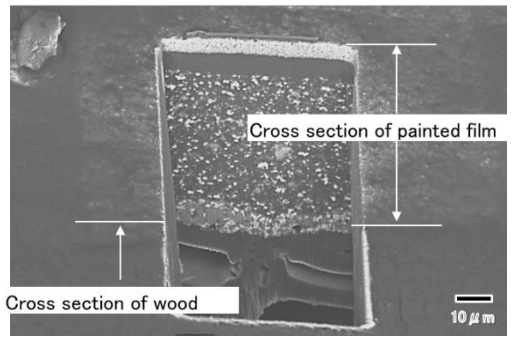
Mechanical polishing



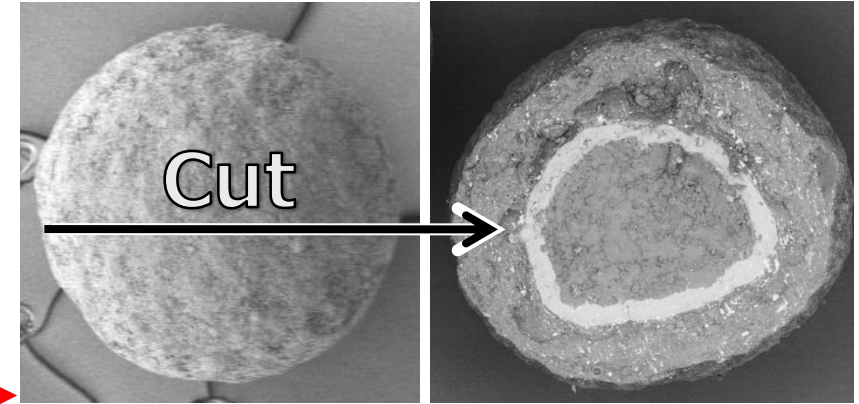
Cross section method	Applicable
 Cleavage ----- Freeze fracturing method	Polymer
	Polymer Bio
 Mechanical polishing ----- Microtome ----- FIB	Metal Semiconductor Sintered body
	Polymer Bio
	Semiconductor Metal



By FIB

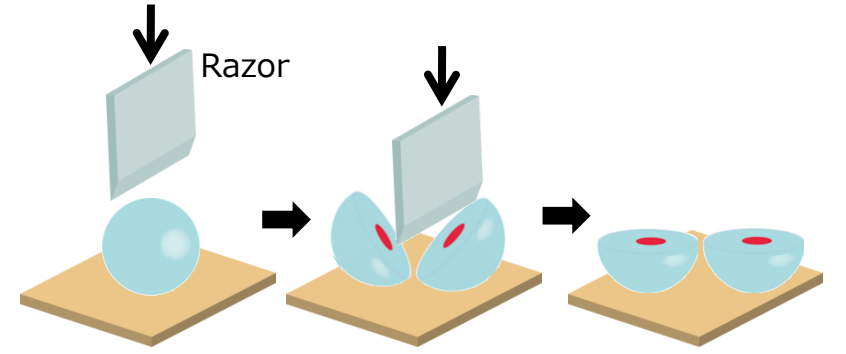


Cleaved by double edge razor

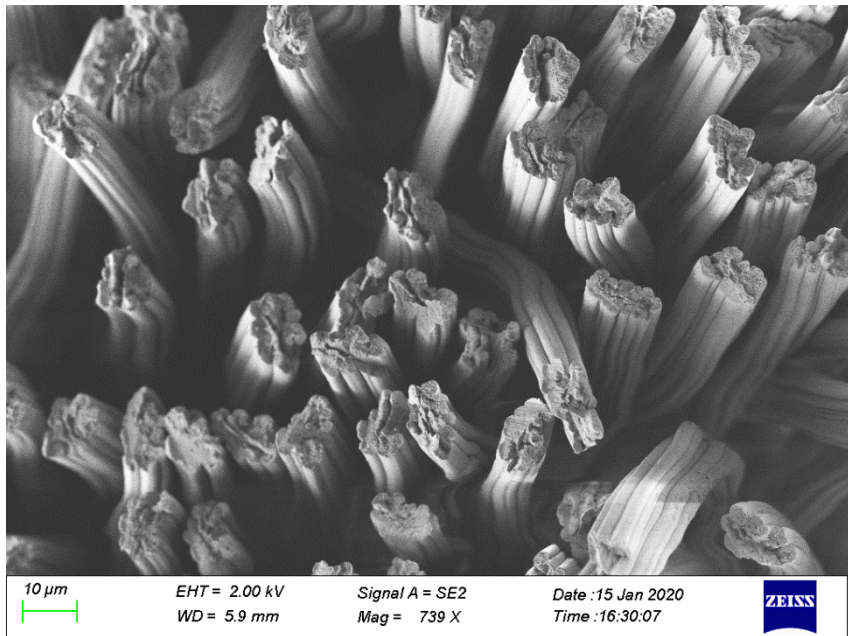


Specimen : Granule (Flue Medicine)

Double or single edge razor

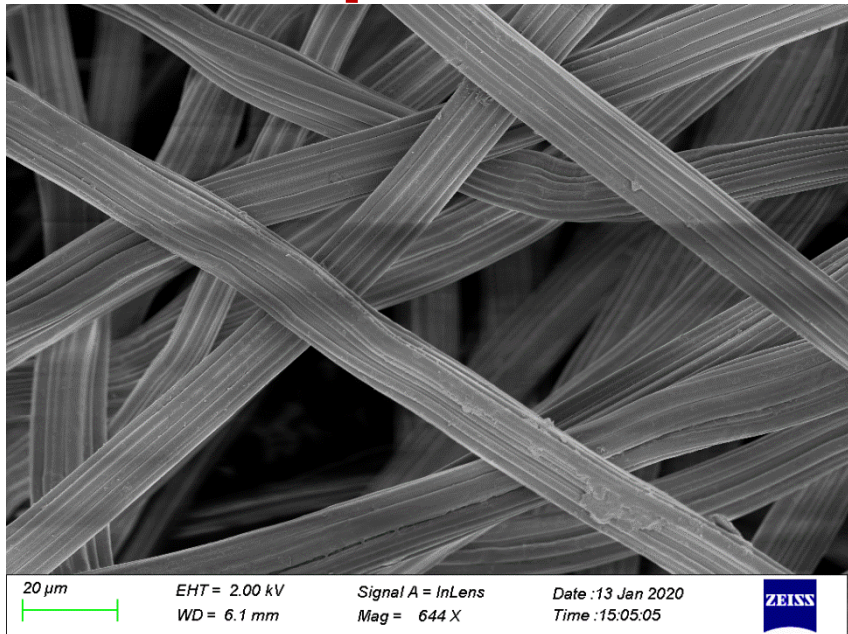


Double-sided tape

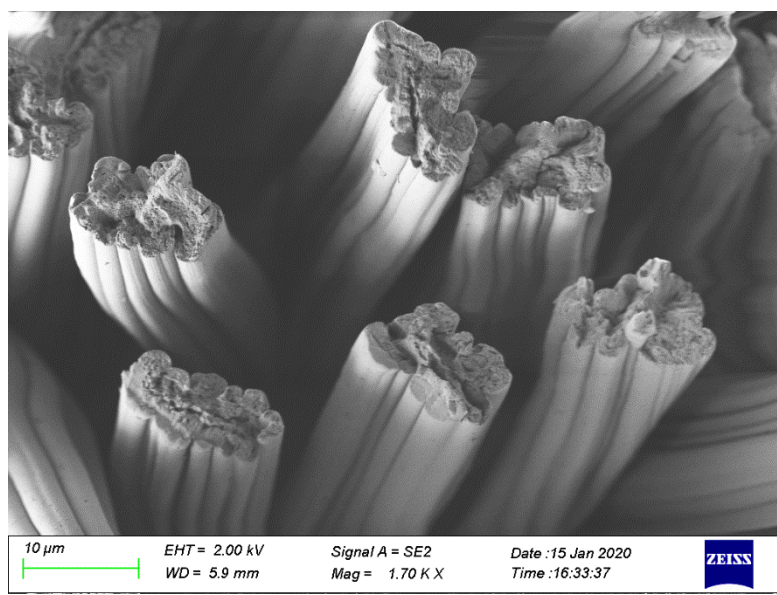


10 μm EHT = 2.00 kV Signal A = SE2 Date :15 Jan 2020
 WD = 5.9 mm Mag = 739 X ZEISS

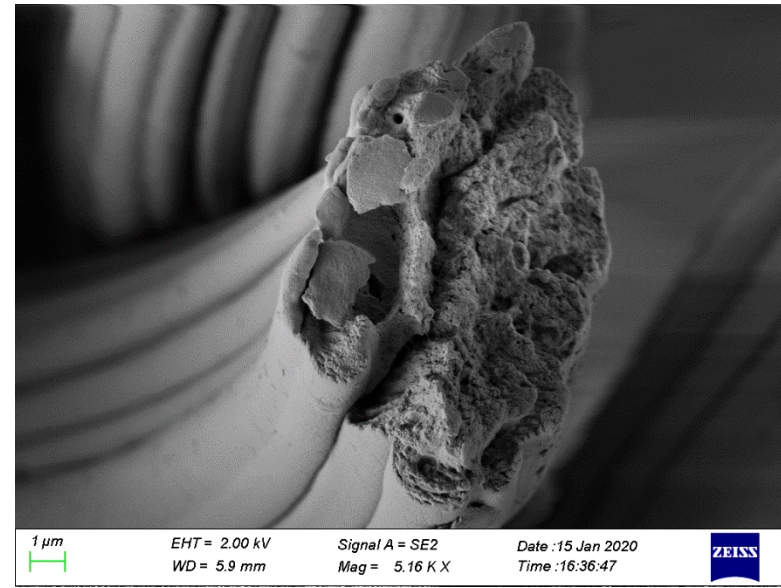
1. Liquid nitrogen
2. Single edge razor
3. Sputter coating



20 μm EHT = 2.00 kV Signal A = InLens Date :13 Jan 2020
 WD = 6.1 mm Mag = 644 X ZEISS

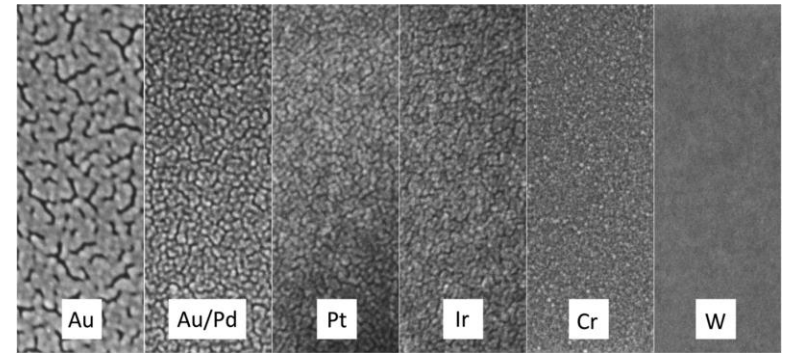


10 μm EHT = 2.00 kV Signal A = SE2 Date :15 Jan 2020
 WD = 5.9 mm Mag = 1.70 K X Time :16:33:37 ZEISS



1 μm EHT = 2.00 kV Signal A = SE2 Date :15 Jan 2020
 WD = 5.9 mm Mag = 5.16 K X Time :16:36:47 ZEISS

Sputter Coating



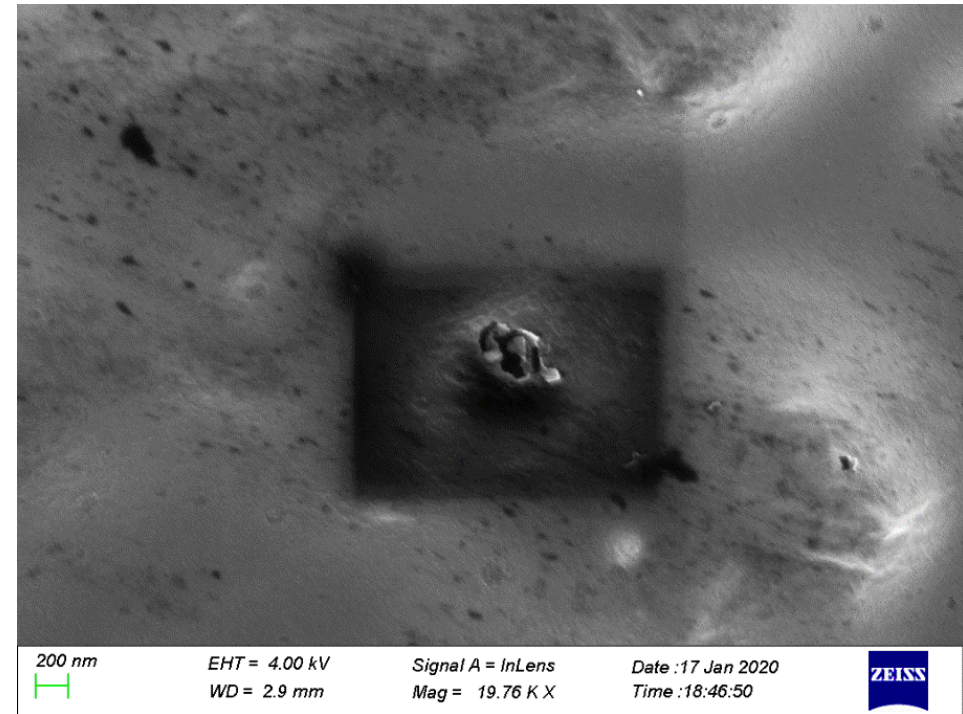
Sputter Material	Grain Size ^a	Typical Maximum Magnification ^b	Relative SE yield ^c	Relative Sputter Rate ^d	Vacuum Requirements
Au	10–12 nm	10,000x	High	10	Modest
Au/Pd	4–8 nm	25,000x	High	9	Modest
Pt	2–3 nm	50,000x	High	6	Stringent
Ir	1–2 nm	100,000x	High	4	Stringent
Cr	1–2 nm	100,000x	Moderate	5	Stringent
W	< 1 nm	200,000x	High	2	Stringent

Cellulose fiber

<https://www.cambridge.org/core/journals/microscopy-today/article/target-material-selection-for-sputter-coating-of-sem-samples/089A8657A8345CFFCF963BED868578D4/core-reader>

Contamination in SEM

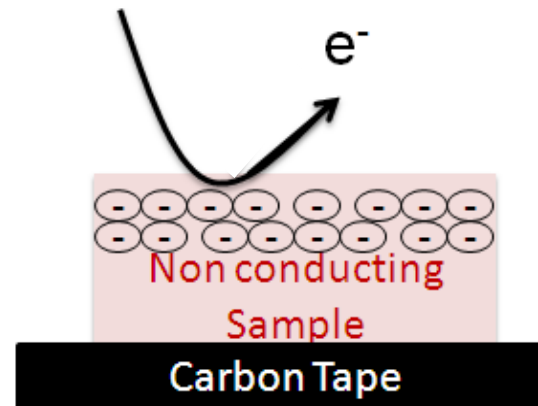
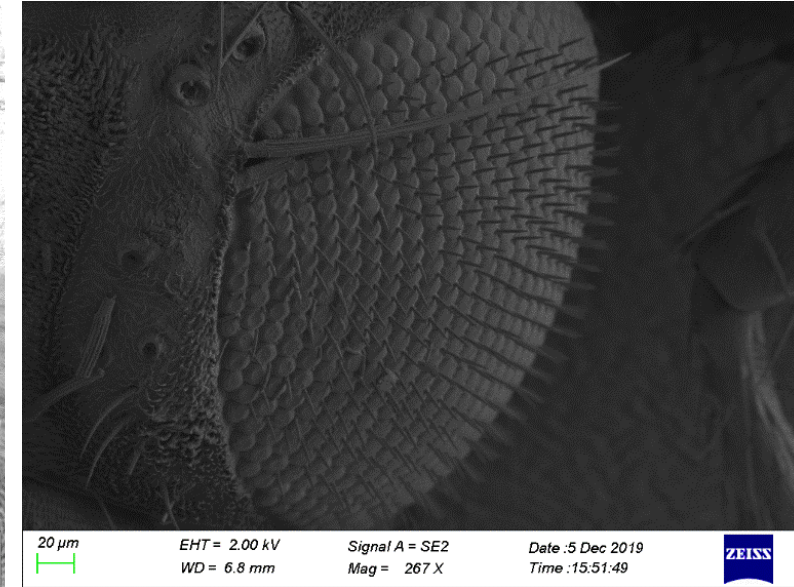
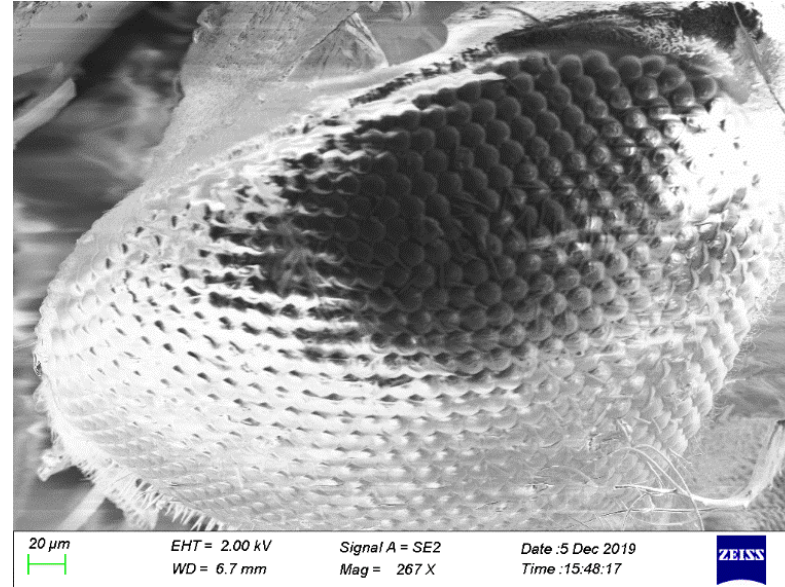
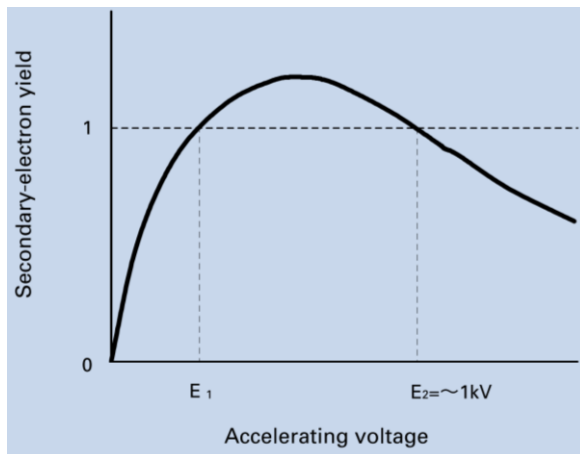
Interaction of the electron beam with residual gases and hydrocarbons on the specimen surface



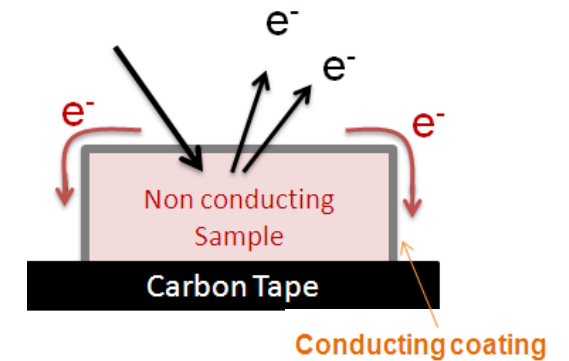
- Ensuring the cleanliness of specimens (heat, UV or plasma cleaning)
- Decreasing the probe current
- Only from low magnification imaging to higher
- Aligning the microscope on areas of the specimen not used for imaging

Charging in SEM

- Charging is a result of electrons becoming trapped within the sample → sample to "glow"
- No conducting path for electrons to flow from the sample surface to ground
- Drifting, blurring, low contrast and false Image



Very less e^- escaping from specimen

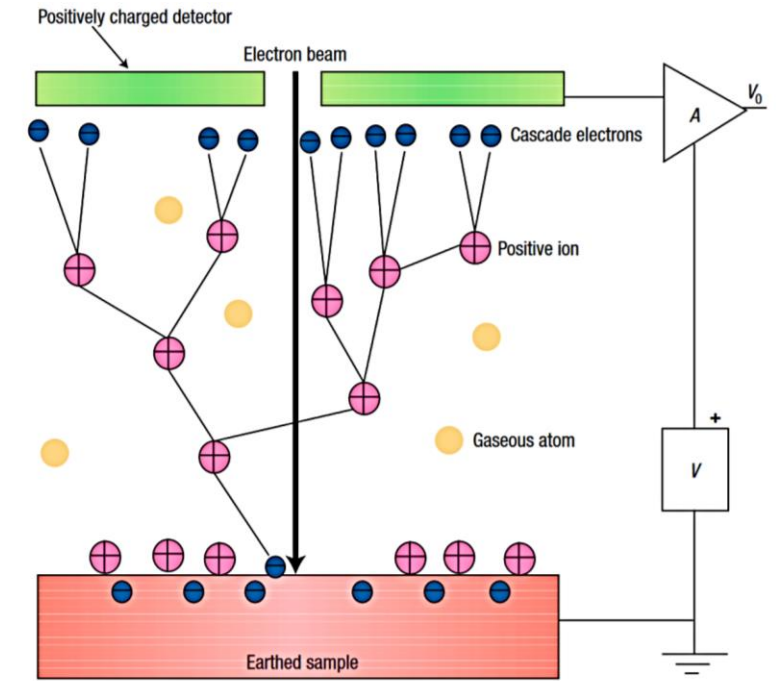
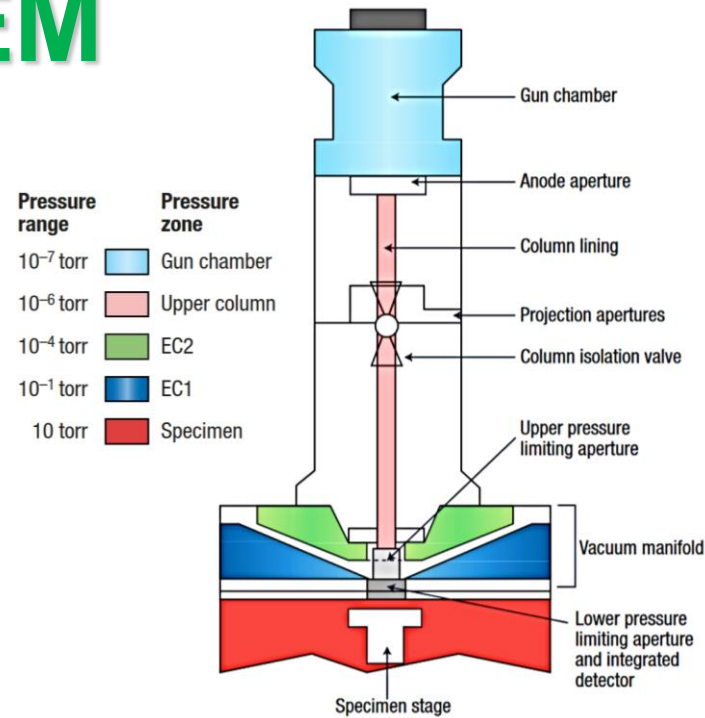


The developed charges are passed to the ground via the conducting layer

Environmental SEM

Three operating modes:

- High vacuum (HV),
- Variable pressure (VP) (10 - 133 Pa, N₂, air, H₂O)
- Environmental mode (EP) (10 - 3000 Pa, N₂, air, H₂O)



- Wet (or dry) & nonconductive (uncoated) sample can be imaged
- Gaseous environment (oxygen, nitrogen, argon, and water vapor)
- Series of different pressure zones
- The gas molecules are ionized by the electrons emitted from the sample
- **Daughter electrons** produced in the ionizing collisions
- All the electrons produced are drawn towards the **positively biased detector**
- The **positive ions** drift back and hence serve to **compensate charge** build-up at the surface of insulators

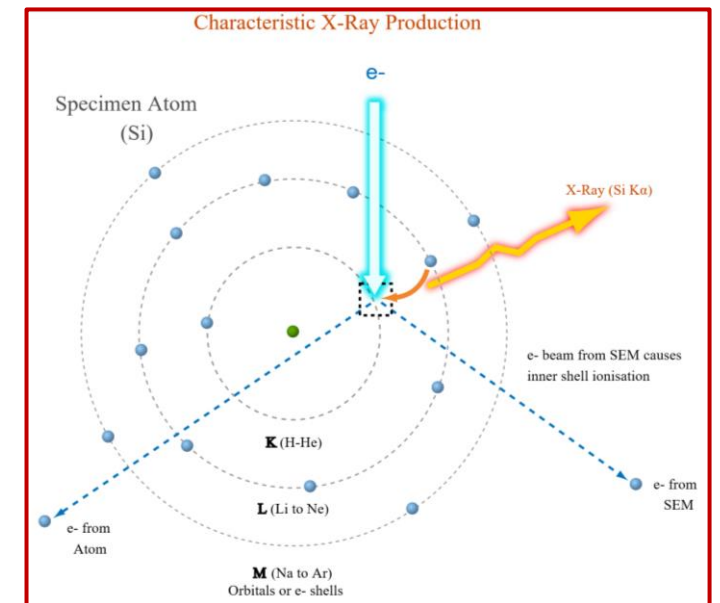
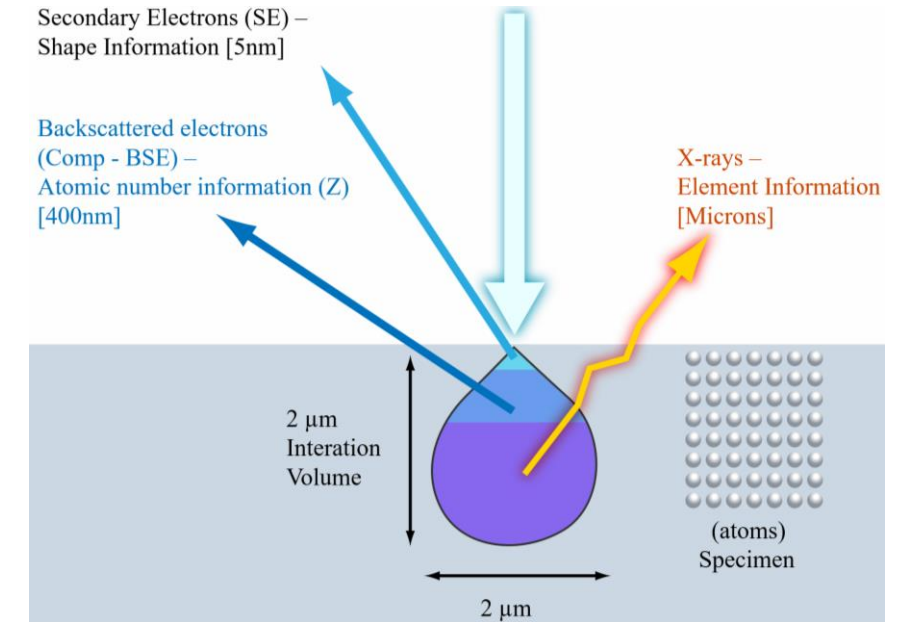
Donald, Athene M. "The use of environmental scanning electron microscopy for imaging wet and insulating materials." *Nature materials* 2.8 (2003): 511-516.

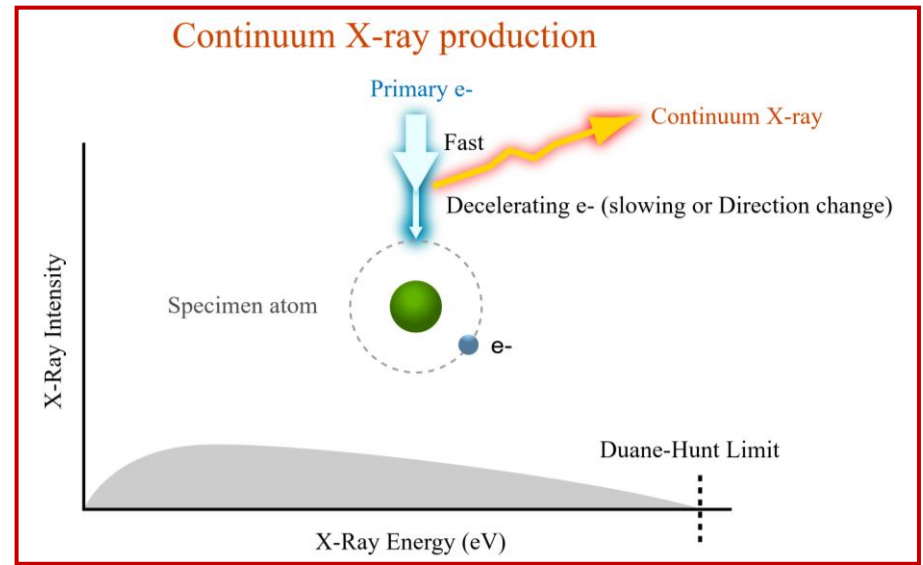
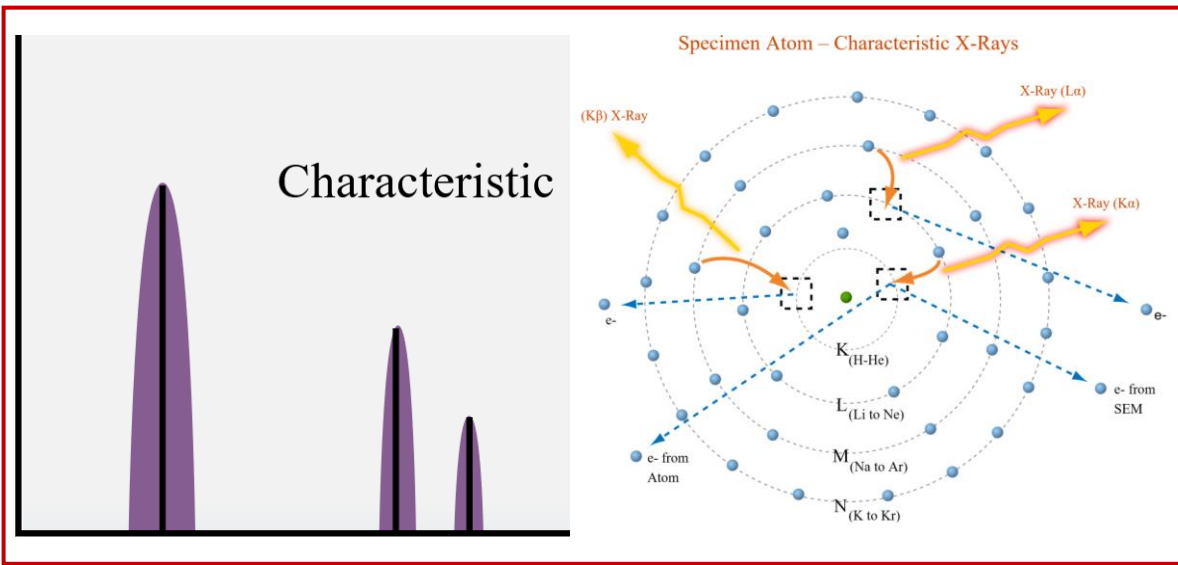
Energy Dispersive Spectroscopy

- EDS, (EDX) or (XEDS)
- A qualitative and quantitative X-ray microanalytical technique → chemical composition: $Z > 3$ ($Z > 2$ is now achievable under some circumstances)
- Primary electrons interact with the atoms. Bremsstrahlung X-rays (braking radiation, Continuum or background X-rays) + Characteristic X-rays are produced
- The production of Characteristic X-rays is a two-stage process
 - Ionisation: an electron is removed from one of the inner shells of the atom by an electron from the primary (ionized unstable atom)
 - Relaxation: the atom regains stability when an electron from an outer shell fills the inner shell vacancy and an X-ray photon is emitted.
 - The energy of the emitted X-ray is equal to the difference between the ionisation energies of the electrons involved in the transition.
- The X-rays are detected by an Energy Dispersive detector
- The typical spatial resolution for X-ray microanalysis is a few microns
- The detection limit in the range 0.1-0.5 wt%

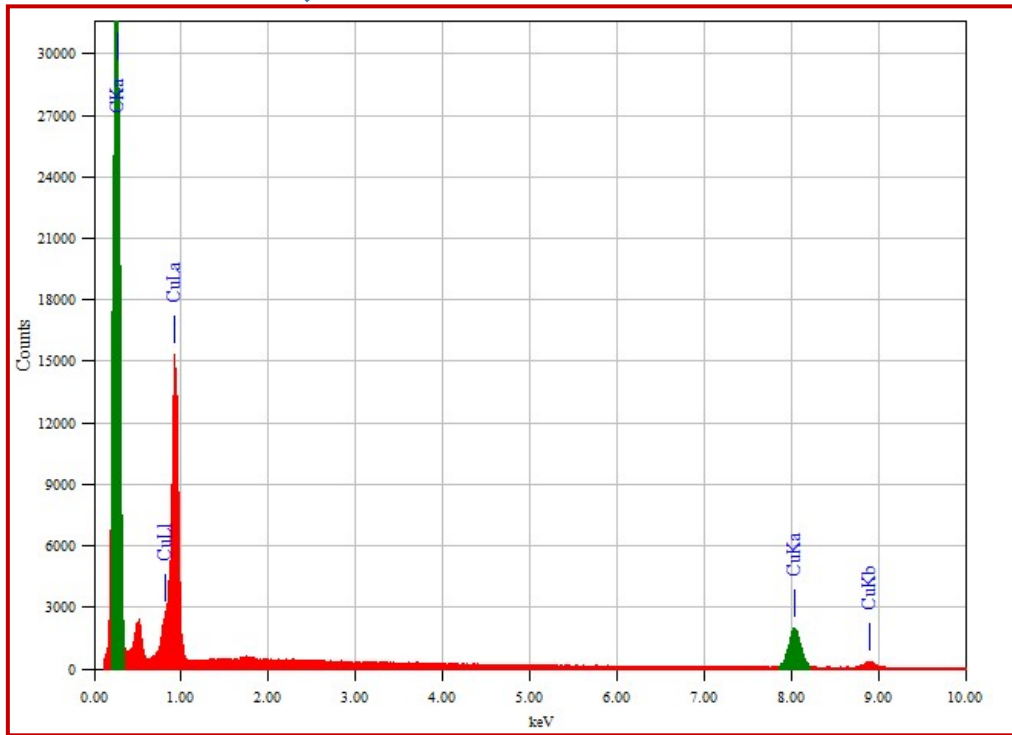
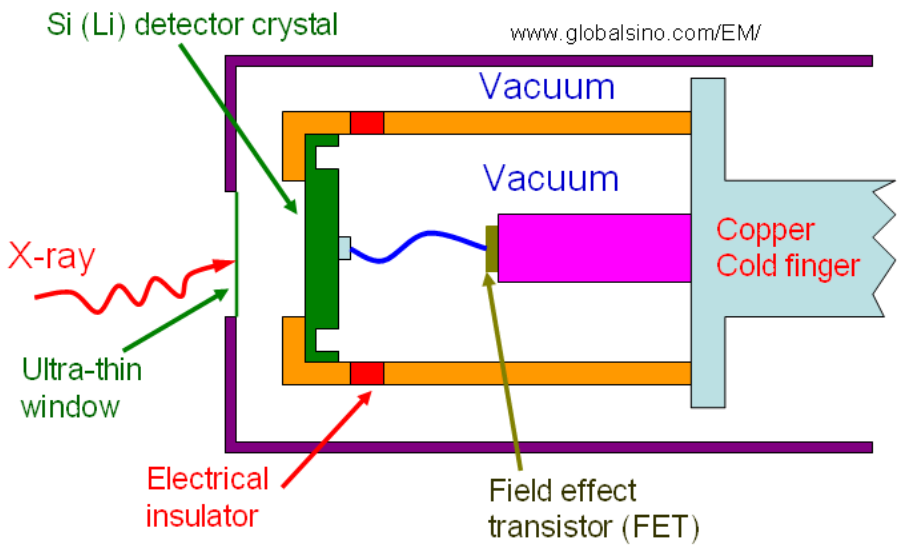
<https://myscope.training/>

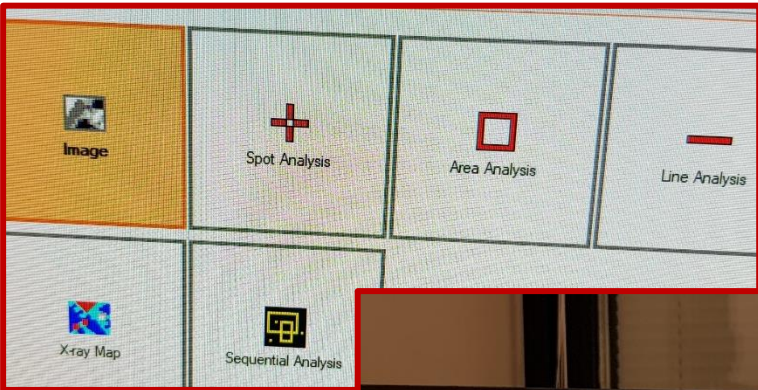
For Si, the ionisation energy of the K shell is 1.84 keV, the ionisation energy of the L shell is ~0.10 keV and the ionisation energy of the M shell is ~0.01 keV.





EDS detector with a solid state crystal





JEOL

SEM PLASMA TREAT 40% 2004cps

Element	Wt%	Count	Peak	Ratio	Blank Comp.	Repeat	Out
C K	0.257	11451.24	20.13	0.17	10.50		
K K	0.322	14234.44	1.36	0.02	0.11		
Al K	1.434	59225.44	17.20	0.12	26.43		
Si K	1.719	6921.04	0.37	0.01	0.28		
Total	0.740	23061.45	2.14	0.04	0.33		

PC SEM LOG IN: Guest

NO PASSWORD

network drive Z: (\\10.0.0.50\JSM-7500F)

password: d6mdxfeQYVCZ

JEOL

SCANNING MODE

ALIGNMENT

MAGNIFICATION

FOCUS

TRAST

ARTICLE

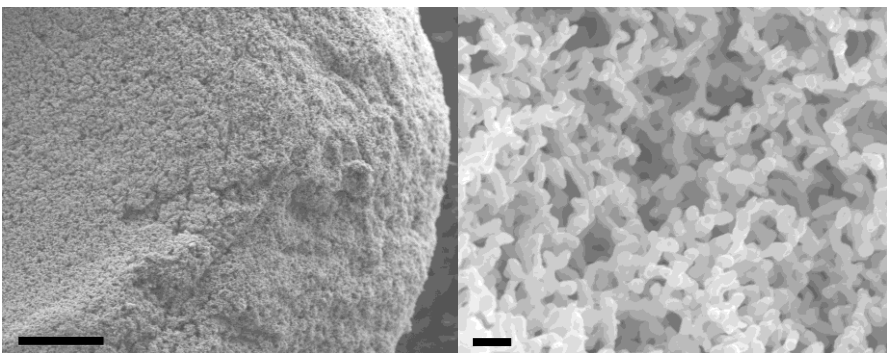
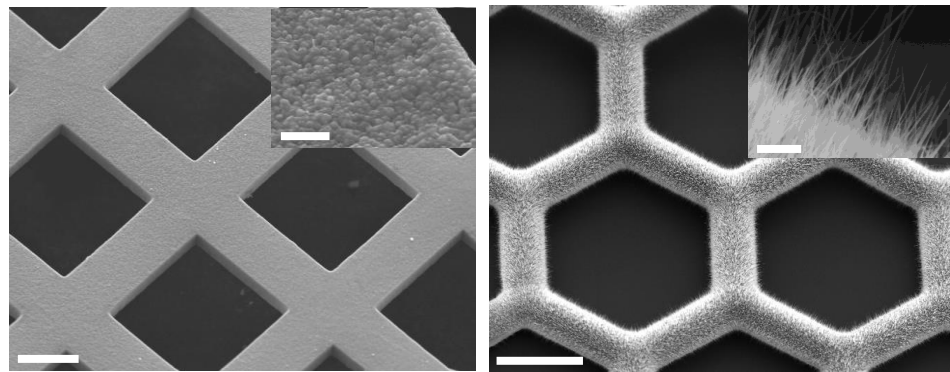
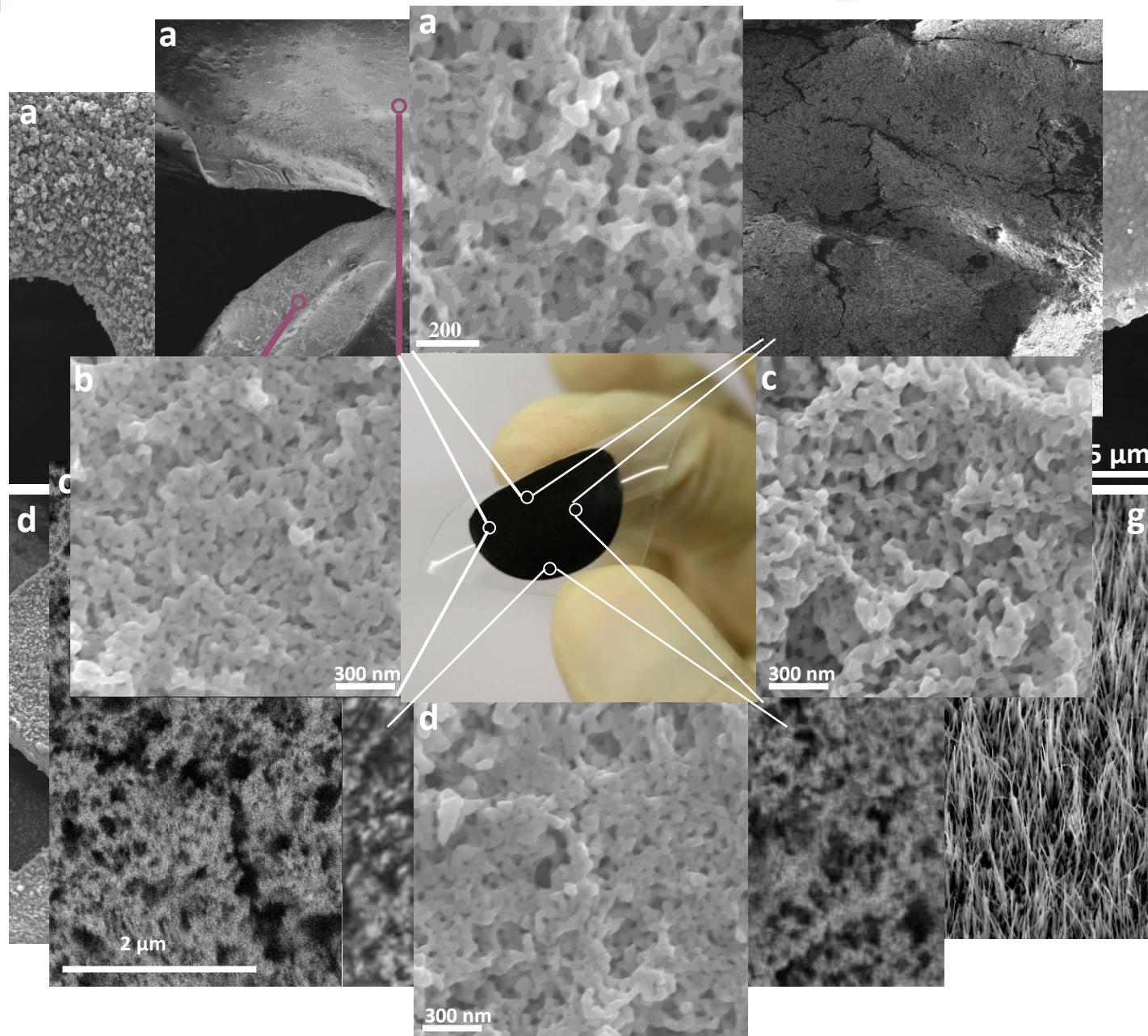
Received 23 Jan 2013 | Accepted 5 Aug 2013 | Published 29 Oct 2013

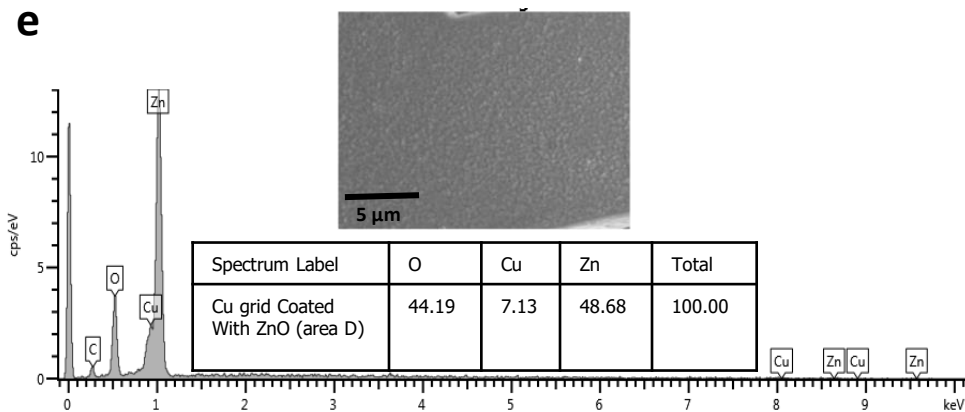
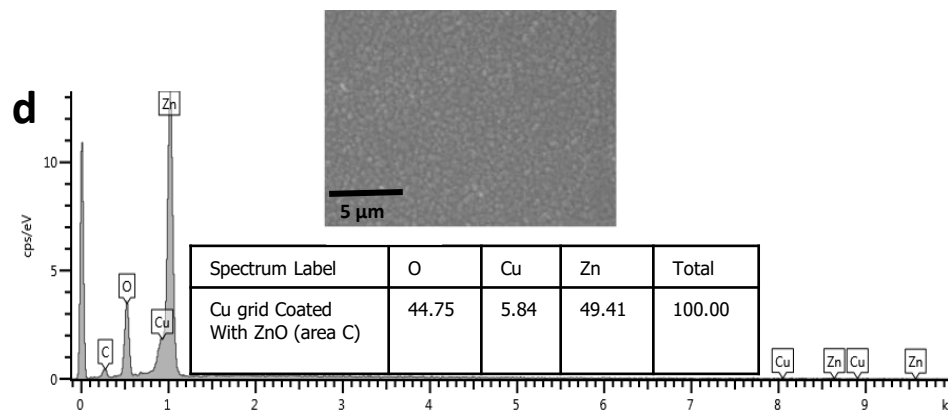
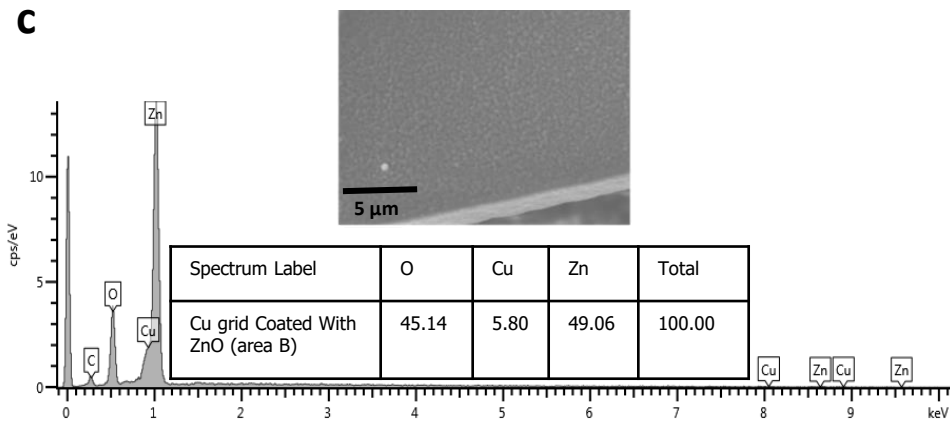
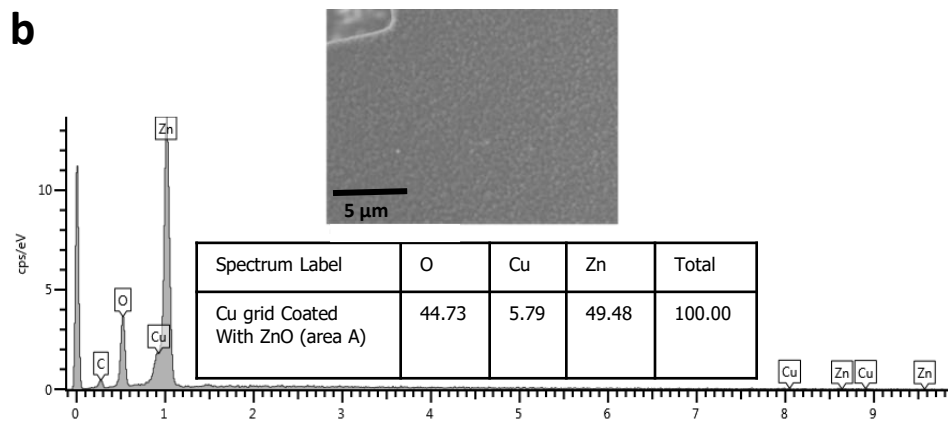
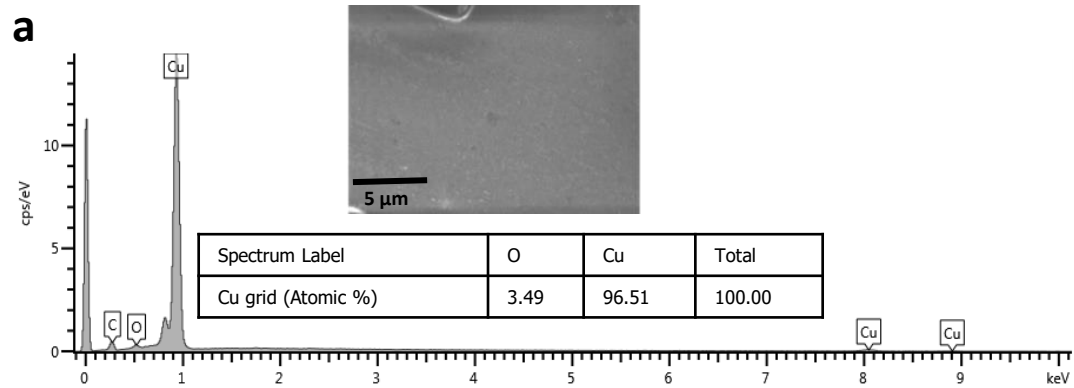
DOI: 10.1038/ncomms3400

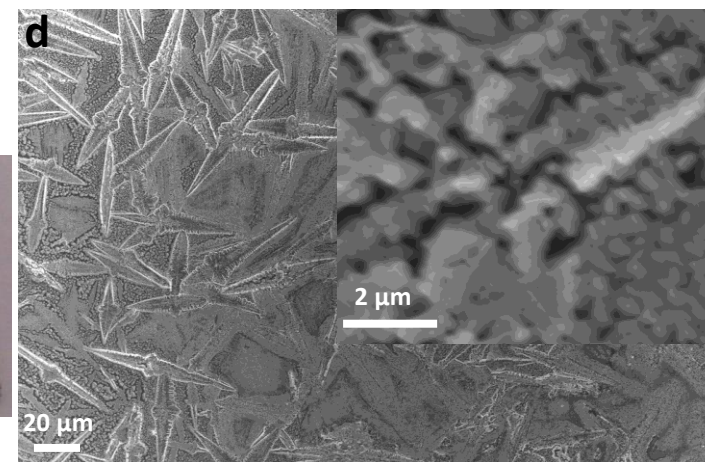
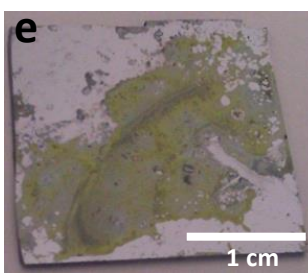
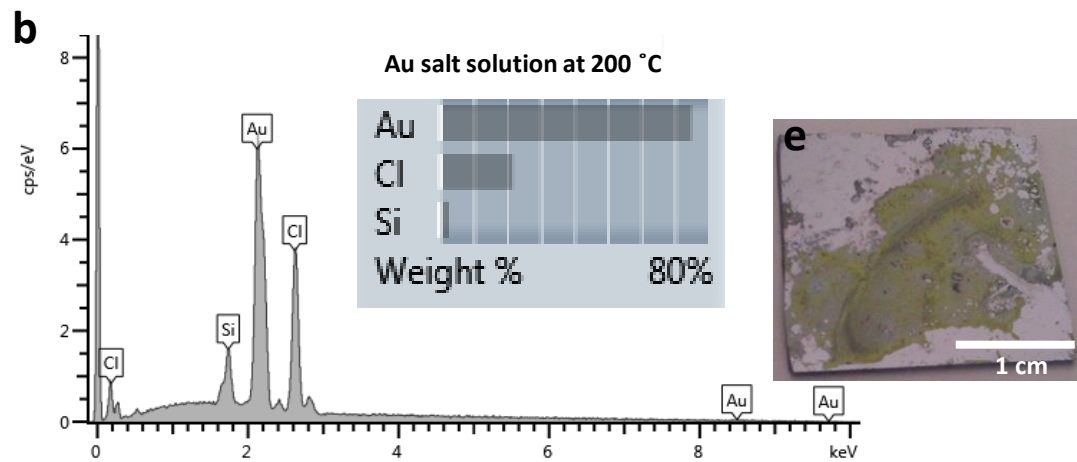
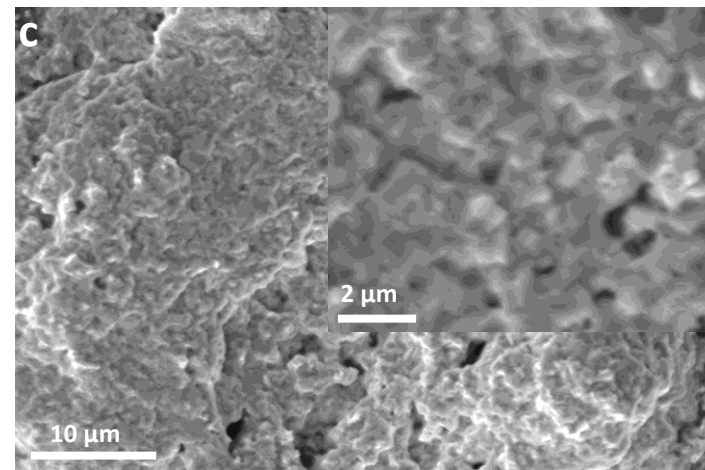
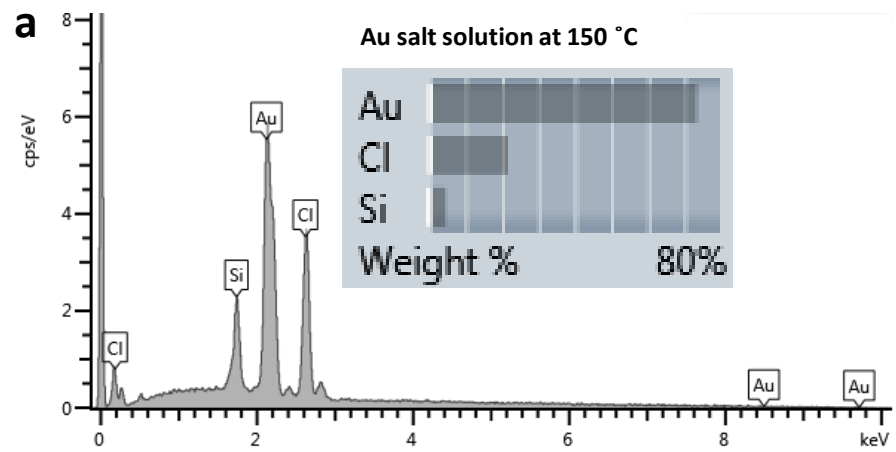
OPEN

Green chemistry and nanofabrication in a levitated Leidenfrost drop

Ramzy Abdelaziz¹, Duygu Disci-Zayed¹, Mehdi Keshavarz Hedayati¹, Jan-Hendrik Pöhlis¹,
Ahnaf Usman Zillohu², Burak Erkartal³, Venkata Sai Kiran Chakravadhanula^{3,†}, Viola Duppel⁴,
Lorenz Kienle³ & Mady Elbahri^{1,2}







ARTICLE

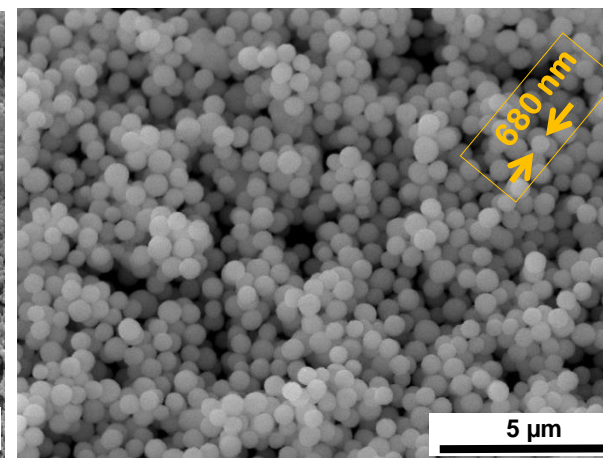
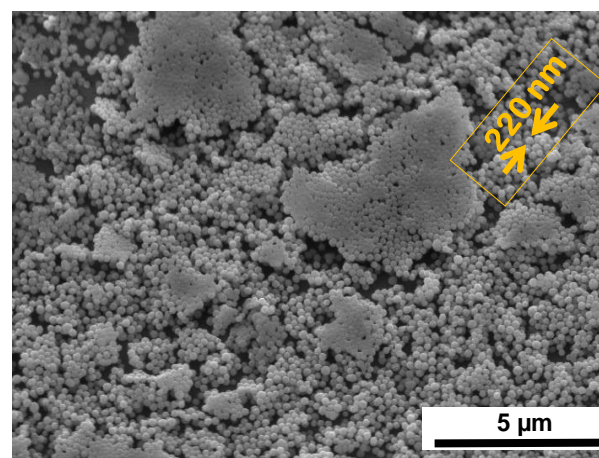
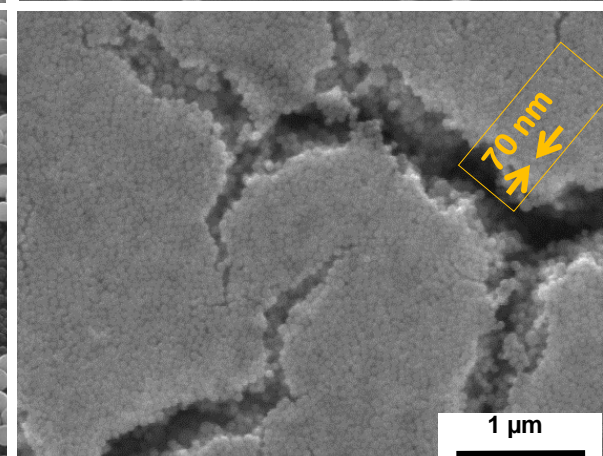
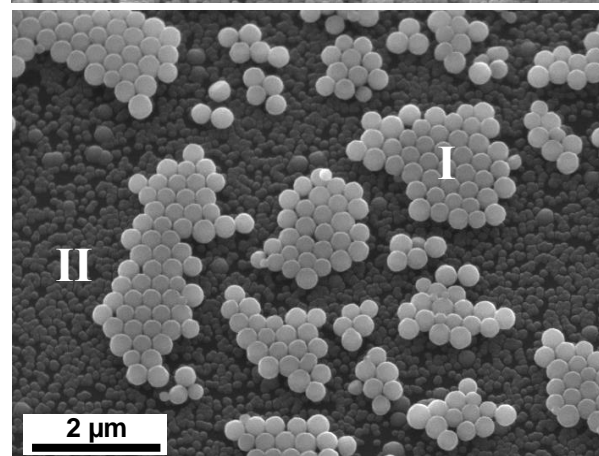
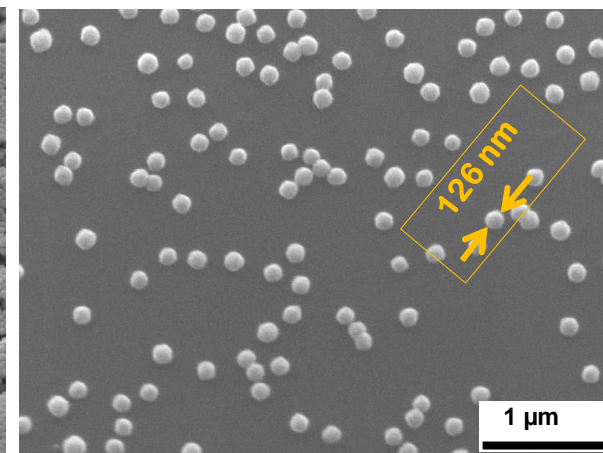
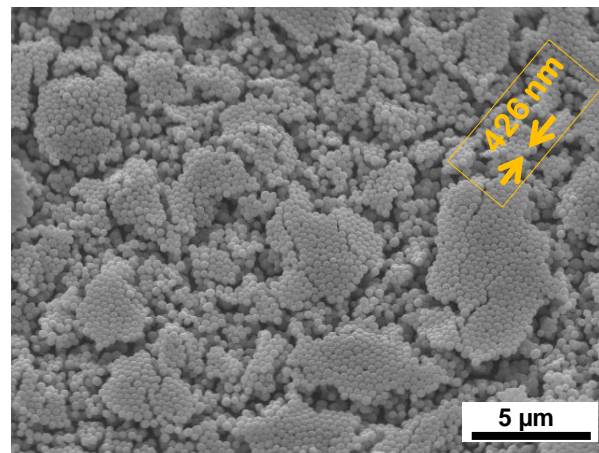
Received 2 Aug 2016 | Accepted 20 Mar 2017 | Published 12 May 2017

DOI: 10.1038/ncomms15319

OPEN

Underwater Leidenfrost nanochemistry for creation of size-tailored zinc peroxide cancer nanotherapeutics

Mady Elbahri^{1,2,3}, Ramzy Abdelaziz¹, Duygu Disci-Zayed^{2,4}, Shahin Homaeigohar¹, Justyna Sosna^{5,6}, Dieter Adam⁵, Lorenz Kienle⁷, Torben Dankwort⁷ & Moheb Abdelaziz^{1,2}





WINNER

Thank you

Ramzy Abdelaziz

